Relion® 670 series

Busbar protection REB670
Installation and commissioning manual

Power and productivity
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Conformity

This product complies with the directive of the Council of the European Communities on the approximation of the laws of the Member States relating to electromagnetic compatibility (EMC Directive 2004/108/EC) and concerning electrical equipment for use within specified voltage limits (Low-voltage directive 2006/95/EC). This conformity is the result of tests conducted by ABB in accordance with the product standards EN 50263 and EN 60255-26 for the EMC directive, and with the product standards EN 60255-1 and EN 60255-27 for the low voltage directive. The product is designed in accordance with the international standards of the IEC 60255 series.

Table of contents

Section 1 Introduction

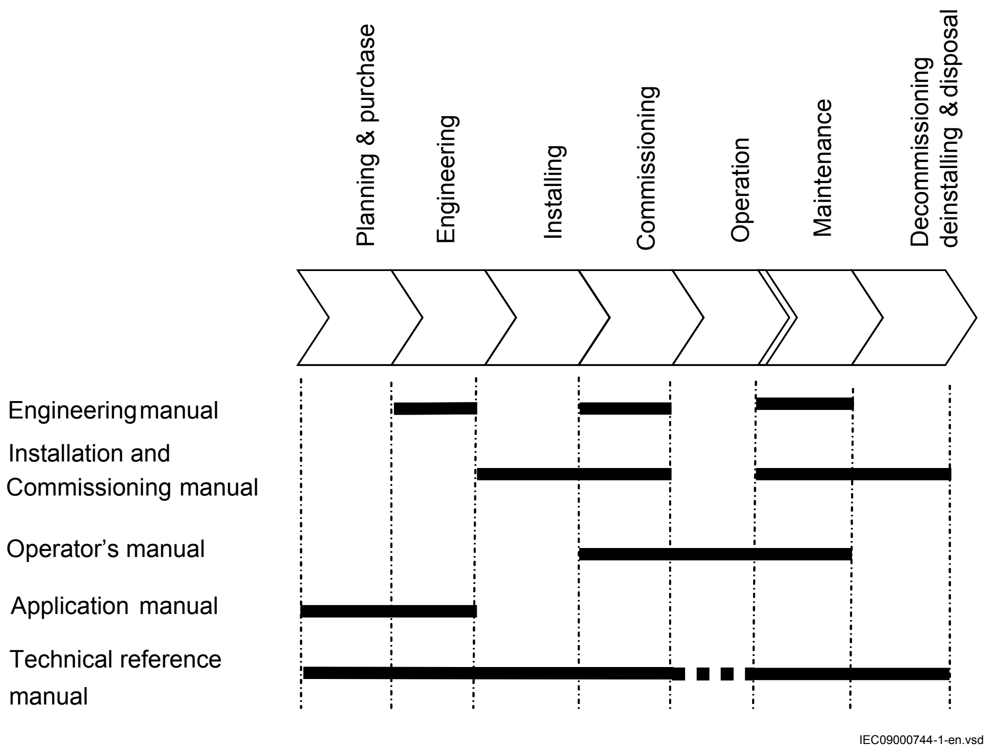
About this chapter

This chapter introduces the user to the manual.

1.1 Introduction to the installation and commissioning manual

1.1.1 About the complete set of manuals for an IED

The user’s manual (UM) is a complete set of five different manuals:



The Application Manual (AM) contains application descriptions, setting guidelines and setting parameters sorted per function. The application manual should be used to find out when and for what purpose a typical protection function could be used. The manual should also be used when calculating settings.

The Technical Reference Manual (TRM) contains application and functionality descriptions and it lists function blocks, logic diagrams, input and output signals, setting parameters and technical data sorted per function. The technical reference manual should be used as a technical reference during the engineering phase, installation and commissioning phase, and during normal service.

The Installation and Commissioning Manual (ICM) contains instructions on how to install and commission the protection IED. The manual can also be used as a reference during periodic testing. The manual covers procedures for mechanical and electrical installation, energizing and checking of external circuitry, setting and configuration as well as verifying settings and performing directional tests. The chapters are organized in the chronological order (indicated by chapter/section numbers) in which the protection IED should be installed and commissioned.

The Operator's Manual (OM) contains instructions on how to operate the protection IED during normal service once it has been commissioned. The operator's manual can be used to find out how to handle disturbances or how to view calculated and measured network data in order to determine the cause of a fault.

The Engineering Manual (EM) contains instructions on how to engineer the IEDs using the different tools in PCM600. The manual provides instructions on how to set up a PCM600 project and insert IEDs to the project structure. The manual also recommends a sequence for engineering of protection and control functions, LHMI functions as well as communication engineering for IEC 61850 and DNP3.

1.1.2 About the installation and commissioning manual

The installation and commissioning manual contains the following chapters:

- The chapter Safety information presents warning and note signs, that the user should pay attention to.
- The chapter Overview is a summary of the major tasks faced when installing and commissioning an IED.
- The chapter Unpacking and checking the IED explains how to take delivery of the IED.
- The chapter Installing the IED explains how to install the IED.
- The chapter Checking the external optical and electrical connections explains how to check that the IED is properly connected to the protection system.
- The chapter Energizing the IED explains how to start the IED.
- The chapter Set up PCM 600 communication link per IED describes the communication between PCM600 and the IED.
- The chapter Establishing connection and verifying the SPA/IEC-communication contains explains how to enter SPA/IEC settings and verifying the communication.
- The chapter Establishing connection and verifying the LON communication contains a reference to another document.
- The chapter Establishing connection and verifying the IEC 61850 communication contains explains how to enter IEC 61850 settings and verifying the communication.
- The chapter Configuring the IED and changing settings" explains how to write settings and configure the IED.

- The chapter Verifying settings by secondary injection contains instructions on how to verify that each included function operates correctly according to the set values.
- The chapter Primary injection testing describes a test with primary current through the protected zone.
- The chapter Commissioning and maintenance of the fault clearing system discusses maintenance tests and other periodic maintenance measures.
- The chapter Fault tracing and repair explains how to troubleshoot.
- The chapter Glossary is a list of terms, acronyms and abbreviations used in ABB technical documentation.

1.1.3 Intended audience

General

The installation and commissioning manual addresses the personnel responsible for the installation, commissioning, maintenance and taking the protection in and out of normal service.

Requirements

The installation and commissioning personnel must have a basic knowledge in handling electronic equipment. The commissioning and maintenance personnel must be well experienced in using protection equipment, test equipment, protection functions and the configured functional logics in the protection.

1.1.4 Revision notes

Revision	Description
A	Minor corrections made
B	Updates made for REB670 1.2.4
C	Maintenance updates, PR corrections
D	Maintenance updates, PR corrections

Section 2 Safety information

2.1 Symbols on the product

All warnings must be observed.

Read the entire manual before doing installation or any maintenance work on the product. All warnings must be observed.

Do not touch the unit in operation. The installation shall take into account the worst case temperature.

2.2 Warnings

Observe the warnings during all types of work related to the product.

Only electrically skilled persons with the proper authorization and knowledge of any safety hazards are allowed to carry out the electrical installation.

National and local electrical safety regulations must always be followed. Working in a high voltage environment requires serious approach to avoid human injuries and damage to equipment.

Do not touch circuitry during operation. Potentially lethal voltages and currents are present.

Always use suitable isolated test pins when measuring signals in open circuitry. Potentially lethal voltages and currents are present.

Never connect or disconnect a wire and/or a connector to or from a IED during normal operation. Hazardous voltages and currents are present that may be lethal. Operation may be disrupted and IED and measuring circuitry may be damaged.

Dangerous voltages can occur on the connectors, even though the auxiliary voltage has been disconnected.

Always connect the IED to protective earth, regardless of the operating conditions. This also applies to special occasions such as bench testing, demonstrations and off-site configuration. This is class 1 equipment that shall be earthed.

Never disconnect the secondary connection of current transformer circuit without short-circuiting the transformer's secondary winding. Operating a current transformer with the secondary winding open will cause a massive potential build-up that may damage the transformer and may cause injuries to humans.

Never remove any screw from a powered IED or from a IED connected to powered circuitry. Potentially lethal voltages and currents are present.

Take adequate measures to protect the eyes. Never look into the laser beam.

The IED with accessories should be mounted in a cubicle in a restricted access area within a power station, substation or industrial or retail environment.

Whenever changes are made in the IED, measures should be taken to avoid inadvertent tripping.

The IED contains components which are sensitive to electrostatic discharge. ESD precautions shall always be observed prior to touching components.

Always transport PCBs (modules) using certified conductive bags.

Do not connect live wires to the IED. Internal circuitry may be damaged

Always use a conductive wrist strap connected to protective ground when replacing modules. Electrostatic discharge (ESD) may damage the module and IED circuitry.

Take care to avoid electrical shock during installation and commissioning.

Changing the active setting group will inevitably change the IEDs operation. Be careful and check regulations before making the change.

2.3 Note signs

Observe the maximum allowed continuous current for the different current transformer inputs of the IED. See technical data.

Section 3 Overview

About this chapter

This chapter outlines the installation and commissioning of the IED.

3.1 Commissioning and installation overview

The settings for each function must be calculated before the commissioning task can start. A configuration, done in the configuration and programming tool, must also be available if the IED does not have a factory configuration downloaded.

The IED is unpacked and visually checked. It is preferably mounted in a cubicle or on a wall. The connection to the protection system has to be checked in order to verify that the installation is successful.

Section 4 Unpacking and checking the IED

About this chapter

This chapter describes the delivery and the unpacking of the IED

4.1 Taking delivery, unpacking and checking

Procedure

1. Remove the transport casing.
2. Visually inspect the IED.
3. Check that all items are included in accordance with the delivery documents.
   Once the IED has been started make sure that the software functions ordered have been included in the delivery.
4. Check for transport damages.
   If transport damage is discovered appropriate action must be taken against the latest carrier and the nearest ABB office or representative should be informed. ABB should be notified immediately if there are any discrepancies in relation to the delivery documents.
5. Storage
   If the IED is to be stored before installation, this must be done in the original transport casing in a dry and dust free place. Observe the environmental requirements stated in the technical data.

Section 5 Installing the IED

About this chapter

This chapter describes how to install the IED.

5.1 Checking environmental conditions and mounting space

The mechanical and electrical environmental conditions at the installation site must be within the limits described in the technical manual and IEC61255-1, normal environment.

- Avoid installation in dusty, damp places.
  Avoid places susceptible to rapid temperature variations, powerful vibrations and shocks, surge voltages of high amplitude and fast rise time, strong induced magnetic fields or similar extreme conditions.
- Check that sufficient space is available.
  Sufficient space is needed at the front and rear of the IED to allow access to wires and optical fibres and to enable maintenance and future modifications.
- Ensure that convection cooling through the ventilation holes at the top and bottom of the case is possible to minimize the heating effect within the IED.
  1. Ensure that the amount of dust around the IED is minimized, so that the cooling effect is not reduced.
     It is recommended to install the 670 series IED in a cubicle with an IP4X ingress protection according to IEC 60529, at least at the top surface, to prevent dust and limited size materials from falling through the ventilation holes at top and bottom of the IED case. The effect of airborne contaminants will also be reduced if ventilation of the cubicle is limited.
  2. Check that no combustible materials are present in the cubicle.

5.2 Dimensions

5.2.1 Case without rear cover

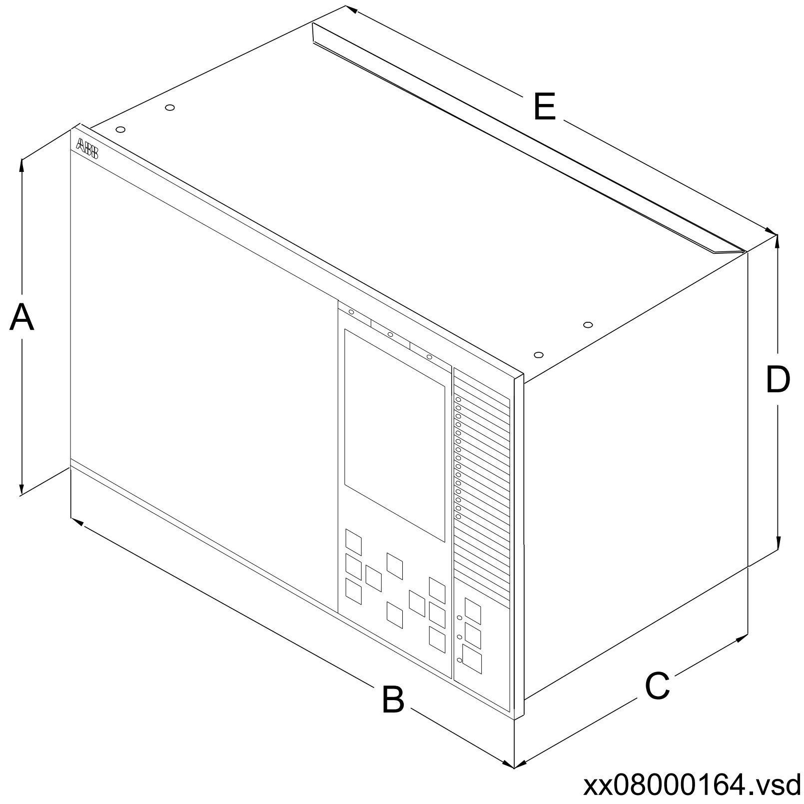


Figure 1: Case without rear cover

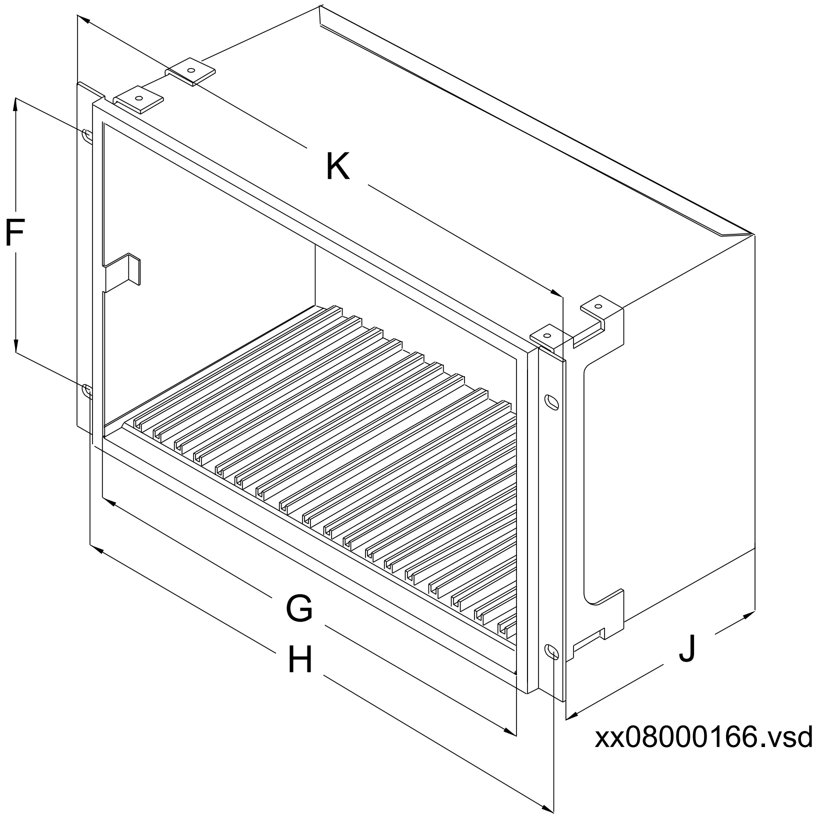


Figure 2: Case without rear cover with 19” rack mounting kit

Case size (mm)	A	B	C	D	E	F	G	H	J	K
6U, 1/2 x 19”	265.9	223.7	201.1	252.9	205.7	190.5	203.7	-	187.6	-
6U, 3/4 x 19”	265.9	336.0	201.1	252.9	318.0	190.5	316.0	-	187.6	-
6U, 1/1 x 19”	265.9	448.3	201.1	252.9	430.3	190.5	428.3	465.1	187.6	482.6
The H and K dimensions are defined by the 19” rack mounting kit										

5.2.2 Case with rear cover

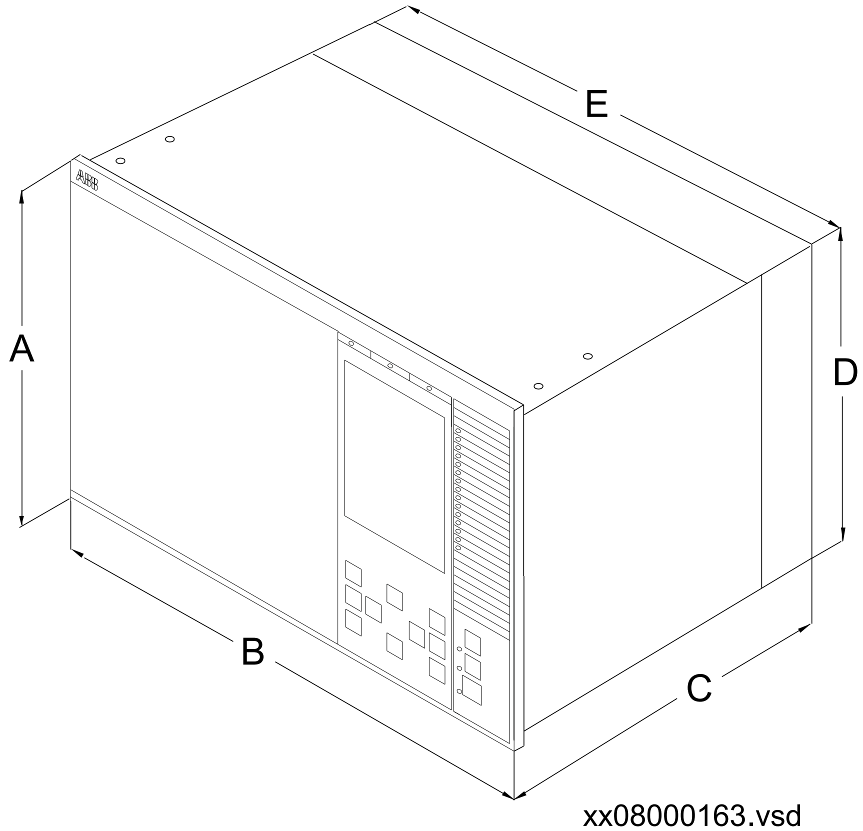


Figure 3: Case with rear cover

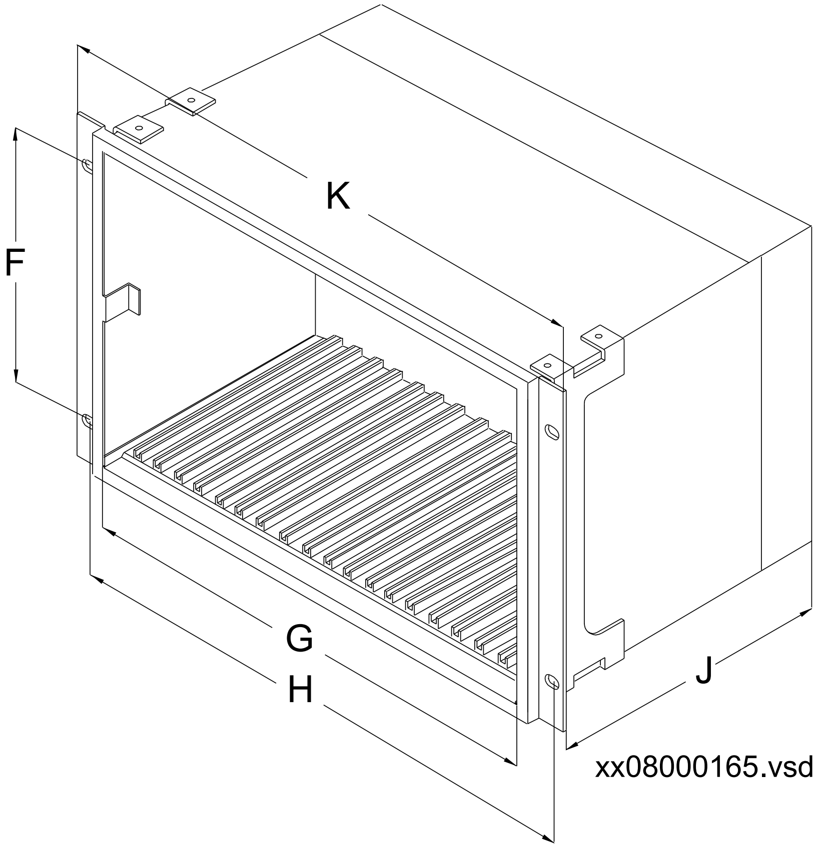


Figure 4: Case with rear cover and 19” rack mounting kit

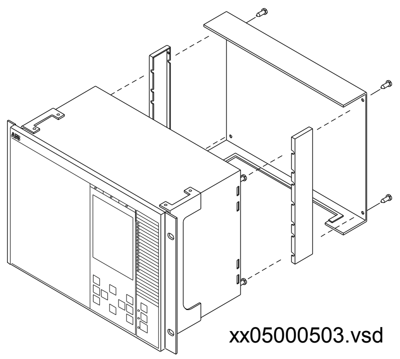


Figure 5: Rear cover case with details

Case size (mm)	A	B	C	D	E	F	G	H	J	K
6U, 1/2 x 19”	265.9	223.7	242.1	255.8	205.7	190.5	203.7	-	228.6	-
6U, 3/4 x 19”	265.9	336.0	242.1	255.8	318.0	190.5	316.0	-	228.6	-
6U, 1/1 x 19”	265.9	448.3	242.1	255.8	430.3	190.5	428.3	465.1	228.6	482.6
The H and K dimensions are defined by the 19” rack mounting kit.										

5.2.3 Flush mounting dimensions

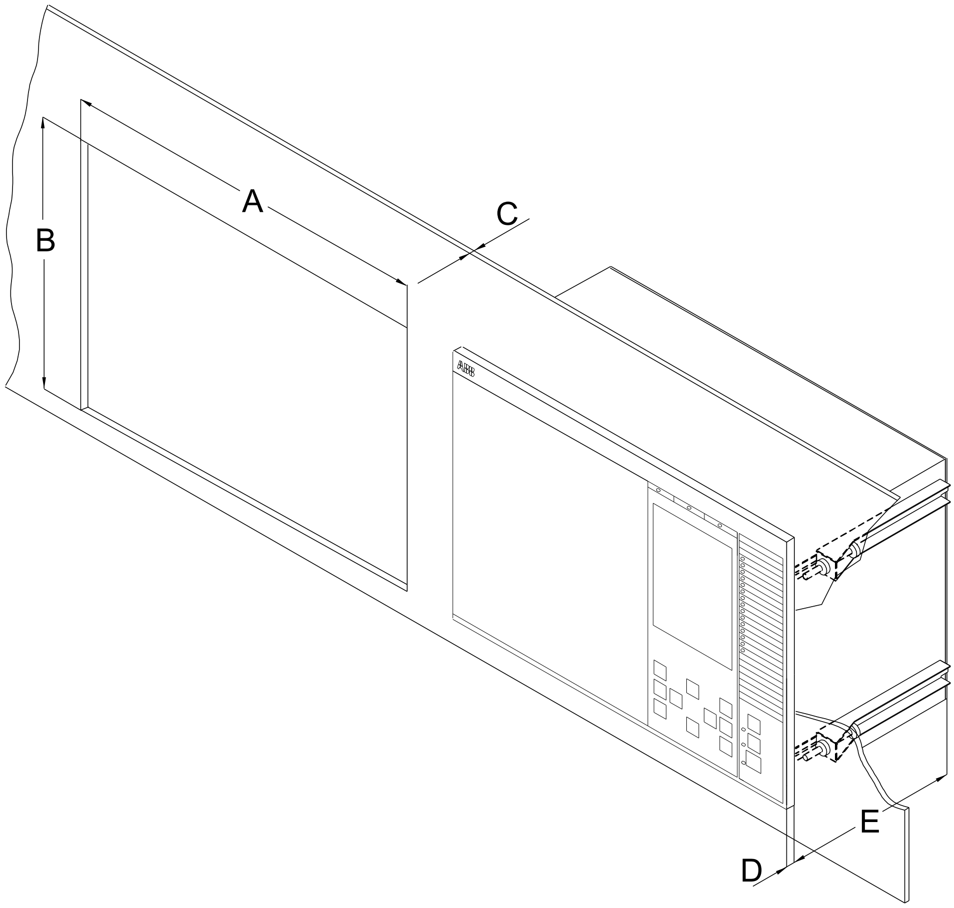


Figure 6: Flush mounting

Case size Tolerance	Cut-out dimensions (mm)			
	A +/-1	B +/-1	C	D
6U, 1/2 x 19"	210.1	254.3	4.0-10.0	12.5
6U, 3/4 x 19"	322.4	254.3	4.0-10.0	12.5
6U, 1/1 x 19"	434.7	254.3	4.0-10.0	12.5
E = 188.6 mm without rear protection cover, 229.6 mm with rear protection cover				

5.2.4 Side-by-side flush mounting dimensions

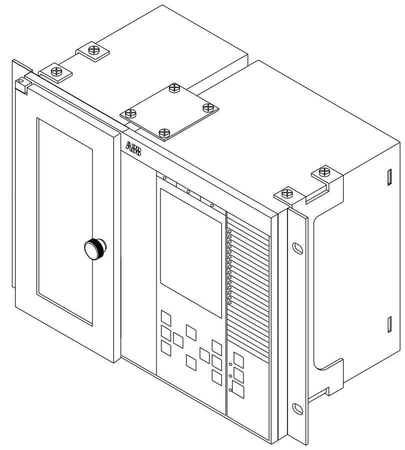


Figure 7: A 1/2 x 19” size 670 series IED side-by-side with RHGS6.

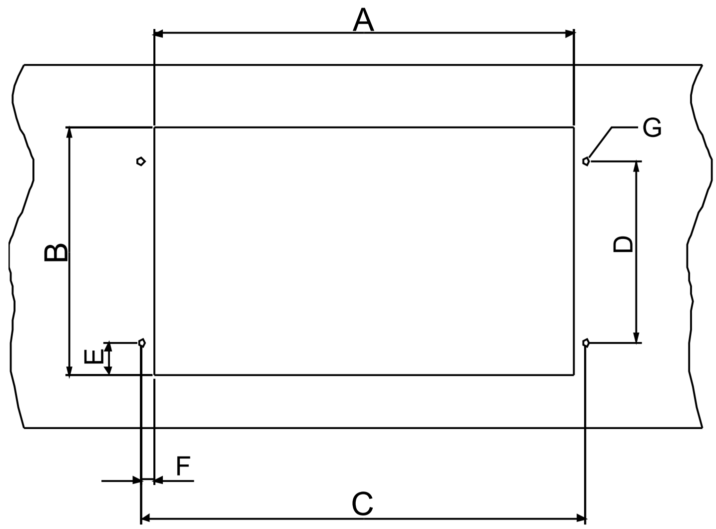


Figure 8: Panel-cut out dimensions for side-by-side flush mounting

Case size (mm) Tolerance	A ±1	B ±1	C ±1	D ±1	E ±1	F ±1	G ±1
6U, 1/2 x 19”	214.0	259.3	240.4	190.5	34.4	13.2	6.4 diam
6U, 3/4 x 19”	326.4	259.3	352.8	190.5	34.4	13.2	6.4 diam
6U, 1/1 x 19”	438.7	259.3	465.1	190.5	34.4	13.2	6.4 diam

5.2.5 Wall mounting dimensions

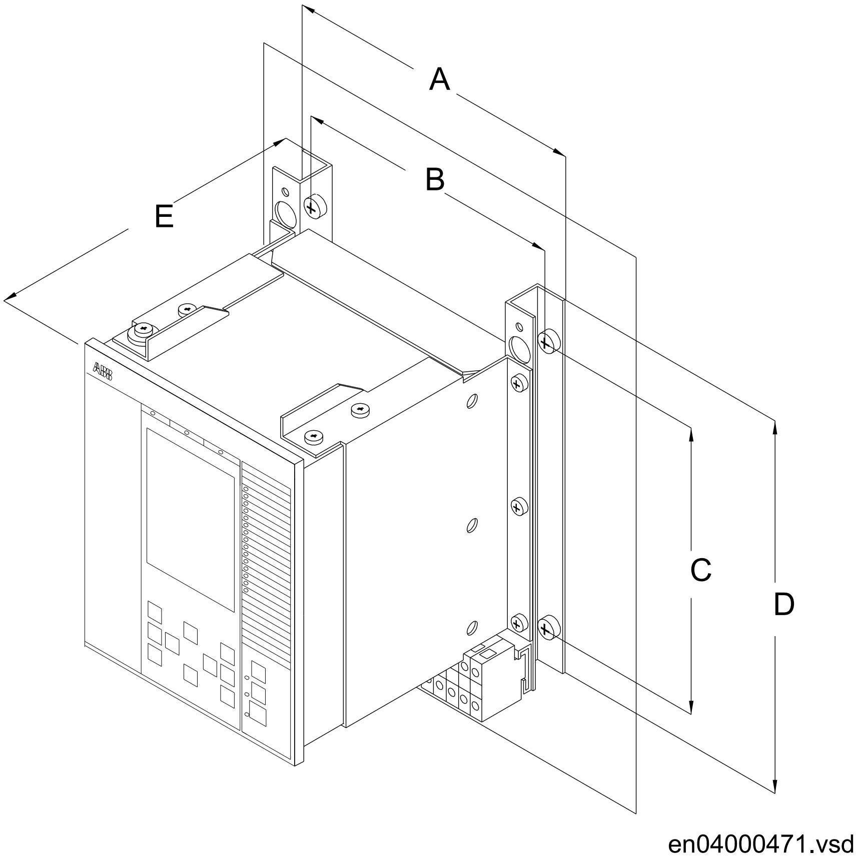


Figure 9: Wall mounting

Case size (mm)	A	B	C	D	E
6U, 1/2 x 19”	292.0	267.1	272.8	390.0	243.0
6U, 3/4 x 19”	404.3	379.4	272.8	390.0	243.0
6U, 1/1 x 19”	516.0	491.1	272.8	390.0	243.0

5.3 Mounting methods and details

5.3.1 Mounting the IED

The IED can be rack, wall or flush mounted with the use of different mounting kits, see figure 10.

The different mounting kits contain all parts needed including screws and assembly instructions. The following mounting kits are available:

- Flush mounting kit
- 19” Panel (rack) mounting kit
- Wall mounting kit
- Side-by-side mounting kit

The same mounting kit is used for side-by-side rack mounting and side-by-side flush mounting.

The mounting kits must be ordered separately when ordering an IED. They are available as options on the ordering sheet in *Accessories for 670 series IED*, see section "".

Generally, all the screws included in delivered mounting kits are of Torx type and a screwdriver of the same type is needed (Tx10, Tx15, Tx20 and Tx25).

If other type of screws are to be used, be sure to use the dimensions of the screws that are given in this guide.

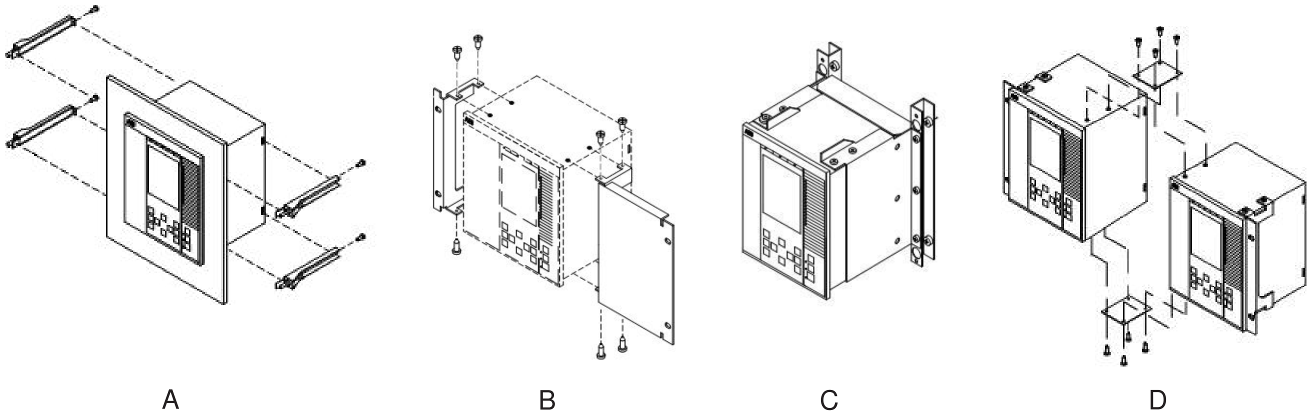


Figure 10: Different mounting methods

	Description
A	Flush mounting
B	19” Panel rack mounting
C	Wall mounting
D	Side-by-side rack or flush mounting

5.3.2 Flush mounting

5.3.2.1 Overview

The flush mounting kit are utilized for case sizes:

- 1/2 x 19”
- 3/4 x 19”
- 1/1 x 19”
- 1/4 x 19” (RHGS6 6U)

Only a single case can be mounted in each cut-out on the cubicle panel, for class IP54 protection.

Flush mounting cannot be used for side-by-side mounted IEDs when IP54 class must be fulfilled. Only IP20 class can be obtained when mounting two cases side-by-side in one (1) cut-out.

To obtain IP54 class protection, an additional factory mounted sealing must be ordered when ordering the IED.

5.3.2.2 Mounting procedure for flush mounting

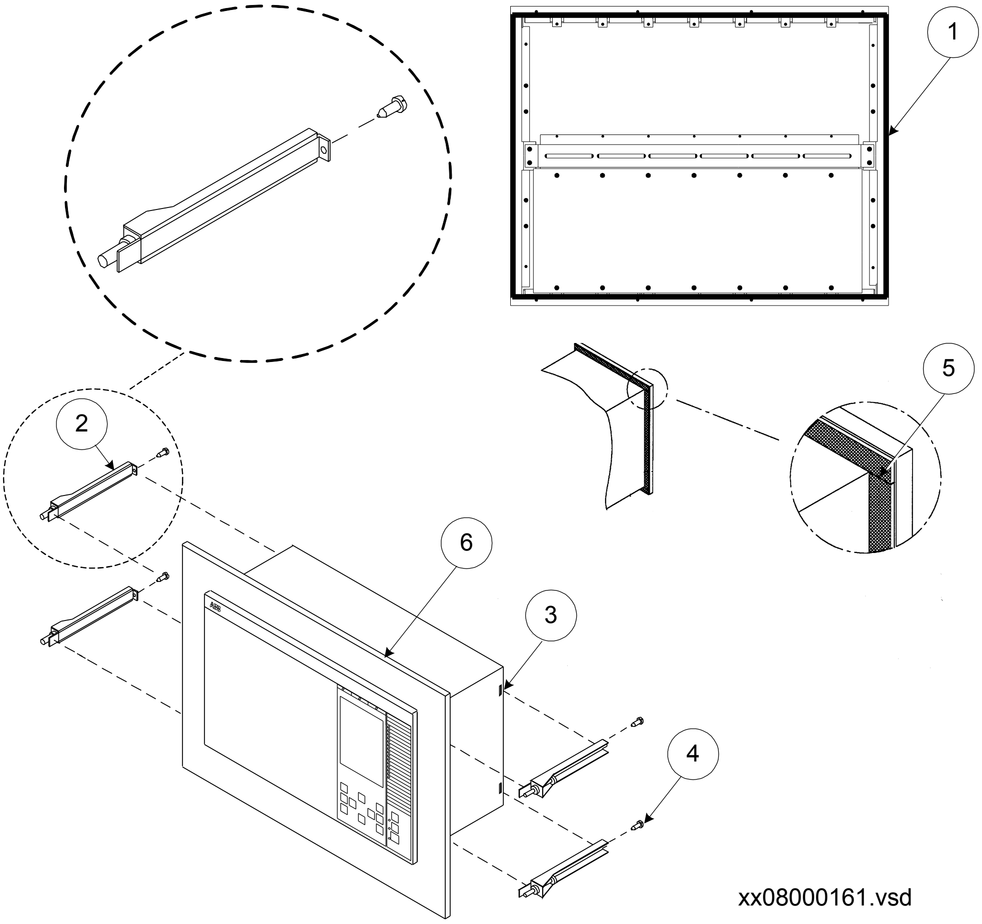


Figure 11: Flush mounting details.

PosNo	Description	Quantity	Type
1	Sealing strip, used to obtain IP54 class. The sealing strip is factory mounted between the case and front plate.	-	-
2	Fastener	4	-
3	Groove	-	-
4	Screw, self tapping	4	2.9x9.5 mm
5	Joining point of sealing strip	-	-
6	Panel	-	-

Procedure

1. Cut an opening in the panel (6).

See section "Flush mounting dimensions" regarding dimensions.

2. Carefully press the sealing strip (1) around the IEDs collar. Cut the end of the sealing strip a few mm to long to make the joining point (5) tight.
   The sealing strip is delivered with the mounting kit. The strip is long enough for the largest available IED.
3. Insert the IED into the opening (cut-out) in the panel.
4. Add and lock the fasteners (2) to the IED.
   Thread a fastener into the groove at the back end of the IED. Insert and lightly fasten the locking screw (4). Next, thread a fastener on the other side of the IED, and lightly fasten its locking screw. Lock the front end of the fastener in the panel, using the M5x25 screws.
   Repeat the procedure with the remaining two fasteners.

5.3.3 19” panel rack mounting

5.3.3.1 Overview

All IED sizes can be mounted in a standard 19” cubicle rack by using the for each size suited mounting kit which consists of two mounting angles and fastening screws for the angles.

Please note that the separately ordered rack mounting kit for side-by-side mounted IEDs, or IEDs together with RHGS cases, is to be selected so that the total size equals 19”.

When mounting the mounting angles, be sure to use screws that follows the recommended dimensions. Using screws with other dimensions than the original may damage the PCBs inside the IED.

5.3.3.2 Mounting procedure for 19” panel rack mounting

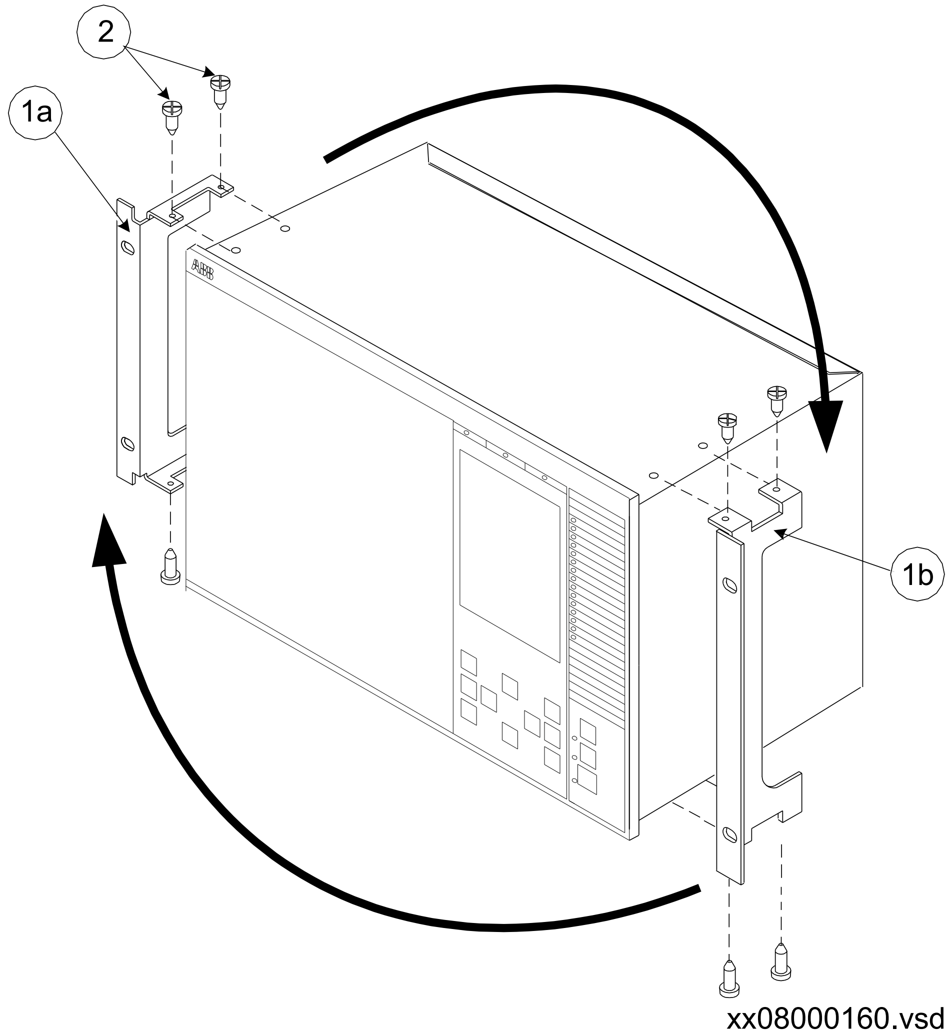


Figure 12: 19” panel rack mounting details

Pos	Description	Quantity	Type
1a, 1b	Mounting angels, which can be mounted, either to the left or right side of the case.	2	-
2	Screw	8	M4x6

Procedure

1. Carefully fasten the mounting angles (1a, 1b) to the sides of the IED.
   Use the screws (2) supplied in the mounting kit.
2. Place the IED assembly in the 19” panel.
3. Fasten the mounting angles with appropriate screws.

5.3.4 Wall mounting

5.3.4.1 Overview

All case sizes, 1/2 x 19”, 3/4 x 19”,1/1 x 19”, can be wall mounted. It is also possible to mount the IED on a panel or in a cubicle.

When mounting the side plates, be sure to use screws that follows the recommended dimensions. Using screws with other dimensions than the original may damage the PCBs inside the IED.

If fiber cables are bent too much, the signal can be weakened. Wall mounting is therefore not recommended for communication modules with fiber connection; Serial SPA/IEC 60870-5-103, DNP3 and LON communication module (SLM),Optical Ethernet module (OEM) and Line data communication module (LDCM).

5.3.4.2 Mounting procedure for wall mounting

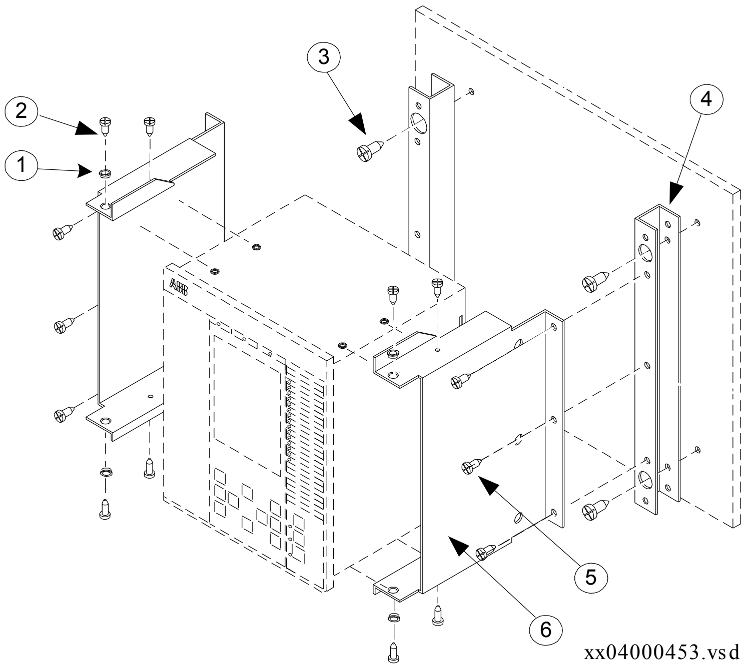


Figure 13: Wall mounting details.

PosNo	Description	Quantity	Type
1	Bushing	4	-
2	Screw	8	M4x10
3	Screw	4	M6x12 or corresponding
4	Mounting bar	2	-
5	Screw	6	M5x8
6	Side plate	2	-

Procedure

1. Mount the mounting bars onto the wall (4).
   See section "Wall mounting dimensions" for mounting dimensions.
   Depending on the wall different preparations may be needed like drilling and inserting plastic or expander plugs (concrete/plasterboard walls) or threading (metal sheet wall).
2. Make all electrical connections to the IED terminal.
   It is much easier to do this without the unit in place.
3. Mount the side plates to the IED.
4. Mount the IED to the mounting bars.

5.3.4.3 How to reach the rear side of the IED

The IED can be equipped with a rear protection cover, which is recommended to use with this type of mounting. See figure 14.

To reach the rear side of the IED, a free space of 80 mmis required on the unhinged side.

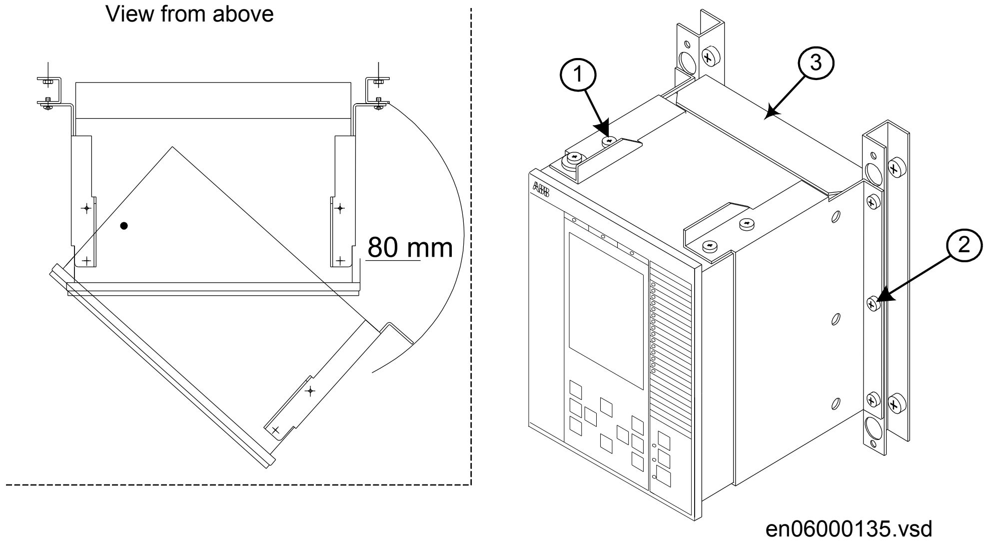


Figure 14: How to reach the connectors on the rear side of the IED.

PosNo	Description	Type
1	Screw	M4x10
2	Screw	M5x8
3	Rear protection cover	-

Procedure

1. Remove the inner screws (1), upper and lower on one side.
2. Remove all three fixing screws (2), on the opposite side, from wall support.
3. The IED can now be swung out for access to the connectors, after removing any rear protection.

5.3.5 Side-by-side 19” rack mounting

5.3.5.1 Overview

IED case sizes, 1/2 x 19” or 3/4 x 19” and RHGS cases, can be mounted side-by-side up to a maximum size of 19”. For side-by-side rack mounting, the side-by-side mounting kit together with the 19” rack panel mounting kit must be used. The mounting kit has to be ordered separately.

When mounting the plates and the angles on the IED, be sure to use screws that follows the recommended dimensions. Using screws with other dimensions than the original may damage the PCBs inside the IED.

5.3.5.2 Mounting procedure for side-by-side rack mounting

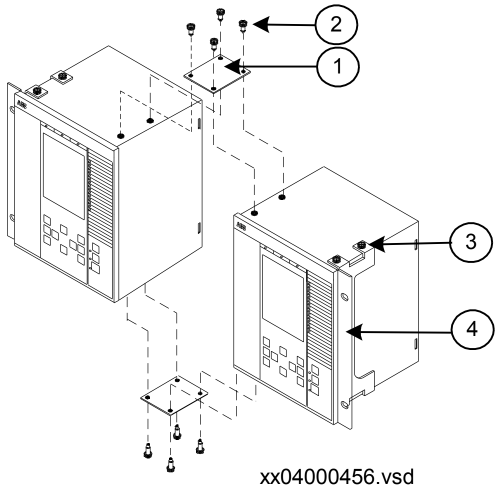


Figure 15: Side-by-side rack mounting details.

PosNo	Description	Quantity	Type
1	Mounting plate	2	-
2, 3	Screw	16	M4x6
4	Mounting angle	2	-

Procedure

1. Place the two IEDs next to each other on a flat surface.
2. Fasten a side-by-side mounting plate (1).
   Use four of the delivered screws (2, 3).
3. Carefully turn the two IEDs up-side down.
4. Fasten the second side-by-side mounting plate.
   Use the remaining four screws.
5. Carefully fasten the mounting angles (4) to the sides of the IED.
   Use the screws available in the mounting kit.
6. Place the IED assembly in the rack.
7. Fasten the mounting angles with appropriate screws.

5.3.5.3 IED in the 670 series mounted with a RHGS6 case

An 1/2 x 19” or 3/4 x 19” size IED can be mounted with a RHGS (6 or 12 depending on IED size) case. The RHGS case can be used for mounting a test switch of type RTXP 24. It also has enough space for a terminal base of RX 2 type for mounting of, for example, a DC-switch or two trip IEDs.

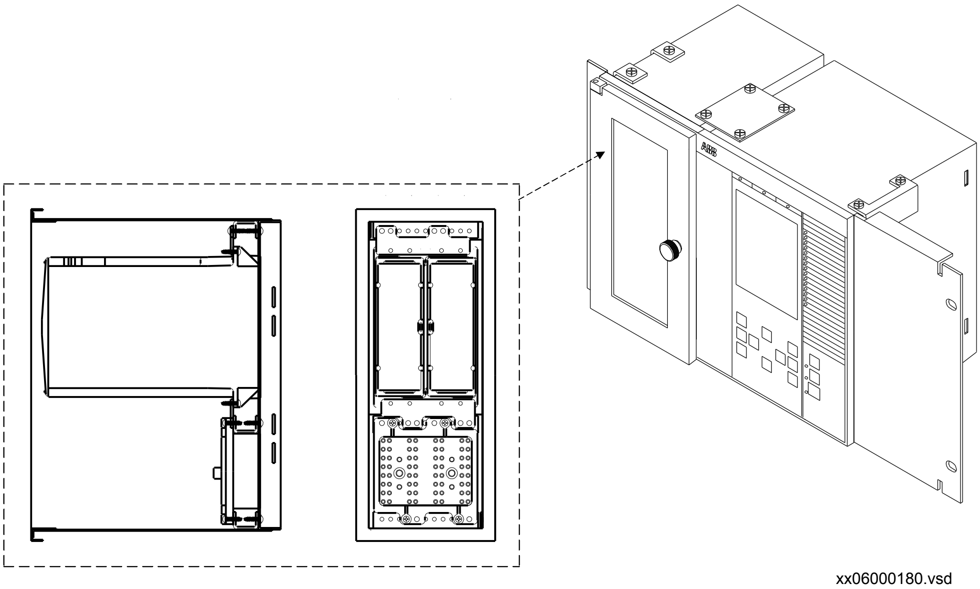


Figure 16: IED in the 670 series (1/2 x 19”) mounted with a RHGS6 case containing a test switch module equipped with only a test switch and a RX2 terminal base

5.3.6 Side-by-side flush mounting

5.3.6.1 Overview

It is not recommended to flush mount side by side mounted cases if IP54 is required. If your application demands side-by-side flush mounting, the side-by-side mounting details kit and the 19” panel rack mounting kit must be used. The mounting kit has to be ordered separately. The maximum size of the panel cut out is 19”.

With side-by-side flush mounting installation, only IP class 20 is obtained. To reach IP class 54, it is recommended to mount the IEDs separately. For cut out dimensions of separately mounted IEDs, see section "Flush mounting".

When mounting the plates and the angles on the IED, be sure to use screws that follows the recommended dimensions. Using screws with other dimensions than the original may damage the PCBs inside the IED.

Please contact factory for special add on plates for mounting FT switches on the side (for 1/2 19" case) or bottom of the relay.

5.3.6.2 Mounting procedure for side-by-side flush mounting

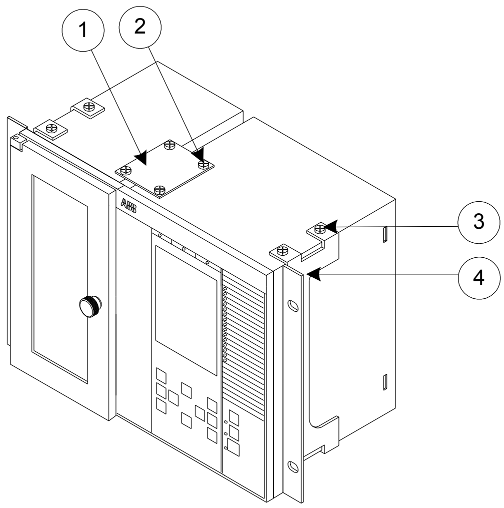


Figure 17: Side-by-side flush mounting details (RHGS6 side-by-side with 1/2 x 19" IED).

PosNo	Description	Quantity	Type
1	Mounting plate	2	-
2, 3	Screw	16	M4x6
4	Mounting angle	2	-

Procedure

1. Make a panel cut-out.
   For panel cut out dimension, see section "Side-by-side flush mounting dimensions".
2. Carefully press the sealing strip around the IED collar. Cut the end of the sealing strip a few mm to long to make the joining point tight.
   Repeat the same procedure with the second case.
   The sealing strip is delivered with the mounting kit. The strip is long enough for the largest available IED.
3. Place the two IEDs next to each other on a flat surface.

4. Fasten a side-by-side mounting plate (1).
   Use four of the delivered screws (2, 3).
5. Carefully turn the two IEDs up-side down.
6. Fasten the second side-by-side mounting plate.
   Use the remaining four screws.
7. Carefully fasten the mounting angles (4) to the sides of the IED.
   Use the fixing screws available in the mounting kit.
8. Insert the IED into the cut-out.
9. Fasten the mounting angles with appropriate screws.

5.4 Making the electrical connection

5.4.1 IED connectors

5.4.1.1 Overview

The quantity and designation of connectors depend upon the type and size of the IED. The rear cover plates are prepared with space for the maximum of HW options for each case size and the cut-outs that are not in use are covered with a plate from factory.

Overview

Table 1: Basic modules

Module	Description
Combined backplane module (CBM)	A backplane PCB that carries all internal signals between modules in an IED. Only the TRM (when included) is not connected directly to this board.
Universal backplane module (UBM)	A backplane PCB that forms part of the IED backplane with connectors for TRM (when included), ADM etc.
Power supply module (PSM)	Including a regulated DC/DC converter that supplies auxiliary voltage to all static circuits. • An internal fail alarm output is available.
Numerical module (NUM)	Module for overall application control. All information is processed or passed through this module, such as configuration, settings and communication.
Local Human machine interface (LHMI)	The module consists of LED:s, an LCD, a push button keyboard and an ethernet connector used to connect a PC to the IED.
Transformer input module (TRM)	Transformer module that galvanically separates the internal circuits from the VT and CT circuits. It has 12 analog inputs.
Analog digital conversion module (ADM)	Slot mounted PCB with A/D conversion.

Table 2: Application specific modules

Module	Description
Binary input module (BIM)	Module with 16 optically isolated binary inputs
Binary output module (BOM)	Module with 24 single outputs or 12 double-pole command outputs including supervision function
Binary I/O module (IOM)	Module with 8 optically isolated binary inputs, 10 outputs and 2 fast signalling outputs.
Line data communication modules (LDCM), short range, medium range, long range, X21	Modules used for digital communication to remote terminal.
Serial SPA/LON/IEC 60870-5-103/DNP3 communication modules (SLM)	Used for SPA/LON/IEC 60870–5–103/DNP3 communication
Optical ethernet module (OEM)	PMC board for IEC 61850 based communication.
mA input module (MIM)	Analog input module with 6 independent, galvanically separated channels.
GPS time synchronization module (GTM)	Used to provide the IED with GPS time synchronization.
Static output module (SOM)	Module with 6 fast static outputs and 6 change over output relays.
IRIG-B Time synchronization module (IRIG-B)	Module with 2 inputs. One is used for handling both pulse-width modulated signals and amplitude modulated signals and one is used for optical input type ST for PPS time synchronization.

5.4.1.2 Front side connectors

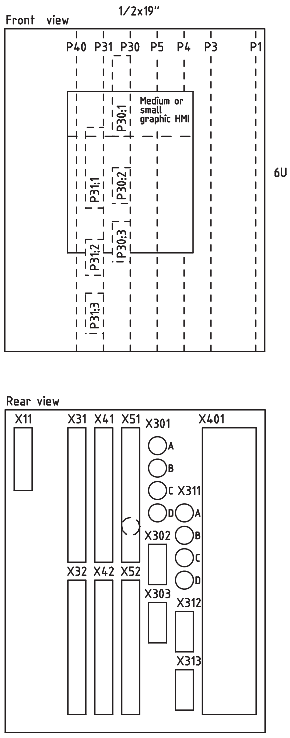
Figure 18: IED front side connector

PosNo	Description
1	IED serial communication port with RJ45 connector
2	Ethernet cable with RJ45 connectors

The cable between PC and the IED serial communication port shall be a crossed-over Ethernet cable with RJ45 connectors. If the connection are made via a hub or switch, a standard Ethernet cable can be used.

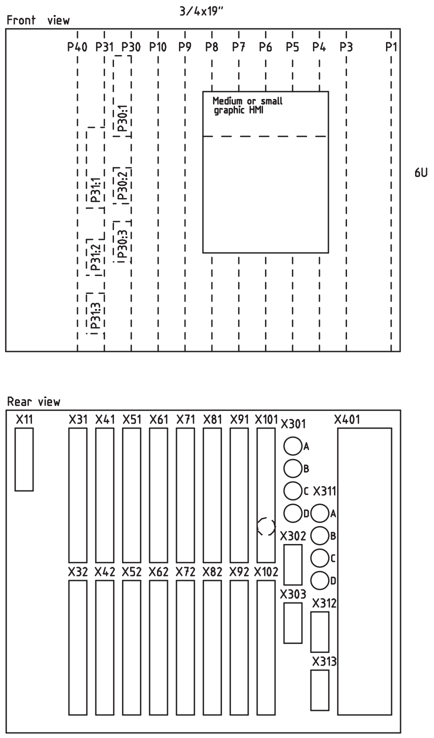
5.4.1.3 Rear side connectors

Table 3: Designations for 1/2 x 19” casing with 1 TRM slot



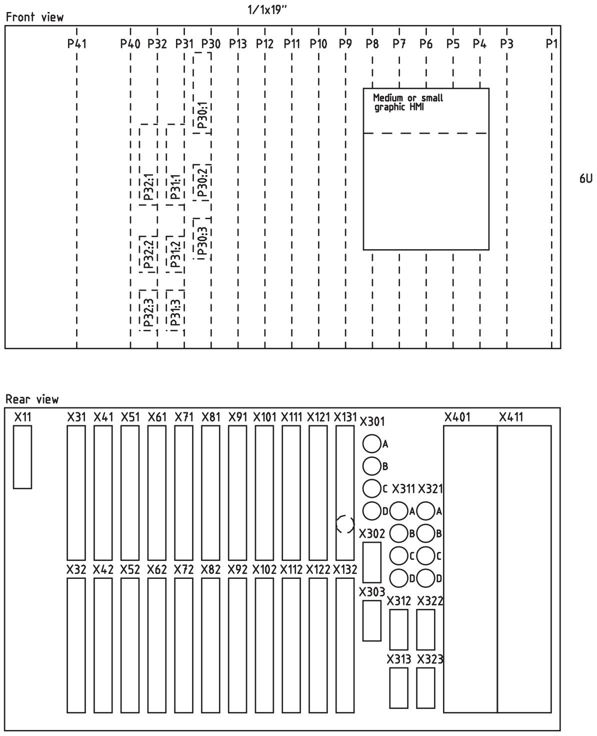
Module	Rear Positions
PSM	X11
BIM, BOM, SOM, IOM or MIM	X31 and X32 etc. to X51 and X52
SLM	X301:A, B, C, D
LDCM, IRIG-B or RS485	X302
LDCM or RS485	X303
OEM	X311:A, B, C, D
LDCM, RS485 or GTM	X312, 313
TRM	X401

Table 4: Designations for 3/4 x 19” casing with 1 TRM slot



Module	Rear Positions
PSM	X11
BIM, BOM, SOM, IOM or MIM	X31 and X32 etc. to X101 and X102
SLM	X301:A, B, C, D
LDCM, IRIG-B or RS485	X302
LDCM or RS485	X303
OEM	X311:A, B, C, D
LDCM, RS485 or GTM	X312, X313
TRM	X401

Table 5: Designations for 1/1 x 19” casing with 2 TRM slots



Module	Rear Positions
PSM	X11
BIM, BOM, SOM, IOM or MIM	X31 and X32 etc. to X131 and X132
SLM	X301:A, B, C, D
LDCM, IRIG-B or RS485	X302
LDCM or RS485	X303
OEM	X311:A, B, C, D
LDCM, RS485 or GTM	X312, X313, X322, X323
TRM 1	X401
TRM 2	X411

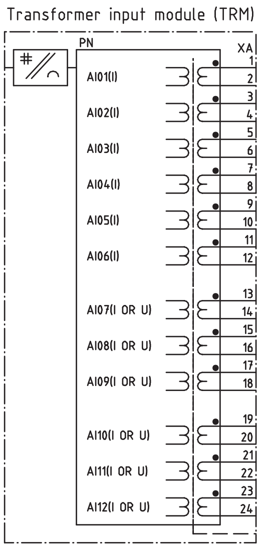


Figure 19: Transformer input module (TRM)

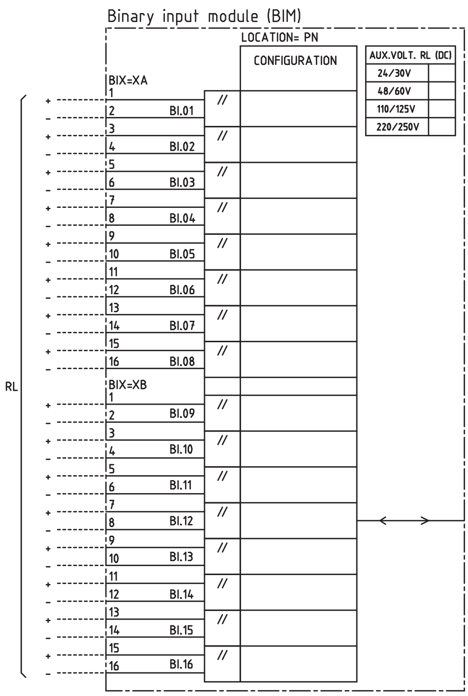
■ Indicates high polarity

	CT/VT-input designation according to figure 19

Table continues on next page

Current/voltage configuration (50/60 Hz)	AI01	AI02	AI03	AI04	AI05	AI06	AI07	AI08	AI09	AI10	AI11	AI12
12I, 1A	1A	1A	1A	1A	1A	1A	1A	1A	1A	1A	1A	1A
12I, 5A	5A	5A	5A	5A	5A	5A	5A	5A	5A	5A	5A	5A
9I+3U, 1A	1A	1A	1A	1A	1A	1A	1A	1A	1A	110-220 V	110-220 V	110-220 V
9I+3U, 5A	5A	5A	5A	5A	5A	5A	5A	5A	5A	110-220 V	110-220 V	110-220 V
6I+6U, 1A	1A	1A	1A	1A	1A	1A	110-220 V	110-220 V	110-220 V	110-220 V	110-220 V	110-220 V
6I+6U, 5A	5A	5A	5A	5A	5A	5A	110-220 V	110-220 V	110-220 V	110-220 V	110-220 V	110-220 V

Note that internal polarity can be adjusted by setting of analog input CT neutral direction and/or on SMAI pre-processing function blocks.



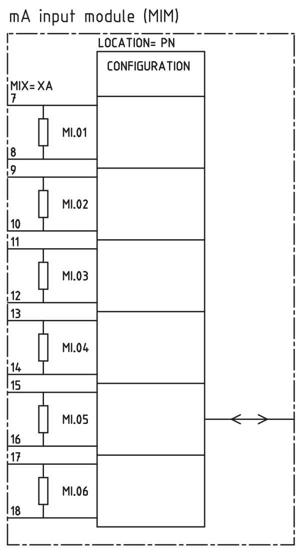


Figure 21: mA input module (MIM)

Figure 20: Binary input module (BIM). Input contacts named XA corresponds to rear position X31, X41, and so on, and input contacts named XB to rear position X32, X42, and so on.

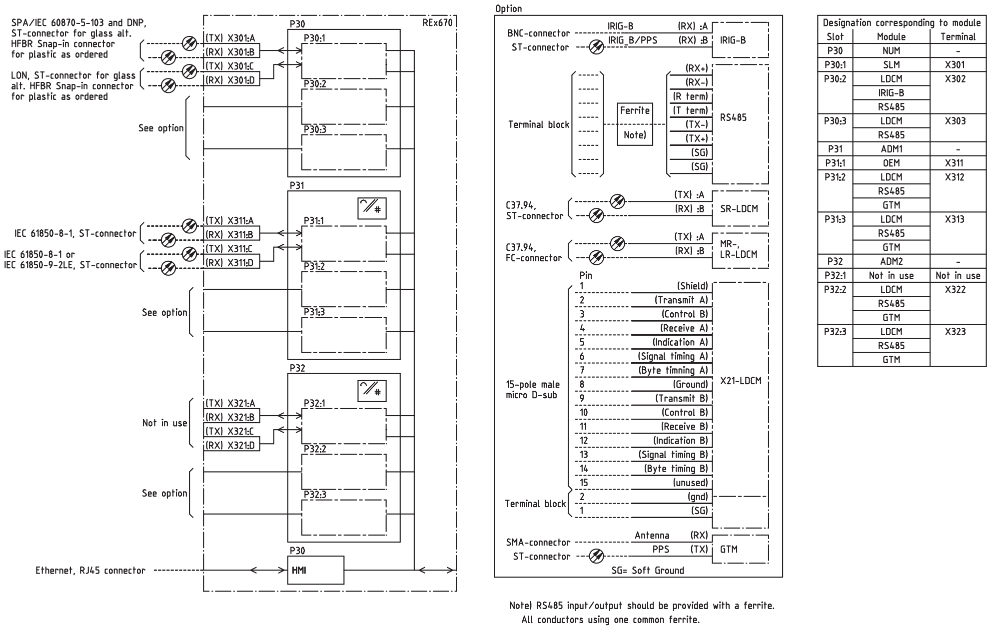


Figure 22: IED with basic functionality and communication interfaces

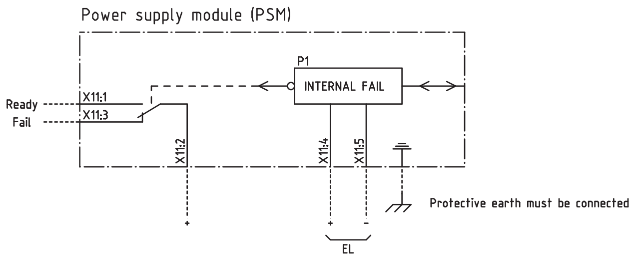


Figure 23: Power supply module (PSM)

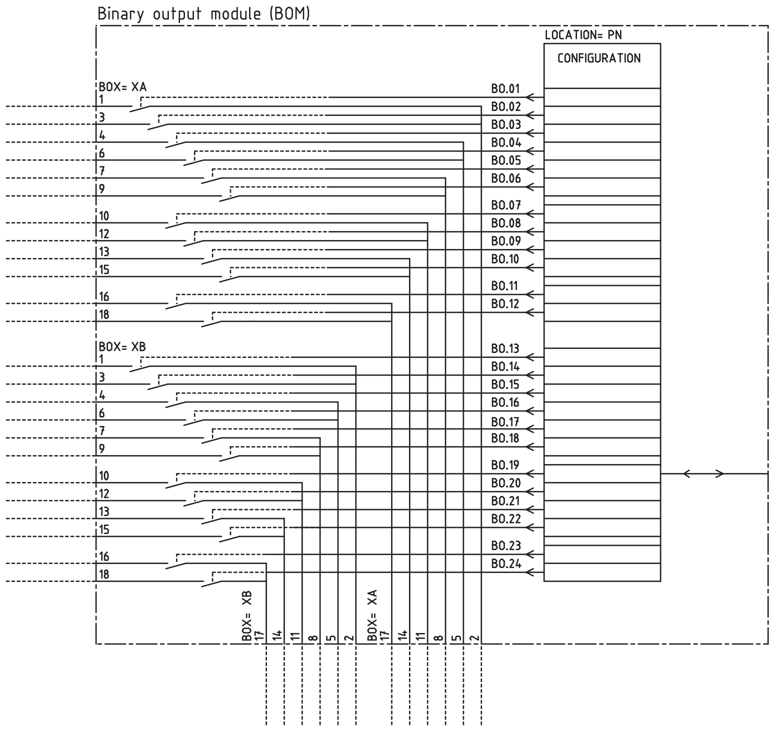


Figure 24: Binary output module (BOM). Output contacts named XA corresponds to rear position X31, X41, and so on, and output contacts named XB to rear position X32, X42, and so on.

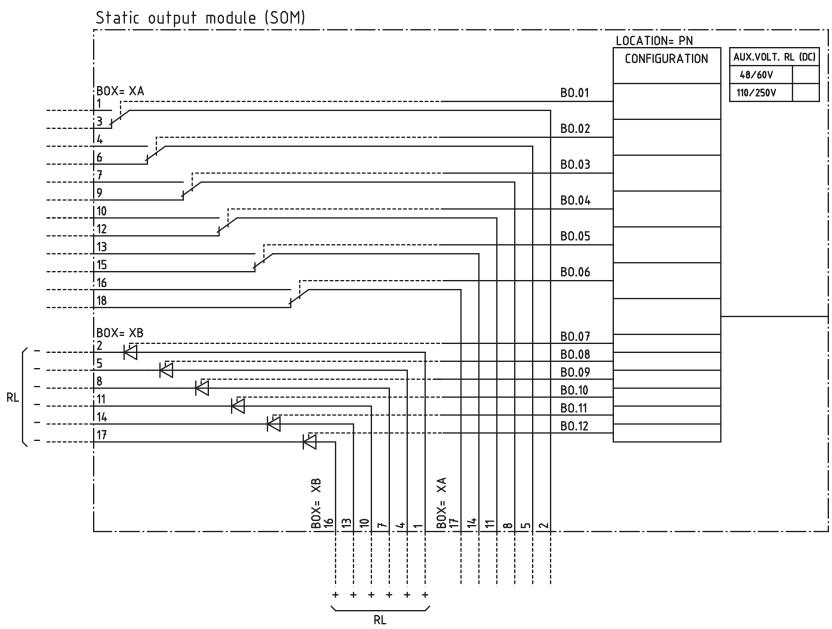


Figure 25: Static output module (SOM)

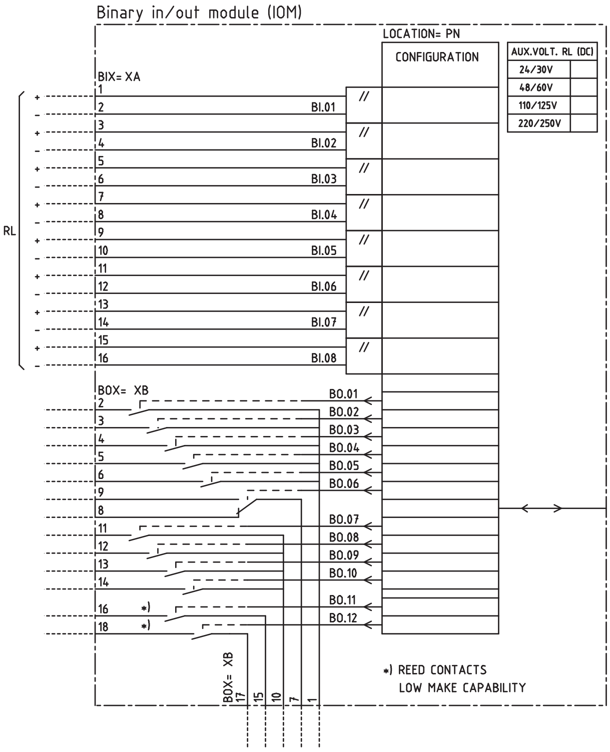


Figure 26: *Binary in/out module (IOM). Input contacts named XA corresponds to rear position X31, X41, and so on, and output contacts named XB to rear position X32, X42, and so on.*

5.4.2 Connecting to protective earth

Connect the protective earthing screw (pos 1 in figure 27) on the rear of the IED to the closest possible earthing point in the cubicle. Electrical codes and standards require that protective earth cables are green/yellow conductors with a cross section area of at least 2.5 mm^2 (AWG14). The Power supply module (PSM), Transformer input modules (TRM) and the enclosure are all separately earthed, see figure 27 below.

The cubicle must be properly connected to the station earthing system. Use a conductor with a core cross section area of at least 4 mm^2 (AWG 12).

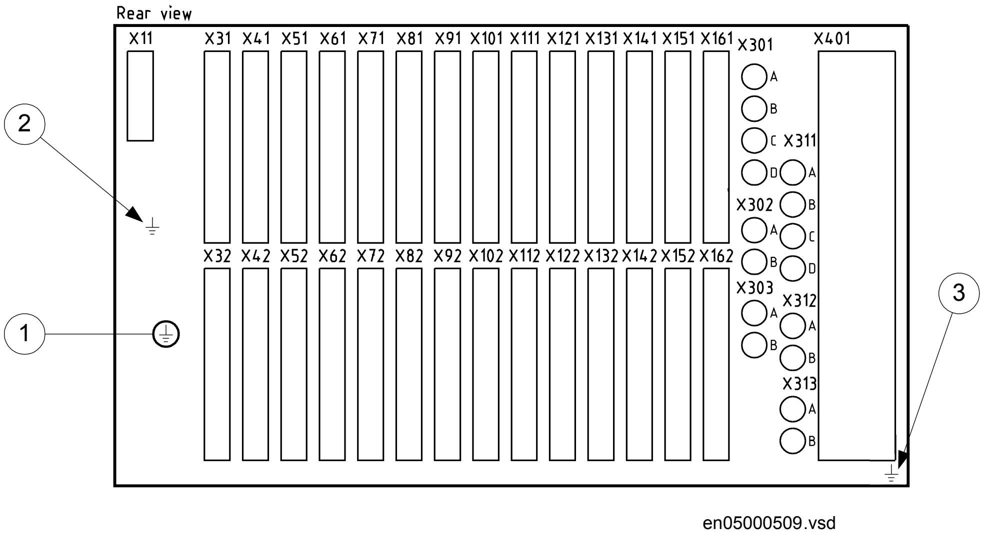


Figure 27: Rear view of IED showing earthing points.

Pos	Description
1	Main protective earth to chassis
2	Earthing screw to Power supply module (PSM)
3	Earthing screw to Transformer input module (TRM). (There is one earth connection per TRM)

Use the main protective earth screw (1) for connection to the stations earthing system. Earthing screws for PSM module (2) and TRM module (3) must be fully tightened to secure protective earth connection of these modules.

5.4.3 Connecting the power supply module

The wiring from the cubicle terminal block to the IED terminals (see Figure 23 for PSM connection diagram) must be made in accordance with the established guidelines for this type of equipment. The wiring should have a minimum cross-sectional area of 1.0 mm^2 and a voltage rating of 250 V. Branch circuit protection must be provided in the power supply wiring to the IED, and if necessary it must be possible to disconnect manually from the power supply. Fuse or circuit breaker up to 6 A and 250 V should be close to the equipment. It is recommended to separate the instrument transformer leads from the other cables, that is, they should not be run in the same cable ducts or loom. The connections are made on connector X11. For location of connector X11, refer to section "Rear side connectors".

5.4.4 Connecting to CT and VT circuits

CTs and VTs are connected to the 24–pole connector of the Transformer input module (TRM) on the rear side of the IED. Connection diagram for TRM is shown in figure 19.

Use a solid conductor with a cross section area between 2.5-6 mm^2 (AWG14-10) or a stranded conductor with a cross section area between 2.5-4 mm^2 (AWG14-12).

If the IED is equipped with a test-switch of type RTXP 24, COMBIFLEX wires with 20 A sockets must be used to connect the CT and VT circuits.

Connectors on TRM (for location see section "Rear side connectors") for current and voltage transformer circuits are so called “feed-through IED blocks” and are designed for conductors with cross sectional area up to 4 mm^2 (AWG 12). The screws used to fasten the conductors should be tightened with a torque of 1Nm.

Connector terminals for CT and VT circuits, as well as terminals for binary input and output signals, can be of either ringlug or compression connection type, depending on ANSI/IEC standards, or customers choice.

Table 6: CT and VT circuit connectors

Connector type	Rated voltage and current	Maximum conductor area
Screw compression type	250 V AC, 20 A	4 mm^2 (AWG12) 2 x 2.5 mm^2 (2 x AWG14)
Terminal blocks suitable for ring lug terminals	250 V AC, 20 A	4 mm^2 (AWG12)

5.4.4.1 Configuration for analog CT inputs

The secondary rated current of the CT (that is, 1A or 5A) determines the choice of TRM in the IED. Two TRMs are available, One is dimensioned for an input current of 5A and the other for an input of 1A. If the CT rated secondary current does not match the TRM input current rating adjustments can be made in settings depending on the tolerance of the TRM.

5.4.5 Connecting the binary input and output signals

Auxiliary power and signals are connected using voltage connectors. Signal wires are connected to a female connector, see figure 28, which is then plugged into the corresponding male connector, see figure 29, located at the rear of the IED. For location of BIM, BOM and IOM refer to section "Rear side connectors". Connection diagrams for BIM, BOM and IOM are shown in figure 20, figure 24 and figure 26.

If the IED is equipped with a test-switch of type RTXP 24, COMBIFLEX wires with 20 A sockets, 1.5mm² (AWG16) conductor area must be used to connect the auxiliary power.

Procedure

1. Connect signals to the female connector
   All wiring to the female connector should be done before it is plugged into the male part and screwed to the case. The conductors can be of rigid type (solid, stranded) or of flexible type.
   The female connectors accept conductors with a cross section area of 0.2-2.5 mm^2 (AWG 24-14). If two conductors are used in the same terminal, the maximum permissible cross section area is 0.2-1 mm^2 (AWG 24-18).
   If two conductors, each with area 1.5 mm^2 (AWG 16) need to be connected to the same terminal, a ferrule must be used, see figure 30. This ferrule, is applied with the by Phoenix recommended crimping tool.The fastening screw shall be tightened with a torque of 0.4 Nm (This torque applies to all binary connectors).
2. Plug the female connector to the corresponding back-side mounted male connector
3. Lock the female connector by fastening the lock screws

xx02000742.vsd

Figure 28: A female connector

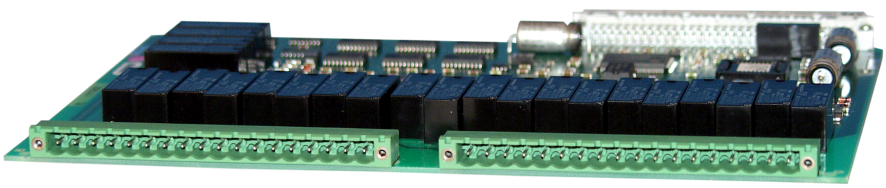


Figure 29: Board with male connectors

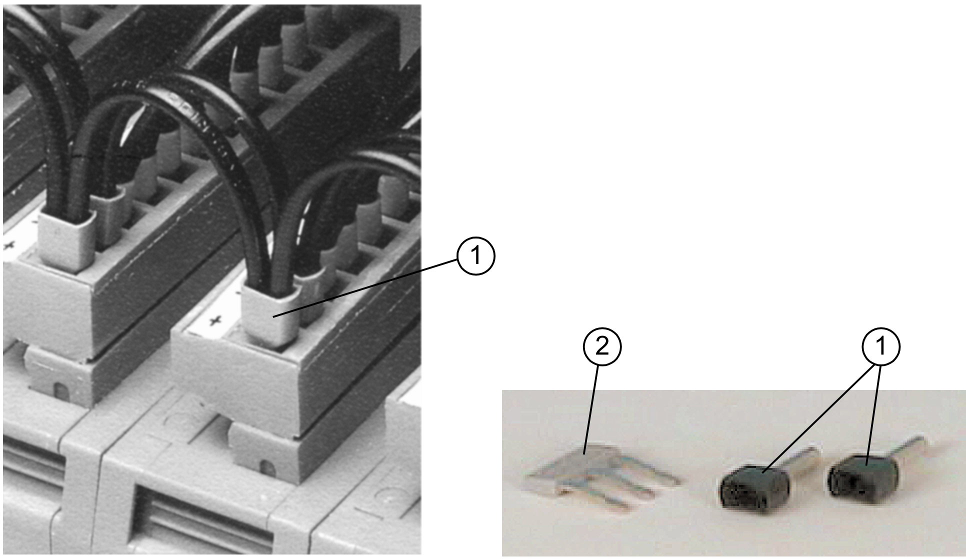


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Figure 30: Cable connectors

PosNo	Description
1	Is ferrule,
2	A bridge connector, is used to jump terminal points in a connector.

Table 7: Binary I/O connection system

Connector type	Rated voltage	Maximum conductor area
Screw compression type	250 V AC	2.5 mm^2 (AWG14) 2 × 1 mm^2 (2 x AWG18)
Terminal blocks suitable for ring lug terminals	300 V AC	3 mm^2 (AWG14)

Because of limitations of space, when ring lug terminal is ordered for Binary I/O connections, one blank slot is necessary between two adjacent IO cards. Please refer to the ordering particulars for details.

5.4.6 Making the screen connection

When using screened cables always make sure screens are earthed and connected according to applicable engineering methods. This may include checking for appropriate earthing points near the IED, for instance, in the cubicle and/or near the source of measuring. Ensure that earth connections are made with short (max. 10

cm) conductors of an adequate cross section, at least 6 mm^2 (AWG10) for single screen connections.

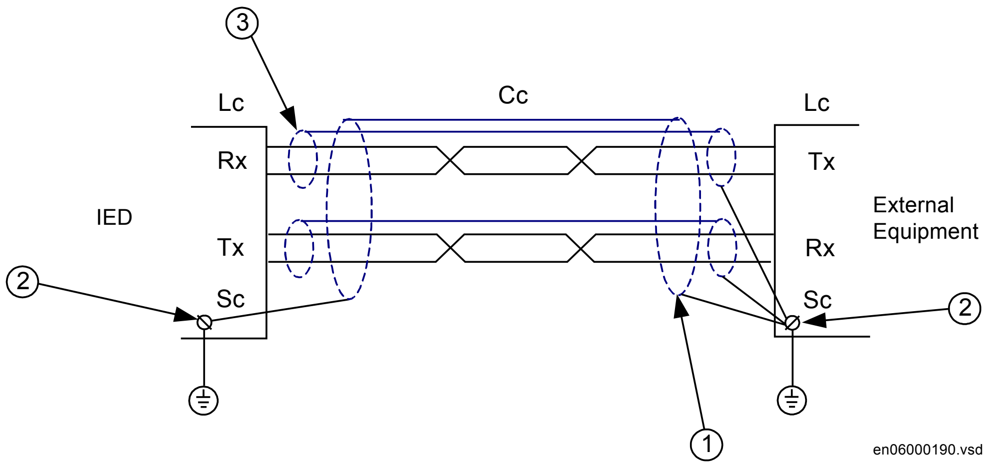


Figure 31: Communication cable installation.

PosNo	Description
1	Outer shield
2	Protective earth screw
3	Inner shield

Inner shielding of the cable shall be earthed at the external equipment end only. At the IED terminal end, the inner shield must be isolated from protective earth.

5.5 Making the optical connections

5.5.1 Connecting station communication interfaces

The IED can be equipped with an optical ethernet module (OEM), see figure 22, needed for IEC 61850 communication and a serial communication module (SLM), see figure 22 for LON, SPA, IEC 60870–5–103 or DNP3 communication. In such cases optical ports are provided on the rear side of the case for connection of the optical fibers. For location of OEM and SLM, refer to section "Rear side connectors".

- Optical ports X311: A, B (Tx, Rx) and X311: C, D (Tx, Rx) on OEM are used for IEC 61850-8-1 communication. Both ports AB and CD shall be connected when redundant IEC 61850-8-1 communication is used. Connectors are of ST type. When OEM is used, the protection plate for the galvanic connection must not be removed.

- Optical port X301: A, B (Tx, Rx) on SLM module is used for SPA, IEC 60870-5-103 or DNP3 communication. Connectors are of ST type (glass) or HFBR Snap in (plastic).
- Optical port X301: C, D (Tx, Rx) on SLM module is used for LON communication. Connectors are of ST type (glass) or HFBR Snap in (plastic).

The optical fibers have Transmission (Tx) and Reception (Rx) connectors, and they should be attached to the Tx and Rx connectors of OEM and SLM module (Tx cable to Rx connector, Rx cable to Tx connector).

Connectors are generally color coded; connect blue or dark grey cable connectors to blue or dark grey (receive) back-side connectors. Connect black or grey cable connectors to black or grey (transmit) back-side connectors.

The fiber optical cables are very sensitive to handling. Do not bend too sharply. The minimum curvature radius is 15 cm for the plastic fiber cables and 25 cm for the glass fiber cables. If cable straps are used to fix the cables, apply with loose fit.
Always hold the connector, never the cable, when connecting or disconnecting optical fibers. Do not twist, pull or bend the fiber. Invisible damage may increase fiber attenuation thus making communication impossible.

Please, strictly follow the instructions from the manufacturer for each type of optical cables/connectors.

5.5.2 Connecting remote communication interfaces LDCM

The Line Data Communication Module (LDCM), see figure 22 is the hardware used for the transfer of binary and analog signal data between IEDs in different protection schemes on the IEEE/ANSI C37.94 protocol. The optical ports on the rear side of the IED are X312 and X313. For location of LDCM, refer to section "Rear side connectors".

When LDCM is used for binary signal exchange between IEDs in the same station or even within the same panel (that is, between three one-phase REB670) the fiber optic cables can be quite short (that is, 1-2 meters). In such installation it is of outmost importance to set the LDCM setting parameter *OptoPower* = *LowPower*.

5.6 Installing the serial communication cable for RS485

5.6.1 RS485 serial communication module

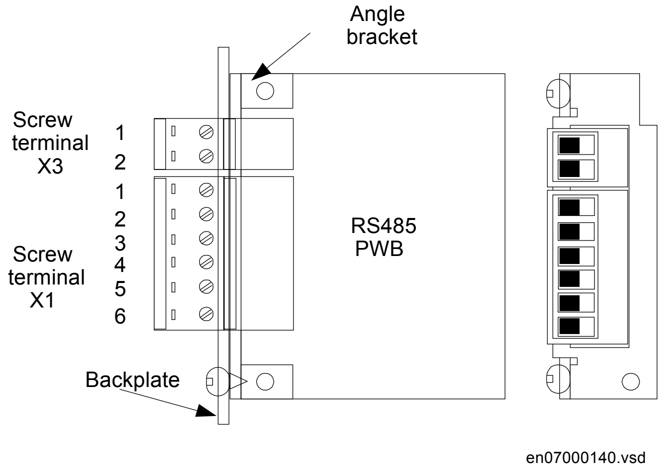


Figure 32: The connection plate to the backplate with connectors and screws. This figure also shows the pin numbering from the component side

Pin	Name 2-wire	Name 4-wire	Description
x3:1			soft ground
x3:2			soft ground
x1:1	RS485 +	TX+	Receive/transmit high or transmit high
x1:2	RS485 –	TX-	Receive/transmit low or transmit low
x1:3	Term	T-Term	Termination resistor for transmitter (and receiver in 2-wire case) (connect to TX+)
x1:4	reserved	R-Term	Termination resistor for receiver (connect to RX+)
x1:5	reserved	RX-	Receive low
x1:6	reserved	RX+	Receive high
2–wire:	Connect pin X1:1 to pin X1:6 and pin X1:2 to pin X1:5.		
Termination (2-wire):	Connect pin X1:1 to pin X1:3		
Termination (4-wire):	Connect pin X1:1 to pin X1:3 and pin X1:4 to pin X1:6		

The distance between earth points should be < 1200 m (3000 ft), see figure 33 and 34. Only the outer shielding is connected to the protective earth at the IED. The inner and outer shieldings are connected to the protective earth at the external equipment. Use insulating tape for the inner shield to prevent contact with the protective earth. Make sure that the terminals are properly earthed with as short connections as possible from the earth screw, for example to an earthed frame.

The IED and the external equipment should preferably be connected to the same battery.

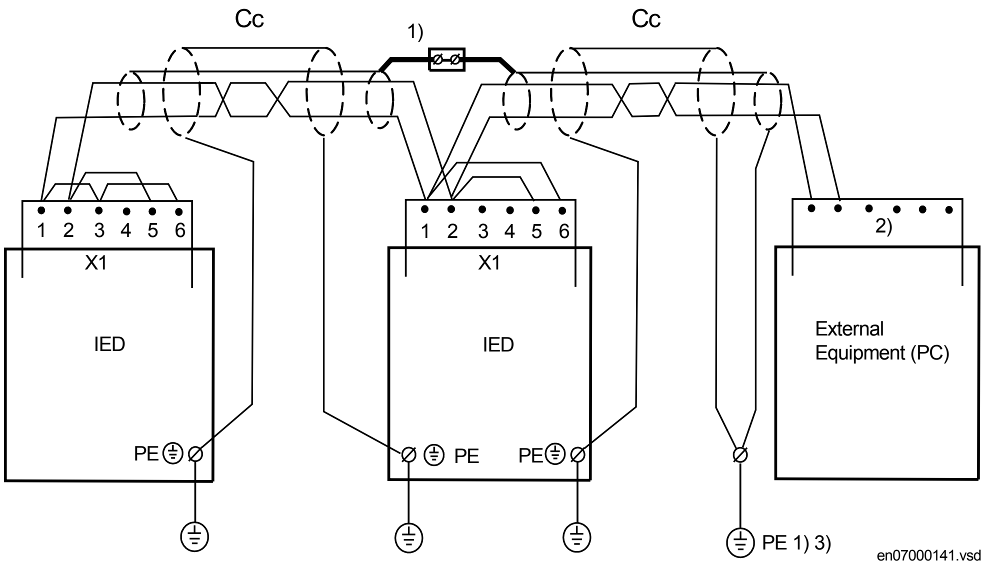


Figure 33: Communication cable installation, 2-wire

Where:

1	The inner shields shall be connected together (with an isolated terminal block) and only have **one earthing point** in the whole system, preferably at the external equipment (PC). The outer shield shall be connected to Protective Earth (PE) in every cable end that is, to PE at all IED terminals and to PE at External equipment (PC). The first **IED** will have only one cable end but all others of course two.
2	Connect according to installation instructions for the actual equipment, observe the 120 ohms termination.
3	The protective earth should be close to the external equipment (< 2m)
Cc	Communication cable
PE	Protective earth screw

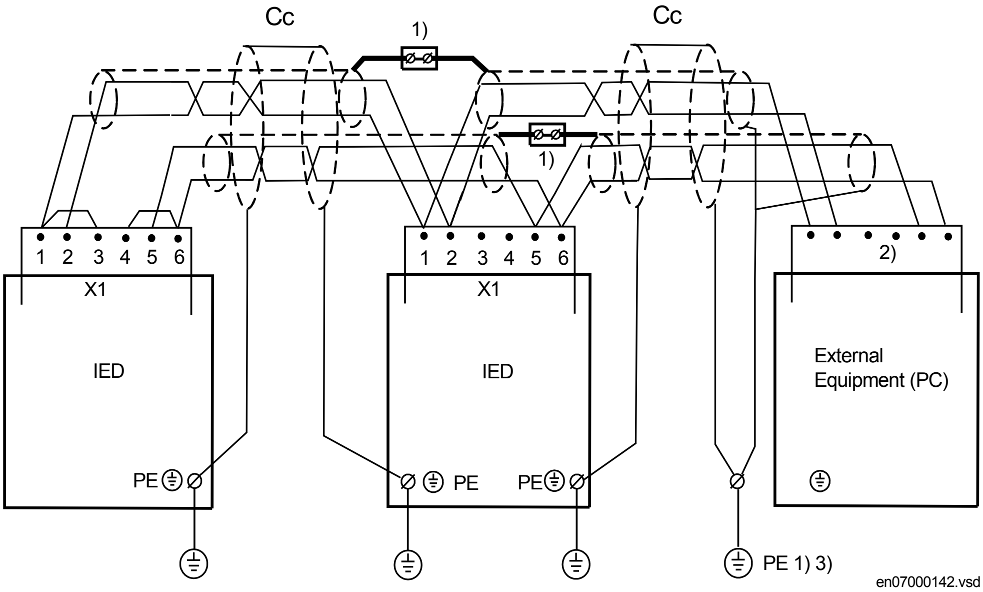


Figure 34: Communication cable installation, 4-wire

Where:

1	The inner shields shall be connected together (with an isolated terminal block) and only have **one earthing point** in the whole system, preferably at the external equipment (PC). The outer shield shall be connected to Protective Earth (PE) in every cable end that is, to PE at all IED terminals and to PE at External equipment (PC). The first **IED** will have only one cable end but all others of course two.
2	Connect according to installation instructions for the actual equipment, observe the 120 ohms termination.
3	The protective earth should be close to the external equipment (< 2m)
Cc	Communication cable
PE	Protective earthscrew

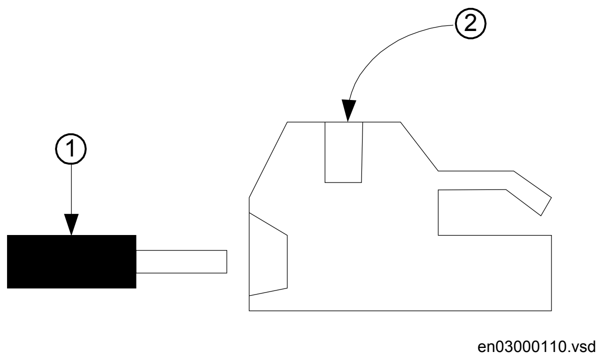


Figure 35: Cable contact, Phoenix: MSTB2.5/6-ST-5.08 1757051

Where:

1	is cable
2	is screw

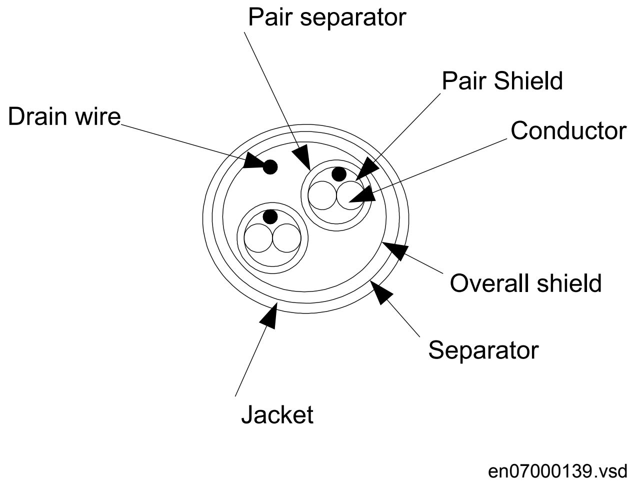


Figure 36: Cross section of communication cable

The EIA standard RS-485 specifies the RS485 network. An informative excerpt is given in section "Installing the serial communication cable for RS485 SPA/IEC".

5.6.2 Installing the serial communication cable for RS485 SPA/IEC

Informative excerpt from EIA Standard RS-485 - Electrical Characteristics of Generators and Receivers for Balanced Digital Multipoint Systems

RS-485 Wire - Media dependent Physical layer

1 **Normative references**

EIA Standard RS-485 - Electrical Characteristics of Generators and Receivers for Balanced Digital Multipoint Systems

2 **Transmission method**

RS-485 differential bipolar signaling

2.1 **Differential signal levels**

Two differential signal levels are defined:

A+ =line A positive with respect to line B

A- =line A negative with respect to line B

2.2 **Galvanic isolation**

The RS485 circuit shall be isolated from earth by:

Riso ≥ 10 MΩ

Ciso ≤ 10 pF

Three isolation options exist:

a) The entire node electronics can be galvanically isolated

b) The bus interface circuit can be isolated form the rest of node electronics by optoisolators, transformer coupling or otherwise.

c) The RS485 chip can include built-in isolation

2.3 **Bus excitation and signal conveyance**

2.3.1 **Requirements**

a) The RS485 specification requires the Signal A and Signal B wires.

b) Each node also requires (5 V) Excitation of the RS485 termination network.

c) Vim - the common mode voltage between any pair of RS485 chips may not exceed 10 V.

d) A physical ground connection between all RS485 circuits will reduce noise.

2.3.2 **Bus segment termination network**

The termination network below required at each end of each Bus Ph-segment.

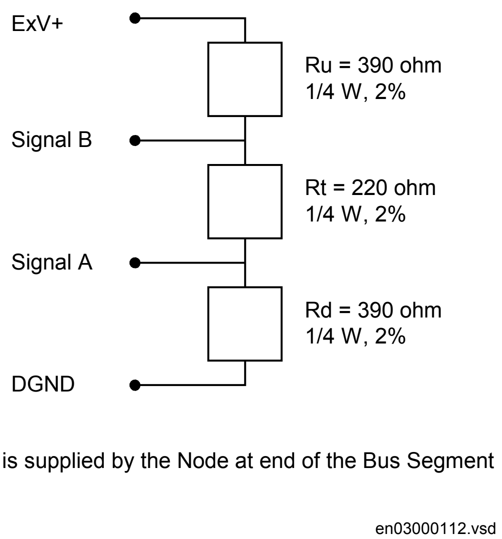


Figure 37: RS-485 bus segment termination

Table continues on next page

ExV is supplied by the Node at end of the Bus Segment

The specifications of the components are:

a) Ru	+ 5 V to Signal B	= 390 Ω, 0.25 W ±2.5%
b) Rt	Signal B to Signal A	= 220 Ω, 0.25 W ±2.5%
c) Rd	Signal A to GND	= 390 Ω, 0.25 W ±2.5%

2.3.3 Bus power distribution

The end node in each Ph-segment applies 5 V bus excitation power to the Termination network via the Excitation pair (ExV+ and GND) used in the Type 3 Physical layer specification.

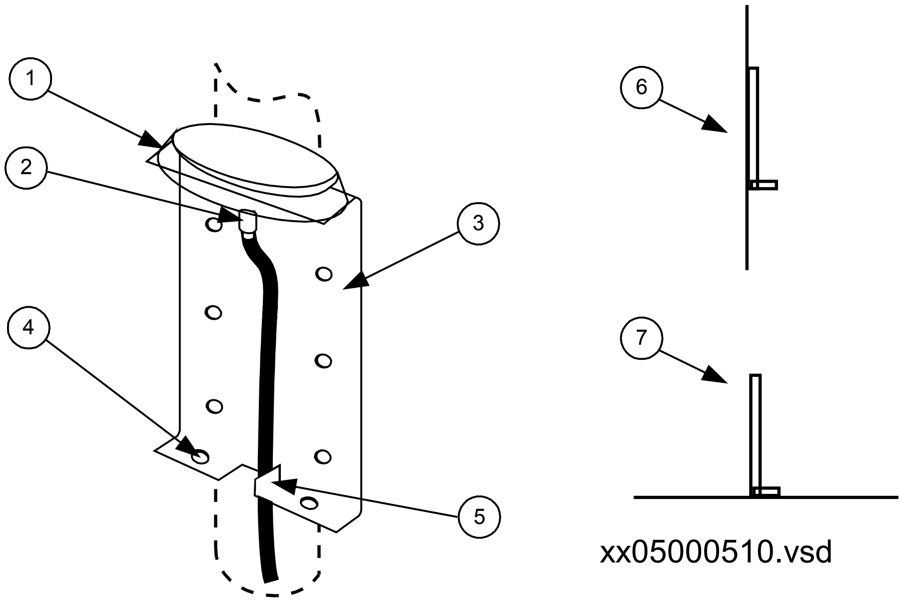
5.6.3 Data on RS485 serial communication module cable

Type:	Twisted-pair S-STP (Screened – Screened Twisted Pair)
Shield:	Individual foil for each pair with overall copper braid
Length:	Maximum 1200 m (3000 ft) from one system earth to the next system earth (includes length from platform point to system earth on both sides)
Temp:	According to application
Impedance:	120 Ω
Capacitance:	Less than or equal to 42 pF/m
Example:	Belden 9841,Alpha wire 6412, 6413

5.7 Installing the GPS antenna

5.7.1 Antenna installation

The antenna is mounted on a console for mounting on a horizontal or vertical flat surface or on an antenna mast.



PosNO	Description
1	GPS antenna
2	TNC connector
3	Console, 78x150 mm
4	Mounting holes 5.5 mm
5	Tab for securing of antenna cable
6	Vertical mounting position (on antenna mast etc.)
7	Horizontal mounting position

Mount the antenna and console clear of flat surfaces such as buildings walls, roofs and windows to avoid signal reflections. If necessary, protect the antenna from animals and birds which can affect signal strength. Also protect the antenna against lightning.

Always position the antenna and its console so that a continuous clear line-of-sight visibility to all directions is obtained, preferably more than 75%. A minimum of 50% clear line-of-sight visibility is required for un-interrupted operation.

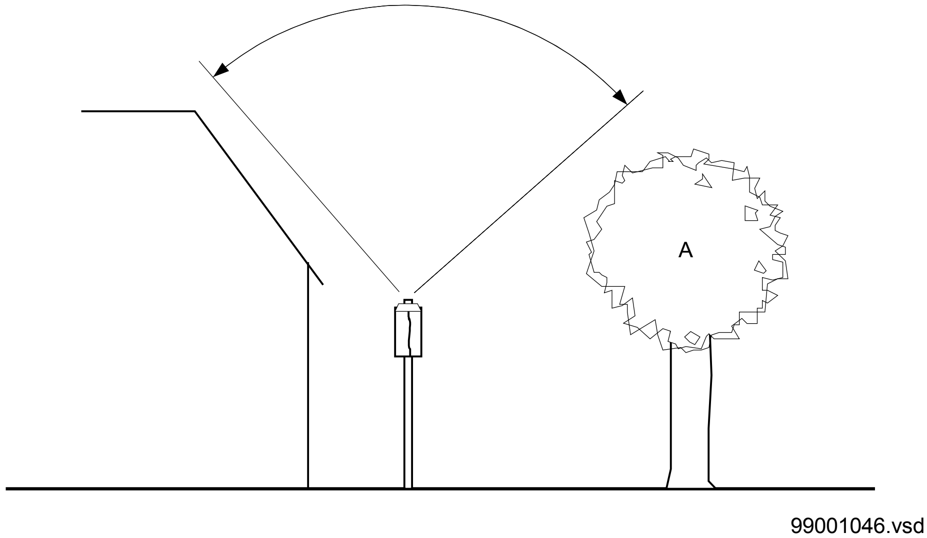


Figure 38: Antenna line-of-sight

5.7.2 Electrical installation

Use a 50 ohm coaxial cable with a male TNC connector on the antenna end and a male SMA connector on the receiver end to connect the antenna to the IED. Choose cable type and length so that the total attenuation is max. 26 dB at 1.6 GHz. A suitable antenna cable is supplied with the antenna.

The antenna has a female TNC connector to the antenna cable. For location of GPS time module (GTM), refer to section "Rear side connectors". Connection diagram for GTM is shown in figure 22.

Make sure that the antenna cable is not charged when connected to the antenna or to the receiver. Short-circuit the end of the antenna cable with some metal device, then connect to the antenna. When the antenna is connected to the cable, connect the cable to the receiver. The IED must be switched off when the antenna cable is connected.

5.7.3 Lightning protection

The antenna should be mounted with adequate lightning protection, that is the antenna mast must not rise above a neighboring lightning conductor.

Section 6 Checking the external optical and electrical connections

About this chapter

This chapter describes what to check to ensure correct connection to the external circuitry, such as the auxiliary power supply, CT’s and VT’s. These checks must be made with the protection IED de-energized.

6.1 Overview

The user must check the installation which includes verifying that the IED is connected to the other parts of the protection system. This is done with the IED and all connected circuits de-energized.

6.2 Checking VT circuits

Check that the wiring is in strict accordance with the supplied connection diagram.

Correct possible errors before continuing to test the circuitry.

Test the circuitry.

- Polarity check
- VT circuit voltage measurement (primary injection test)
- Earthing check
- Phase relationship
- Insulation resistance check

The polarity check verifies the integrity of circuits and the phase relationships. The check must be performed as close to the IED as possible.

The primary injection test verifies the VT ratio and the wiring all the way from the primary system to the IED. Injection must be performed for each phase-to-neutral circuit and each phase-to-phase pair. In each case, voltages in all phases and neutral are measured.

6.3 Checking CT circuits

Check that the wiring is in strict accordance with the supplied connection diagram.

The CTs must be connected in accordance with the circuit diagram provided with the IED, both with regards to phases and polarity. The following tests shall be performed on every primary CT connected to the IED:

- Primary injection test to verify the current ratio of the CT, the correct wiring up to the protection IED and correct phase sequence connection (that is L1, L2, L3.)
- Polarity check to prove that the predicted direction of secondary current flow is correct for a given direction of primary current flow. This is an essential test for the proper operation of the differential function.
- CT secondary loop resistance measurement to confirm that the current transformer secondary loop DC resistance is within specification and that there are no high resistance joints in the CT winding or wiring.
- CT excitation test in order to confirm that the current transformer is of the correct accuracy rating and that there are no shorted turns in the current transformer windings. Manufacturer's design curves must be available for the current transformer to compare the actual results.
- Earthing check of the individual CT secondary circuits to verify that each three-phase set of main CTs is properly connected to the station earth and only at one electrical point.
- Insulation resistance check.
- Phase identification of CT shall be made.

Both the primary and the secondary sides must be disconnected from the line and the IED when plotting the excitation characteristics.

If the CT secondary circuit earth connection is removed without the current transformer primary being de-energized, dangerous voltages may result in the secondary CT circuits.

6.4 Checking the power supply

Check that the auxiliary supply voltage remains within the permissible input voltage range under all operating conditions. Check that the polarity is correct before powering the IED.

6.5 Checking the binary I/O circuits

6.5.1 Binary input circuits

Preferably, disconnect the binary input connector from the binary input cards. Check all connected signals so that both input level and polarity are in accordance with the IED specifications.

6.5.2 Binary output circuits

Preferably, disconnect the binary output connector from the binary output cards. Check all connected signals so that both load and polarity are in accordance with IED specifications.

6.6 Checking optical connections

Check that the Tx and Rx optical connections are correct.

An IED equipped with optical connections requires a minimum depth of 180 mm for plastic fiber cables and 275 mm for glass fiber cables. Check the allowed minimum bending radius from the optical cable manufacturer.

Section 7 Energizing the IED

About this chapter

This chapter describes the start-up sequence and what to check once the IED has been energized.

7.1 Checking the IED operation

Check all connections to external circuitry to ensure correct installation, before energizing the IED and carrying out the commissioning procedures.

The user could also check the software version, the IED's serial number and the installed modules and their ordering number to ensure that the IED is according to delivery and ordering specifications.

Energize the power supply of the IED to start it up. This could be done in a number of ways, from energizing a whole cubicle to energizing a single IED. The user should re-configure the IED to activate the hardware modules in order to enable the self supervision function to detect possible hardware errors. Set the IED time if no time synchronization source is configured. Check also the self-supervision function in **Main menu/Diagnostics/Monitoring** menu in local HMI to verify that the IED operates properly.

7.2 Energizing the IED

When the IED is energized, the green LED starts flashing instantly. After approximately 55 seconds the window lights up and the window displays ‘IED Startup’. The main menu is displayed and the upper row should indicate ‘Ready’ after about 90 seconds. A steady green light indicates a successful startup.

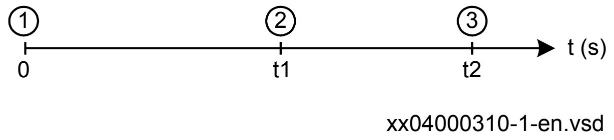


Figure 39: Typical IED start-up sequence

1 IED energized. Green LED instantly starts flashing

2 LCD lights up and "IED startup" is displayed

3 The main menu is displayed. A steady green light indicates a successful startup.

If the upper row in the window indicates ‘Fail’ instead of ‘Ready’ and the green LED flashes, an internal failure in the IED has been detected. See section "Checking the self supervision function" in this chapter to investigate the fault.

An example of the local HMI is shown in figure 40.

7.3 Design

The different parts of the medium size local HMI are shown in figure 40. The local HMI exists in an IEC version and in an ANSI version. The difference is on the keypad operation buttons and the yellow LED designation.

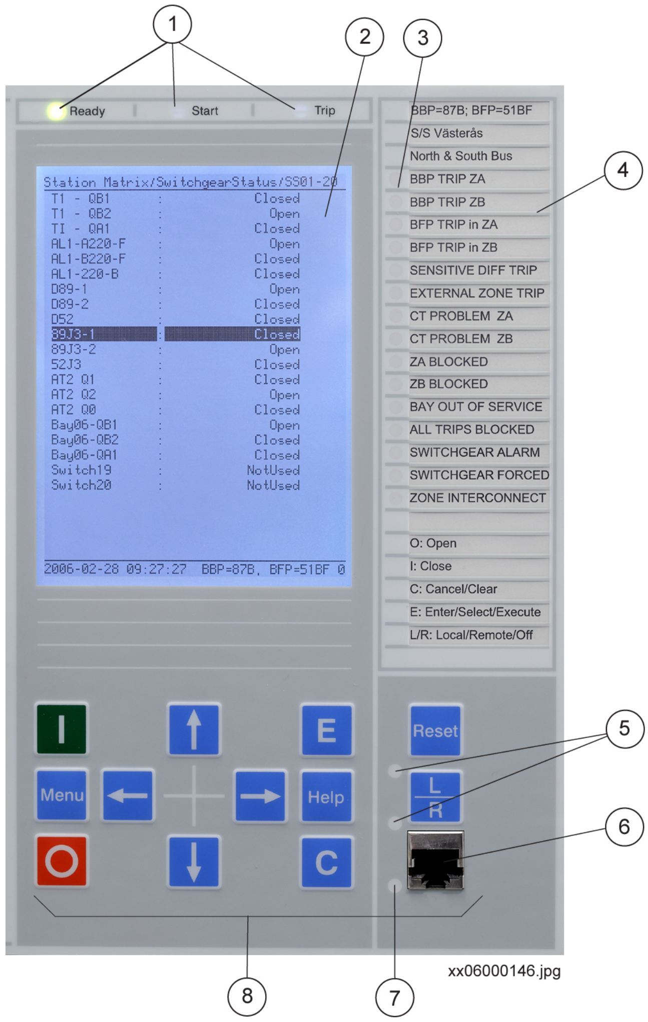


Figure 40: Medium size graphic HMI

1 Status indication LEDs
2 LCD
3 Indication LEDs
4 Label
5 Local/Remote LEDs
6 RJ45 port
7 Communication indication LED
8 Keypad

7.4 Checking the self supervision signals

7.4.1 Reconfiguring the IED

I/O modules configured as logical I/O modules (BIM, BOM or IOM) are supervised.

I/O modules that are not configured are not supervised.

Each logical I/O module has an error flag that indicates signal or module failure. The error flag is also set when the physical I/O module of the correct type is not detected in the connected slot.

7.4.2 Setting the IED time

This procedure describes how to set the IED time from the local HMI.

1. Display the set time dialog.
   Navigate to **Main menu/Settings/Time/System time**
   Press the *E* button to enter the dialog.
2. Set the date and time.
   Use the *Left* and *Right* arrow buttons to move between the time and date values (year, month, day, hours, minutes and seconds). Use the *Up* and *Down* arrow buttons to change the value.
3. Confirm the setting.
   Press the *E* button to set the calendar and clock to the new values.

7.4.3 Checking the self supervision function

7.4.3.1 Determine the cause of an internal failure

This procedure describes how to navigate the menus in order to find the cause of an internal failure when indicated by the flashing green LED on the HMI module.

Procedure

1. Display the general diagnostics menu.
   Navigate the menus to:
   Diagnostics/IED status/General
2. Scroll the supervision values to identify the reason for the failure.
   Use the arrow buttons to scroll between values.

7.4.4 Self supervision HMI data

Table 8: Signals from the General menu in the diagnostics tree.

Indicated result	Possible reason	Proposed action
InternFail OK	No problem detected.	None.
InternFail Fail	A failure has occurred.	Check the rest of the indicated results to find the fault.
InternWarning OK	No problem detected.	None.
InternWarning Warning	A warning has been issued.	Check the rest of the indicated results to find the fault.
NUM-modFail OK	No problem detected.	None.
NUM-modFail Fail	The main processing module has failed.	Contact your ABB representative for service.
NUM-modWarning OK	No problem detected.	None.
NUM-modWarning Warning	There is a problem with: • the real time clock. • the time synchronization.	Set the clock. If the problem persists, contact your ABB representative for service.
ADC-module OK	No problem detected.	None.
ADC-module Fail	The AD conversion module has failed.	Contact your ABB representative for service.
CANP 9 BIM1 Fail	IO module has failed.	Check that the IO module has been configured and connected to the IOP1- block. If the problem persists, contact your ABB representative for service.
RealTimeClock OK	No problem detected.	None.
RealTimeClock Warning	The real time clock has been reset.	Set the clock.
TimeSync OK	No problem detected.	None.
TimeSync Warning	No time synchronization.	Check the synchronization source for problems. If the problem persists, contact your ABB representative for service.

Section 8 Set up the PCM600 communication link per IED

About this chapter

This chapter describes the communication between the IED and PCM600.

8.1 Setting up communication between PCM600 and the IED

The communication between the IED and PCM600 is independent of the communication protocol used within the substation or to the NCC.

The communication media is always Ethernet and the used protocol is TCP/IP.

Each IED has an RJ-45 Ethernet interface connector on the front. The front Ethernet connector shall be used for communication with PCM600.

When an Ethernet-based station protocol is used, PCM600 communication can use the same Ethernet port and IP address.

To connect PCM600 to the IED, two basic variants must be considered.

- Direct point-to-point link between PCM600 and the IED front port. The front port can be seen as a service port.
- Indirect link via a station LAN or from remote via a network.

The physical connection and the IP address must be configured in both cases to enable communication.

The communication procedures are the same in both cases.

1. If needed, set the IP address for the IEDs.
2. Set up the PC or workstation for a direct link (point-to-point), or
3. Connect the PC or workstation to the LAN/WAN network.
4. Configure the IED IP addresses in the PCM600 project for each IED to match the IP addresses of the physical IEDs.

Setting up IP addresses

The IP address and the corresponding mask must be set via the LHMI for each available Ethernet interface in the IED. Each Ethernet interface has a default factory IP address when the IED is delivered. This is not given when an additional Ethernet interface is installed or an interface is replaced.

- The default IP address for the IED front port is 10.1.150.3 and the corresponding subnetwork mask is 255.255.255.0, which can be set via the local HMI path **Main menu/Settings/General settings/Communication/ Ethernet configuration/Front port**.
- The default IP address for the IED rear port is 192.168.1.10 and the corresponding subnetwork mask is 255.255.255.0, which can be set via the local HMI path **Main menu/Settings/General settings/Communication/ Ethernet configuration/Rear OEM - port AB** and **Rear OEM - port CD**.

The front and rear port IP addresses cannot belong to the same subnet or communication will fail. It is recommended to change the IP address of the front port, if the front and rear port are set to the same subnet.

Setting up the PC or workstation for point-to-point access to IEDs front port

A special cable is needed to connect two physical Ethernet interfaces together without a hub, router, bridge or switch in between. The Tx and Rx signal wires must be crossed in the cable to connect Tx with Rx on the other side and vice versa. These cables are known as cross over cables. The maximum length should be about 2 m. The connector type is RJ-45.

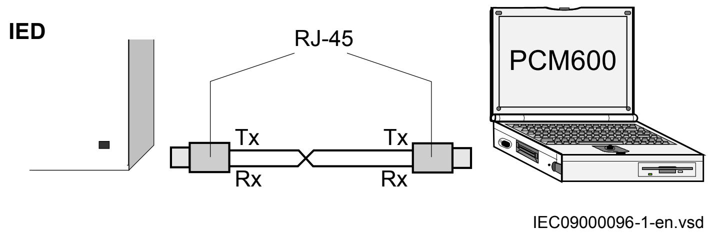
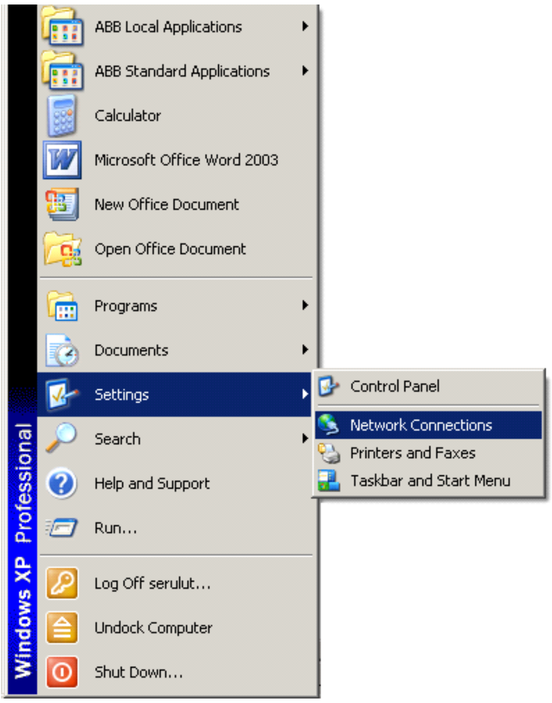


Figure 41: Point-to-point link between IED and PCM600 using a null-modem cable

The following description is an example valid for standard PCs using Microsoft Windows operating system. The example is taken from a Laptop with one Ethernet interface.

Administrator rights are required to change the PC communication setup. Some PCs have the feature to automatically detect that Tx signals from the IED are received on the Tx pin on the PC. Thus, a straight (standard) Ethernet cable can be used.

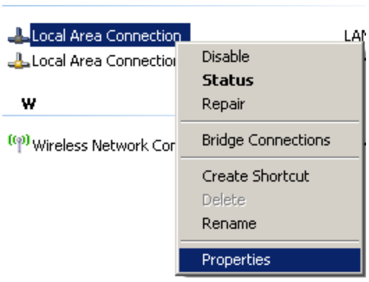
1. Select **Network Connections** in the PC.



IEC09000355-1-en.vsd

Figure 42: Select: Network connections

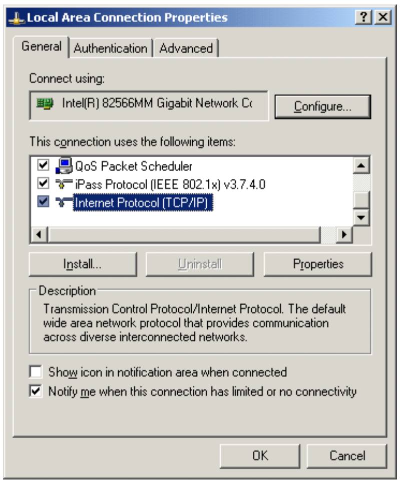
2. Select **Properties** in the status window.



IEC09000356-1-en.vsd

Figure 43: Right-click Local Area Connection and select Properties

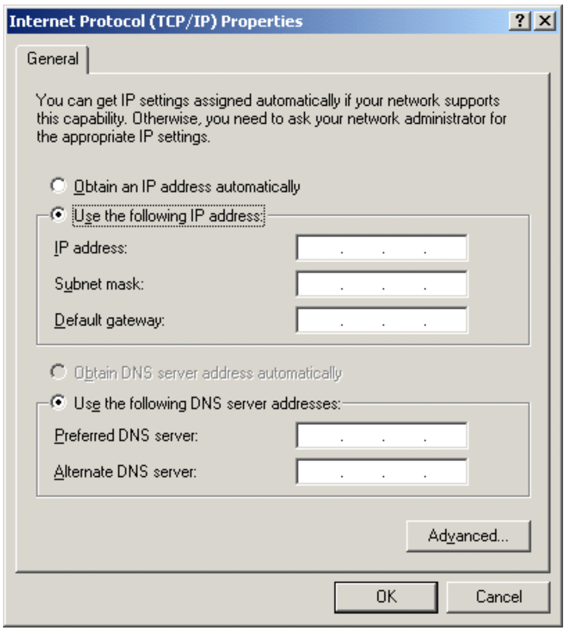
3. Select the TCP/IP protocol from the list of configured components using this connection and click **Properties**.



IEC09000357-1-en.vsd

Figure 44: Select the TCP/IP protocol and open Properties

4. Select **Use the following IP address** and define *IP address* and *Subnet mask* if the front port is used and if the *IP address* is not set to be obtained automatically by the IED, see Figure 45. The IP address must be different from the IP address chosen for the IED.



IEC09000658-1-en.vsd

Figure 45: Select: Use the following IP address

5. Use the *ping* command to verify connectivity with the IED.
6. Close all open windows and start PCM600.

Setting up the PC to access the IED via a network

This task depends on the used LAN/WAN network.

The PC and IED must belong to the same subnetwork for this set-up to work.

Section 9 Configuring the IED and changing settings

About this chapter

This chapter describes how to change IED settings, either through a PC or the local HMI, and download a configuration to the IED in order to make commissioning possible.

The chapter does not contain instructions on how to create a configuration or calculate settings. Please consult the application manual for further information about how to calculate settings.

9.1 Overview

The customer specific values for each setting parameter and a configuration file have to be available before the IED can be set and configured, if the IED is not delivered with a configuration.

Use the configuration tools in PCM600 to verify that the IED has the expected configuration. A new configuration is done with the application configuration tool. The binary outputs can be selected from a signal list where the signals are grouped under their function names. It is also possible to specify a user-defined name for each input and output signal.

Each function included in the IED has several setting parameters, which have to be set in order to make the IED behave as intended. A factory default value is provided for each parameter. A setting file can be prepared using the Parameter Setting tool, which is available in PCM600.

All settings can be

- Entered manually through the local HMI.
- Written from a PC, either locally or remotely using PCM600. Front or rear port communication has to be established before the settings can be written to the IED.

It takes a minimum of three minutes for the IED to save the new settings, during this time the DC supply must not be turned off.

The IED uses a FLASH disk for storing configuration data and process data like counters, object states, Local/Remote switch position etc. Since FLASH memory is used, measures have been taken in software to make sure that the FLASH disk is not worn out by too intensive storing of data. These mechanisms make it necessary to think about a couple of issues in order to not loose configuration data, especially at commissioning time.

After the commissioning is complete, the configuration data is always stored to FLASH, so that is not an issue. But other things, like objects states and the Local/Remote switch position is stored in a slightly different way, where the save of data to FLASH is performed more and more seldom to eliminate the risk of wearing out the FLASH disk. In worst case, the time between saves of this kind of data is around one hour.

This means, that to be absolutely sure that all data have been saved to FLASH, it is necessary to leave the IED with auxiliary power connected after all the commissioning is done (including setting the Local/Remote switch to the desired position) for at least one hour after the last commissioning action performed on the IED.

After that time has elapsed, it will be safe to turn the IED off, no data will be lost.

9.2 Entering settings through the local HMI

Procedure

1. Set each function included in the IED in the local HMI.
2. Browse to the function to be set and enter the appropriate value.
3. Find the parameters for each function in the local HMI

The operator's manual is structured in a similar way to the local HMI and provides a detailed guide to the use of the local HMI including paths in the menu structure and brief explanations of most settings and measurements. See the technical reference manual for a complete list of setting parameters for each function. Some of the included functions may not be used. In this case the user can set the parameter *Operation* = *Off* to disable the function.

9.3 Configuring analog CT inputs

The analog input channels must be configured to get correct measurement results as well as correct protection functionality. Because all protection algorithms in the IED utilize the primary system quantities, it is extremely important to make sure that connected current transformer settings are done properly. These data are calculated by the system engineer and normally set by the commissioner from the local HMI or from PCM600.

The analog inputs on the transformer input module are dimensioned for either 1A or 5A. Each transformer input module has a unique combination of current and voltage inputs. Make sure the input current rating is correct and that it matches the order documentation.

The primary CT data are entered via the HMI menu under **Main menu/Settings/ General Settings/Analog modules/AnalogInputs**

The following parameter shall be set for every current transformer connected to the IED:

Table 9: CT configuration

Parameter description	Parameter name	Range	Default
Rated CT primary current in A	CT Prim Input	from -10000 to +10000	0

This parameter defines the primary rated current of the CT. For two set of CTs with ratio 1000/1 and 1000/5 this parameter is set to the same value of 1000 for both CT inputs. Negative values (that is -1000) can be used in order to reverse the direction of the CT current by software for the differential function. This might be necessary if two sets of CTs have different star point locations in relation to the protected busbar. It is recommended that this parameter is set to zero, for all unused CT inputs.

For main CTs with 2A rated secondary current, it is recommended to connect the secondary wiring to the 1A input and to set the rated primary current to one half times its true value. For example, a CT with a primary secondary current ratio of 1000/2A can be treated as a 500/1A CT.

Take the rated permissive overload values for the current inputs into consideration.

9.4 Writing settings and configuration from a PC

9.4.1 Writing an application configuration to the IED

When writing a configuration to the IED with the application configuration tool, the IED is automatically set in configuration mode. When the IED is set in configuration mode, all functions are blocked. The red LED on the IED flashes, and the green LED is lit while the IED is in the configuration mode.

When the configuration is written and completed, the IED is automatically set into normal mode. For further instructions please refer to the users manuals for PCM600.

Section 10 Establishing connection and verifying the SPA/IEC- communication

About this chapter

This chapter contains instructions on how to establish connection and verify that the SPA/IEC-communication operates as intended, when the IED is connected to a monitoring or control system via the rear SPA/IEC port.

10.1 Entering settings

If the IED is connected to a monitoring or control system via the rear SPA/IEC port, the SPA/IEC port has to be set either for SPA or IEC use.

10.1.1 Entering SPA settings

The SPA/IEC port is located on the rear side of the IED. Two types of interfaces can be used:

- for plastic fibres with connector type HFBR
- for glass fibres with connectors type ST

When using the SPA protocol, the rear SPA/IEC port must be set for SPA use.

Procedure

1. Set the operation of the rear optical SPA/IEC port to “SPA”.
   The operation of the rear SPA port can be found on the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical SPA-IEC-DNP port/Protocol selection**
   When the setting is entered the IED restarts automatically. After the restart the SPA/IEC port operates as a SPA port.
2. Set the slave number and baud rate for the rear SPA port
   The slave number and baud rate can be found on the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical SPA-IEC-DNP port/SPA**
   Set the same slave number and baud rate as set in the SMS system for the IED.

10.1.2 Entering IEC settings

When using the IEC protocol, the rear SPA/IEC port must be set for IEC use.

Two types of interfaces can be used:

- for plastic fibres with connector type HFBR
- for glass fibres with connectors type ST

Procedure

1. Set the operation of the rear SPA/IEC port to “IEC”.
   The operation of the rear SPA/IEC port can be found on the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical SPA-IEC-DNP port/Protocol selection**
   When the setting is entered the IED restarts automatically After the restart the selected IEC port operates as an IEC port.
2. Set the slave number and baud rate for the rear IEC port
   The slave number and baud rate can be found on the local HMI under **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical SPA-IEC-DNP port/IEC60870–5–103**
   Set the same slave number and baud rate as set in the IEC master system for the IED.

10.2 Verifying the communication

To verify that the rear communication with the SMS/SCS system is working, there are some different methods. Choose one of the following.

10.2.1 Verifying SPA communication

Procedure

1. Use a SPA-emulator and send “RF” to the IED. The answer from the IED should be “IED 670 ”.
2. Generate one binary event by activating a function, which is configured to an event block where the used input is set to generate events on SPA. The configuration must be made with the PCM600 software. Verify that the event is presented in the SMS/SCS system.

During the following tests of the different functions in the IED, verify that the events and indications in the SMS/SCS system are as expected.

10.2.2 Verifying IEC communication

To verify that the IEC communication with the IEC master system is working, there are some different methods. Choose one of the following.

Procedure

1. Check that the master system time-out for response from the IED, for example after a setting change, is > 40 seconds.
2. Use a protocol analyzer and record the communication between the IED and the IEC master. Check in the protocol analyzer's log that the IED answers the master messages.
3. Generate one binary event by activating a function that is configured to an event block where the used input is set to generate events on IEC. The configuration must be made with the PCM600 software. Verify that the event is presented in the IEC master system.

During the following tests of the different functions in the IED, verify that the events and indications in the IEC master system are as expected.

10.3 Fibre optic loop

The SPA communication is mainly used for SMS. It can include different numerical IEDs with remote communication possibilities. The fibre optic loop can contain < 20-30 IEDs depending on requirements on response time. Connection to a personal computer (PC) can be made directly (if the PC is located in the substation) or by telephone modem through a telephone network with ITU (CCITT) characteristics.

Table 10: Max distances between IEDs/nodes

glass	< 1000 m according to optical budget
plastic	< 25 m (inside cubicle) according to optical budget

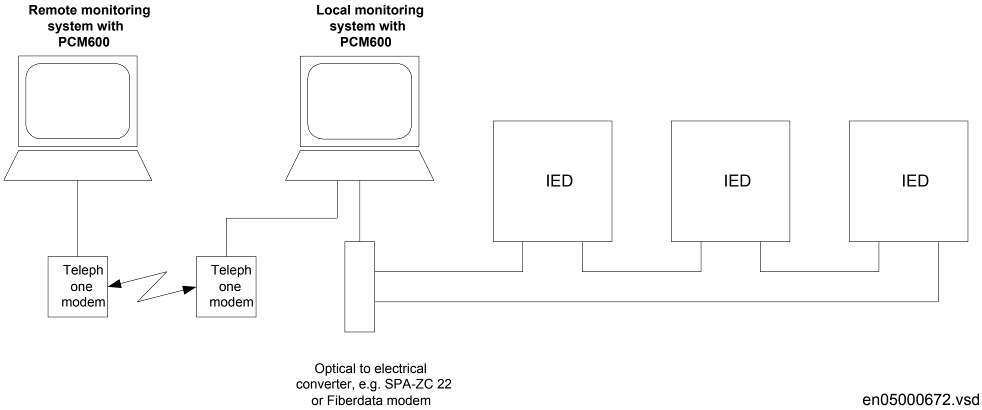


Figure 46: Example of SPA communication structure for a station monitoring system

Where:

1 A separate minute pulse synchronization from station clock to obtain ± 1 ms accuracy for time tagging within the substation might be required.

10.4 Optical budget calculation for serial communication with SPA/IEC

Table 11: Example

	Distance 1 km Glass	Distance 25 m Plastic
Maximum attenuation	- 11 dB	- 7 dB
4 dB/km multi mode: 820 nm - 62.5/125 um	4 dB	-
0.16 dB/m plastic: 620 nm - 1mm	-	4 dB
Margins for installation, aging, and so on	5 dB	1 dB
Losses in connection box, two contacts (0.5 dB/contact)	1 dB	-
Losses in connection box, two contacts (1 dB/contact)	-	2 dB
Margin for 2 repair splices (0.5 dB/splice)	1 dB	-
Maximum total attenuation	11 dB	7 dB

Section 11 Establishing connection and verifying the LON communication

About this chapter

This chapter explains how to set up LON communication and how to verify that LON communication is up and running.

11.1 Communication via the rear ports

11.1.1 LON communication

LON communication is normally used in substation automation systems. Optical fiber is used within the substation as the physical communication link.

The test can only be carried out when the whole communication system is installed. Thus, the test is a system test and is not dealt with here.

The communication protocol Local Optical Network (LON) is available for 670 IED series as an option.

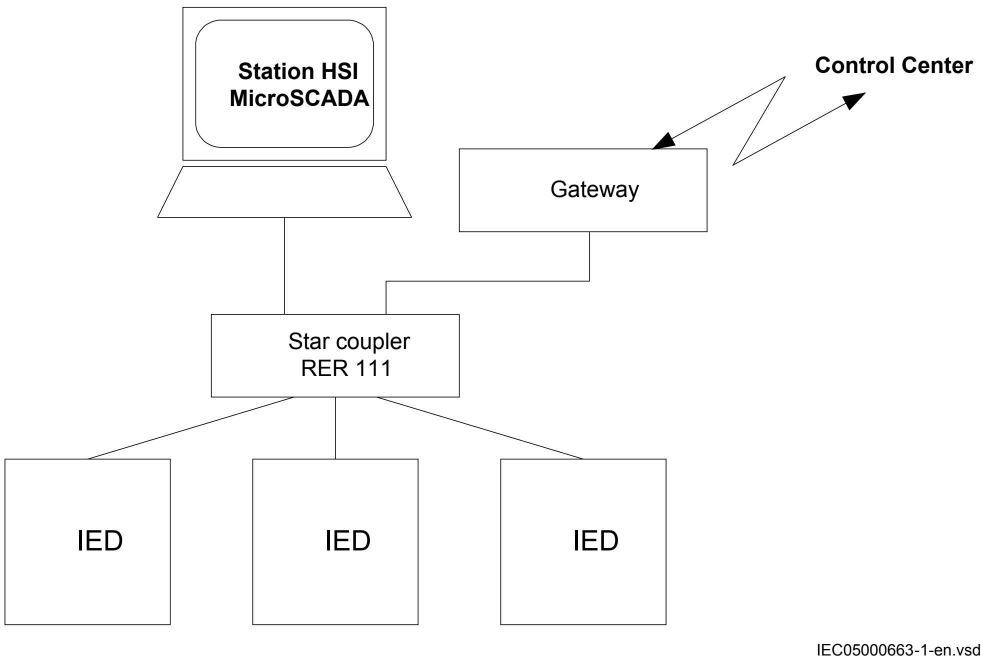


Figure 47: Example of LON communication structure for a substation automation system

An optical network can be used within the substation automation system. This enables communication with the IEDs in the 670 series through the LON bus from the operator's workplace, from the control center and also from other IEDs via bay-to-bay horizontal communication.

The fibre optic LON bus is implemented using either glass core or plastic core fibre optic cables.

Table 12: Specification of the fibre optic connectors

	Glass fibre	Plastic fibre
Cable connector	ST-connector	snap-in connector
Cable diameter	62.5/125 m	1 mm
Max. cable length	1000 m	10 m
Wavelength	820-900 nm	660 nm
Transmitted power	-13 dBm (HFBR-1414)	-13 dBm (HFBR-1521)
Receiver sensitivity	-24 dBm (HFBR-2412)	-20 dBm (HFBR-2521)

11.2.1 The LON Protocol

The LON protocol is specified in the LonTalkProtocol Specification Version 3 from Echelon Corporation. This protocol is designed for communication in control networks and is a peer-to-peer protocol where all the devices connected to the network can communicate with each other directly. For more information of the bay-to-bay communication, refer to the section Multiple command function.

11.2.2 Hardware and software modules

The hardware needed for applying LON communication depends on the application, but one very central unit needed is the LON Star Coupler and optical fibres connecting the star coupler to the IEDs. To interface the IEDs from MicroSCADA, the application library LIB670 is required.

The HV Control 670 software module is included in the LIB520 high-voltage process package, which is a part of the Application Software Library within MicroSCADA applications.

The HV Control 670 software module is used for control functions in IEDs in the 670 series. This module contains the process picture, dialogues and a tool to generate the process database for the control application in MicroSCADA.

Use the LON Network Tool (LNT) to set the LON communication. This is a software tool applied as one node on the LON bus. To communicate via LON, the IEDs need to know

- The node addresses of the other connected IEDs.
- The network variable selectors to be used.

This is organized by LNT.

The node address is transferred to LNT via the local HMI by setting the parameter *ServicePinMsg* = *Yes*. The node address is sent to LNT via the LON bus, or LNT can scan the network for new nodes.

The communication speed of the LON bus is set to the default of 1.25 Mbit/s. This can be changed by LNT.

The setting parameters for the LON communication are set via the local HMI. Refer to the technical reference manual for setting parameters specifications.

The path to LON settings in the local HMI is **Main menu/Settings/General settings/Communication/SLM configuration/Rear optical LON port**

If the LON communication from the IED stops, caused by setting of illegal communication parameters (outside the setting range) or by another disturbance, it is possible to reset the LON port of the IED.

By setting the parameter *LONDefault* = *Yes*, the LON communication is reset in the IED, and the addressing procedure can start from the beginning again.

Path in the local HMI under **Main menu/Settings/General settings/ Communication/SLM configuration/Rear optical LON port**

These parameters can only be set with the LON Network Tool (LNT).

Table 13: Setting parameters for the LON communication

Parameter	Range	Default	Unit	Parameter description
DomainID	0	0	-	Domain identification number
SubnetID*	0 - 255 Step: 1	0	-	Subnet identification number
NodeID*	0 - 127 Step: 1	0	-	Node identification number
*Can be viewed in the local HMI				

Path in the local HMI under **Main menu/Settings/General settings/ Communication/SLM configuration/Rear optical LON port**

These parameters can only be set with the LON Network Tool (LNT).

Table 14: LON node information parameters

Parameter	Range	Default	Unit	Parameter description
NeuronID*	0 - 12	Not loaded	-	Neuron hardware identification number in hexadecimal code
Location	0 - 6	No value	-	Location of the node
*Can be viewed in the local HMI				

Path in the local HMI under **Main menu/Settings/General settings/ Communication/SLM configuration/Rear optical LON port**

Table 15: ADE Non group settings (basic)

Name	Values (Range)	Unit	Step	Default	Description
Operation	Off On	-	-	Off	Operation
TimerClass	Slow Normal Fast	-	-	Slow	Timer class

Path in the local HMI under **Main menu/Settings/General settings/ Communication/SLM configuration/Rear optical LON port**

Table 16: LON commands

Command	Command description
ServicePinMsg	Command with confirmation. Transfers the node address to the LON Network Tool.

11.2 Optical budget calculation for serial communication with LON

Table 17: Example

	Distance 1 km Glass	Distance10 m Plastic
Maximum attenuation	-11 dB	- 7 dB
4 dB/km multi mode: 820 nm - 62.5/125 um	4 dB	-
0.3 dB/m plastic: 620 nm - 1mm	-	3 dB
Margins for installation, aging, and so on	5 dB	2 dB
Losses in connection box, two contacts (0.75 dB/contact)	1.5 dB	-
Losses in connection box, two contacts (1dB/contact)	-	2 dB
Margin for repair splices (0.5 dB/splice)	0.5 dB	-
Maximum total attenuation	11 dB	7 dB

Section 12 Establishing connection and verifying the IEC 61850 communication

About this chapter

This chapter contains instructions on how to establish connection and verify that the IEC 61850 communication operates as intended, when the IED is connected to an Ethernet network via the optical ports of the OEM.

12.1 Overview

The rear OEM ports are used for substation bus (IEC 61850-8-1) communication.

For IEC 61850-8-1 redundant communication, both rear OEM ports are utilized. In this case IEC 61850-9-2LE communication can not be used.

IEC 61850-9-2LE process bus communication is not supported in the IED.

12.2 Setting the station communication

To enable IEC 61850 communication the corresponding OEM ports must be activated. The rear OEM port AB and CD is used for IEC 61850-8-1 communication. For IEC 61850-8-1 redundant communication, both OEM port AB and CD are used exclusively.

To enable IEC 61850 station communication:

1. Enable IEC 61850-8-1 (substation bus) communication for port AB.
   1.1. Set values for the rear port AB.
   Navigate to: **Main menu/Settings/general settings/Communication/ Ethernet configuration/Rear OEM - port AB**
   Set values for *Mode*, *IPAddress* and *IPMask*. *Mode* must be set to *Normal*.
   Check that the correct IP address is assigned to the port.
   1.2. Enable IEC 61850-8-1 communication.
   Navigate to: **Main menu/Settings/General settings/Communication/ Station communication/IEC 61850-8-1**

Set *Operation* to *On* and *GOOSE* to the port used (for example *OEM311_AB*).

2. Enable redundant IEC 61850-8-1 communication for port AB and CD
    2.1. Enable redundant communication.
    Navigate to: **Main menu/Settings/general settings/Communication/ Ethernet configuration/Rear OEM - redundant PRP**
    Set values for *Operation*, *IPAddress* and *IPMask*. *Operation* must be set to *On*.
    The IED will restart after confirmation. Menu items **Rear OEM - port AB** and **Rear OEM - port CD** are hidden in local HMI after restart but are visible in PST where the values for parameter *Mode* is set to *Duo*.

12.3 Verifying the communication

Connect your PC to the substation network and ping the connected IED and the Substation Master PC, to verify that the communication is working (up to the transport layer).

The best way to verify the communication up to the application layer is to use protocol analyzer ITT600 connected to the substation bus, and monitor the communication.

Verifying redundant IEC 61850-8-1 communication

Ensure that the IED receives IEC 61850-8-1 data on both port AB and CD. Browse in the local HMI to **Main menu/Diagnostics/Communication/Redundant PRP** and check that both signals LAN-A-STATUS and LAN-B-STATUS are shown as *Ok*. Remove the optical connection to one of the ports AB or CD. Verify that either signal LAN-A-STATUS or LAN-B-STATUS (depending on which connection that was removed) are shown as *Error* and the that other signal is shown as *Ok*. Be sure to re-connect the removed connection after completed verification.

Section 13 Verifying settings by secondary injection

About this chapter

This chapter describes how to verify that protection functions operate correctly and according to their settings. It is preferable that only the tested function is in operation.

13.1 Overview

IED test requirements:

- Calculated settings
- Application configuration diagram
- Signal matrix (SMT) configuration
- Terminal diagram
- Technical reference manual
- Three-phase test equipment
- PCM600

The setting and configuration of the IED must be completed before the testing can start.

The terminal diagram, available in the technical reference manual, is a general diagram of the IED.

Note that the same diagram is not always applicable to each specific delivery (especially for the configuration of all the binary inputs and outputs).

Therefore, before testing, check that the available terminal diagram corresponds to the IED.

The technical reference manual contains application and functionality summaries, function blocks, logic diagrams, input and output signals, setting parameters and technical data sorted per function.

The test equipment should be able to provide a three-phase supply of voltages and currents. The magnitude of voltage and current as well as the phase angle between voltage and current must be variable. The voltages and currents from the test equipment must be obtained from the same source and they must have minimal harmonic content. If the test equipment cannot indicate the phase angle, a separate phase-angle measuring instrument is necessary.

Prepare the IED for test before testing a particular function. Consider the logic diagram of the tested protection function when performing the test. All included functions in the IED are tested according to the corresponding test instructions in this chapter. The functions can be tested in any order according to user preferences and the test instructions are therefore presented in alphabetical order. Only the functions that are used (*Operation* is set to *On*) should be tested.

The response from a test can be viewed in different ways:

- Binary outputs signals
- Service values on the local HMI (logical signals or phasors)
- A PC with PCM600 application configuration software in debug mode

All setting groups that are used should be tested.

This IED is designed for a maximum continuous current of four times the rated current.

Please observe the measuring accuracy of the IED, the test equipment and the angular accuracy for both of them.

Please consider the configured logic from the function block to the output contacts when measuring the operate time.

After intense testing, it is important that the IED is not immediately restarted, which might cause a faulty trip due to flash memory restrictions. Some time must pass before the IED is restarted. For more information about the flash memory, refer to section “Configuring the IED and changing settings”.

13.2 Preparing for test

13.2.1 Preparing the IED to verify settings

If a test switch is included, start preparation by making the necessary connections to the test switch. This means connecting the test equipment according to a specific and designated IED terminal diagram.

Put the IED into the test mode to facilitate the test of individual functions and prevent unwanted operation caused by other functions. The busbar differential protection is not included in the test mode and is not prevented to operate during the test operations. The test switch should then be connected to the IED.

Verify that analog input signals from the analog input module are measured and recorded correctly by injecting currents and voltages required by the specific IED.

To make testing even more effective, use PCM600. PCM600 includes the Signal monitoring tool, which is useful in reading the individual currents and voltages, their amplitudes and phase angles. In addition, PCM600 contains the Disturbance handling tool. The content of reports generated by the Disturbance handling tool can be configured which makes the work more efficient. For example, the tool may be configured to only show time tagged events and to exclude analog information and so on.

Check the disturbance report settings to ensure that the indications are correct.

For test functions and test and signal parameter names, see the technical reference manual. The correct initiation of the disturbance recorder is made on start and/or release or trip from a function. Also check that the wanted recordings of analog (real and calculated) and binary signals are achieved.

Parameters can be entered into different setting groups. Make sure to test functions for the same parameter setting group. If needed, repeat the tests for all different setting groups used. The difference between testing the first parameter setting group and the remaining is that there is no need for testing the connections.

During testing, observe that the right testing method, that corresponds to the actual parameters set in the activated parameter setting group, is used.

Set and configure the function(s) before testing. Most functions are highly flexible and permit a choice of functional and tripping modes. The various modes are checked at the factory as part of the design verification. In certain cases, only modes with a high probability of coming into operation need to be checked when commissioned to verify the configuration and settings.

13.2.2 Preparing the connection to the test equipment

The IED can be equipped with a test switch of type RTXP8, RTXP18 or RTXP24. The test switch and its associated test plug handle (RTXH8, RTXH18 or RTXH24) are a part of the COMBITEST system, which provides secure and convenient testing of the IED.

When using the COMBITEST, preparations for testing are automatically carried out in the proper sequence, that is, for example, blocking of tripping circuits, short circuiting of CT’s, opening of voltage circuits, making IED terminals available for secondary injection. Terminals 1 and 8, 1 and 18 as well as 1 and 12 of the test switches RTXP8, RTXP18 and RTXP24 respectively are not disconnected as they supply DC power to the protection IED.

The RTXH test-plug handle leads may be connected to any type of test equipment or instrument. When a number of protection IEDs of the same type are tested, the test-plug handle only needs to be moved from the test switch of one protection IED to the test switch of the other, without altering the previous connections.

Use COMBITEST test system to prevent unwanted tripping when the handle is withdrawn, since latches on the handle secure it in the half withdrawn position. In this position, all voltages and currents are restored and any re-energizing transients are given a chance to decay before the trip circuits are restored. When the latches are released, the handle can be completely withdrawn from the test switch, restoring the trip circuits to the protection IED.

If a test switch is not used, perform measurement according to the provided circuit diagrams.

Never disconnect the secondary connection of a current transformer circuit without first short-circuiting the transformer's secondary winding. Operating a current transformer with the secondary winding open will cause a massive potential build up that may damage the transformer and cause personal injury.

13.2.3 Activating the test mode

Put the IED into the test mode before testing. The test mode blocks all protection functions and some of the control functions in the IED, and the individual functions to be tested can be unblocked to prevent unwanted operation caused by other functions. In this way, it is possible to test slower back-up measuring functions without the interference from faster measuring functions. The busbar differential protection is not included in the test mode and is not prevented to operate during the test operations. The test switch should then be connected to the IED.Test mode is indicated when the yellow StartLED flashes.

1. Browse to the **TestMode** menu and press *E*.
   The **TestMode** menu is found on the local HMI under **Main menu/Test/IED test mode/TestMode**
2. Use the up and down arrows to choose *On* and press *E*.
3. Press the left arrow to exit the menu.
   The dialog box *Save changes* appears.
4. Choose *Yes*, press *E* and exit the menu.
   The yellow startLED above the LCD will start flashing when the IED is in test mode.

13.2.4 Connecting the test equipment to the IED

Connect the test equipment according to the IED specific connection diagram and the needed input and output signals for the function under test. An example of a connection is shown in figure 48.

Connect the current and voltage terminals. Pay attention to the current polarity. Make sure that the connection of input and output current terminals and the connection of the residual current conductor is correct. Check that the input and output logical signals in the logic diagram for the function under test are connected to the corresponding binary inputs and outputs of the IED under test.

To ensure correct results, make sure that the IED as well as the test equipment are properly earthed before testing.

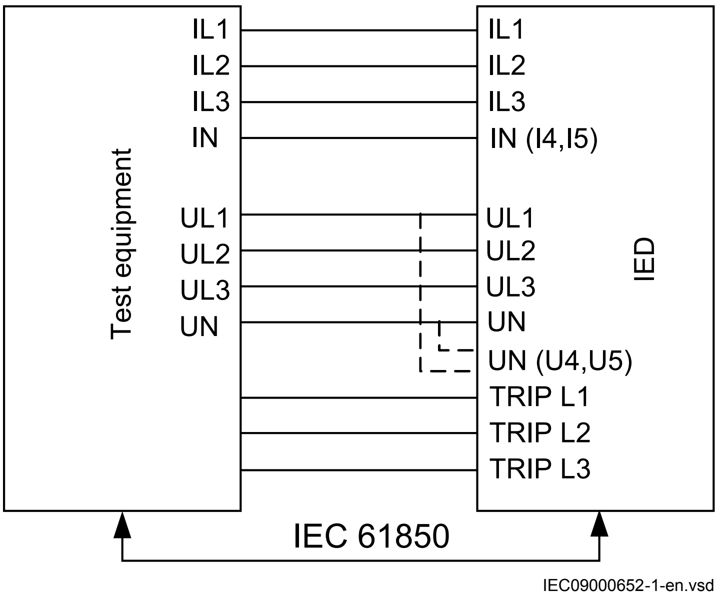


Figure 48: Connection example of the test equipment to the IED when test equipment is connected to the transformer input module

13.2.5 Verifying analog primary and secondary measurement

Verify that the connections are correct and that measuring and scaling is done correctly. This is done by injecting current and voltage to the IED.

Apply input signals as needed according to the actual hardware and the application configuration.

1. Inject a symmetrical three-phase voltage and current at rated value.
2. Compare the injected value with the measured values.
   The voltage and current phasor menu in the local HMI is located under **Main menu/Measurements/Analog primary values** and **Main menu/Measurements/Analog secondary values**.
3. Compare the frequency reading with the set frequency and the direction of the power.
   The frequency and active power are located under **Main menu/Measurements/Monitoring/ServiceValues(MMXN)/CVMMXN:x**. Then navigate to the bottom of the list to find the frequency.
4. Inject an unsymmetrical three-phase voltage and current, to verify that phases are correctly connected.

If some setting deviates, check the analog input settings under

Main menu/Settings/General settings/Analog modules

13.2.6 Releasing the function to be tested

Release or unblock the function to be tested. This is done to ensure that only the function or the chain of functions to be tested are in operation and that other functions are prevented from operating. Release the tested function(s) by setting the corresponding *Blocked* parameter under Function test modes to *No* in the local HMI.

When testing a function in this blocking feature, remember that not only the actual function must be activated, but the whole sequence of interconnected functions (from measuring inputs to binary output contacts), including logic must be activated. Before starting a new test mode session, scroll through every function to ensure that only the function to be tested (and the interconnected ones) have the parameters *Blocked* and eventually *EvDisable* set to *No* and *Yes* respectively. Remember that a function is also blocked if the BLOCK input signal on the corresponding function block is active, which depends on the configuration. Ensure that the logical status of the BLOCK input signal is equal to 0 for the function to be tested. Event function blocks can also be individually blocked to ensure that no events are reported to a remote station during the test. This is done by setting the parameter *EvDisable* to *Yes*.

Any function is blocked if the corresponding setting in the local HMI under **Main menu/Test/Function test modes** menu remains *On*, that is, the parameter *Blocked* is set to *Yes* and the parameter *TestMode* under **Main menu/Test/IED test mode** remains active. All functions that were blocked or released in a previous test mode session, that is, the parameter *Test mode* is set to *On*, are reset when a new test mode session is started.

Procedure

1. Click the **Function test modes** menu.
   The Function test modes menu is located in the local HMI under **Main menu/Test/Function test modes**.
2. Browse to the function instance that needs to be released.
3. Set parameter *Blocked* for the selected function to *No*.

13.2.7 Disturbance report

13.2.7.1 Introduction

The following sub-functions are included in the disturbance report function:

- Disturbance recorder
- Event list
- Event recorder
- Trip value recorder
- Indications

If the disturbance report is set on, then its sub-functions are also set up and so it is not possible to only switch these sub-functions off. The disturbance report function is switched off (parameter *Operation* = *Off*) in PCM600 or the local HMI under **Main menu/Settings/General settings/Monitoring/DisturanceReport/DisturbanceReport(RDRE)**.

13.2.7.2 Disturbance report settings

When the IED is in test mode, the disturbance report can be made active or inactive. If the disturbance recorder is turned on during test mode, recordings will be made. When test mode is switched off all recordings made during the test session are cleared.

Setting *OpModeTest* for the control of the disturbance recorder during test mode are located on the local HMI under **Main menu/Settings/General settings/Monitoring/DisturbanceReport/DisturbanceReport(RDRE)**.

13.2.7.3 Disturbance recorder (DR)

A *Manual Trig* can be started at any time. This results in a recording of the actual values from all recorded channels.

The *Manual Trig* can be initiated in two ways:

1. From the local HMI under **Main menu/Disturbance records**.
   1.1. Enter on the row at the bottom of the HMI called **Manual trig**.

The newly performed manual trig will result in a new row.

1.2. Navigate to **General information** or to **Trip values** to obtain more detailed information.

2. Open the Disturbance handling tool for the IED in the plant structure in PCM600.
    2.1. Right-click and select *Execute manual Trig* in the window *Available recordings in IED*.
    2.2. Read the required recordings from the IED.
    2.3. Refresh the window *Recordings* and select a recording.
    2.4. Right-click and select *Create Report* or *Open With* to export the recordings to any disturbance analyzing tool that can handle Comtrade formatted files.

Evaluation of the results from the disturbance recording function requires access to a PC either permanently connected to the IED or temporarily connected to the Ethernet port (RJ-45) on the front. The PCM600 software package must be installed in the PC.

Disturbance upload can be performed by the use of PCM600 or by any third party tool with IEC 61850 protocol. Reports can automatically be generated from PCM600. Disturbance files can be analyzed by any tool reading Comtrade formatted disturbance files.

It could be useful to have a printer for hard copies. The correct start criteria and behavior of the disturbance recording function can be checked when IED protective functions are tested.

When the IED is brought into normal service it is recommended to delete all recordings, made during commissioning to avoid confusion in future fault analysis.

All recordings in the IED can be deleted in two ways:

1. in the local HMI under **Main menu/Reset/Reset disturbances**, or
2. in the Disturbance handling tool in PCM600 by selecting *Delete all recordings in the IED...* in the window *Available Recordings in IED*.

13.2.7.4 Event recorder (ER) and Event list (EL)

The result from the event recorder and event list can be viewed on the local HMI or, after upload, in PCM600 as follows:

1. on the local HMI under **Main menu/Events**, or in more details via
2. the *Event Viewer* in PCM600.
    The internal FIFO register of all events will appear when the event viewer is launched.

When the IED is brought into normal service it is recommended to delete all events resulting from commissioning tests to avoid confusion in future fault analysis. All event in the IED can be cleared in the local HMI under **Main Menu//Reset/Reset internal event list** or **Main menu/Reset/Reset process event list**. It is not possible to clear the event lists from PCM600.

When testing binary inputs, the event list (EL) might be used instead. No uploading or analyzing of registrations is then needed since the event list keeps running, independent of start of disturbance registration.

13.2.8 Identifying the function to test in the technical reference manual

Use the technical reference manual (to identify function blocks, logic diagrams, input and output signals, setting parameters and technical data.

13.2.9 Exit test mode

The following procedure is used to return to normal operation.

1. Navigate to the test mode folder.
2. Change the *On* setting to *Off*. Press the 'E' key and the left arrow key.
3. Answer *YES*, press the 'E' key and exit the menus.

13.3 Basic IED functions

13.3.1 Parameter setting group handling SETGRPS

Prepare the IED for verification of settings as outlined in section "Overview" and section "Preparing for test" in this chapter.

13.3.1.1 Verifying the settings

1. Check the configuration of binary inputs that control the selection of the active setting group.
2. Browse to the **ActiveGroup** menu to achieve information about the active setting group.
   The **ActiveGroup** menu is located on the local HMI under**Main menu/Test/ Function status/Setting groups/ActiveGroup**
3. Connect the appropriate dc voltage to the corresponding binary input of the IED and observe the information presented on the local HMI.
   The displayed information must always correspond to the activated input.
4. Check that the corresponding output indicates the active group.

Operating procedures for the PC aided methods of changing the active setting groups are described in the corresponding PCM600 documents and instructions for the operators within the SCS are included in the SCS documentation.

13.3.1.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.4 Differential protection

13.4.1 Busbar differential protection

13.4.1.1 General

Secondary injection testing is a normal part of the commissioning. The operating value of all protection functions, the output to the proper trip and alarm contacts and the operation of binary input signals is checked and documented for future reference.

The connection of the test set to REB670 is greatly simplified if the RTXP 24 test switch is included.When the test handle RTXH 24 is inserted in the test switch, preparations for testing are automatically carried out in the proper sequence, that is, blocking of the tripping circuits, short-circuiting of the current circuits on the transformer side, opening of current transformer circuits and making IED terminals accessible from the terminals on the test plug handle.

If the REB670 is not provided with a test switch, the IED has to be tested in the proper way from external circuit terminals. Make sure that the instrument transformers are isolated from the circuits connected to the test set. The secondary phase terminals of the current transformers must be short-circuited to neutral before the circuit is opened if any current can flow on the primary side. The testing requires a good understanding of the protection functionality of the REB670. A testing instruction is given for each type of protection function.

Note that CT inputs for the REB670 are designed for a maximum continuous current of four times rated value.

13.4.1.2 Operation of the differential protection from CTx input

Prepare the IED for verification of settings as outlined in section "Overview" and section "Preparing for test" in this chapter.

The typical connection between the three-phase current test set and REB670 IEDs is shown in figure 49.

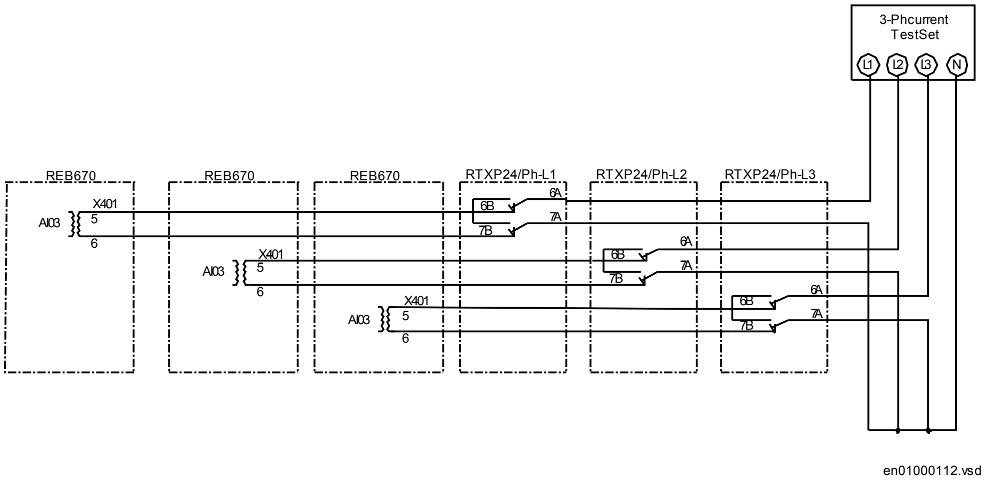


Figure 49: Typical test connection for CT3 current input when COMBITEST RTXP 24 test switch is delivered together with one-phase REB670 IED

Testing will be explained from one general current input CTx (that is x=1, 2,..., Nmax; where Nmax is equal to the maximum number of used CT inputs). Follow the following test instructions for all used current inputs in the REB670 IED.

Procedure

1. Connect the test set for injection of three-phase current (or if not available one-phase current) to the current terminals of CTx input of REB670 terminal.
2. Check and write down the value for the configuration parameter *CT Prim Input x*, which should correspond to the rated primary CT current of the main CT connected to CTx current input.
3. Check the value for the configuration parameter *ZoneSel/CTx*. If this value is *Fixed to ZA*, *Fixed to ZB* or *Fixed to ZA & - ZB*, proceed with next point. (If this value is *CtrlIncludes*, energize the binary input *CTRLZA* to include the current from this current input into ZA measurement.)
4. If this value is *CtrlExcludes*, de-energize the binary input *CTRLZA* to include the current from this current input into ZA measurement.
5. Make sure that the check zone is properly set and enabled, when used.
6. Increase the current in phase L1 until the correct differential function (that is, either ZA or ZB) operates and note the incoming and differential currents at the moment of operation.
7. Check that trip and alarm contacts operate according to the scheme wiring.

8. Check that trip information is stored in the event list (if connected).
9. Switch off the current.
10. Check that trip reset information is stored in the event list (if connected).
11. Check in the same way the function by injecting current in phases L2 and L3.
12. Inject a symmetrical three-phase current and note the operate value (possible with three-phase test set only).
13. Connect the timer and set the current to five times the set value for *DiffOperLevel* parameter.
14. Switch on the current and note the operate time.
15. If the value for the configuration parameter *ZoneSel/CTx* is *CtrlIncludes*, de-energize the binary input *CTRLZA* and now energize the binary input *CTRLZB* to include the current from this current input into ZB measurement.
16. If the value for the configuration parameter *ZoneSel/CTx* is *CtrlExcludes*, energize the binary input *CTRLZA* and now de-energize binary input *CTRLZB* to include the current from this current input into ZB measurement.
17. Repeat the steps from 4 to 12 for zone ZB
18. If the value for the configuration parameter *ZoneSel/CTx* is *CtrlIncludes*, energize now both binary inputs *CTRLZA* and *CTRLZB* to include the current from this current input into both measuring zone simultaneously.
19. If the value for the configuration parameter *ZoneSel/CTx* is *CtrlExcludes*, de-energize now both the binary inputs *CTRLZA* and *CTRLZB* to include the current from this current input into both measuring zone simultaneously.
20. Make sure that the dedicated binary output *ACTIVE* from the *Zone Interconnection* block has the logical value *One*.
21. Repeat the steps from 4 to 12.

Note that now both zones shall operate during these tests.

22. Check in the same way that the differential function properly operates for all used and connected CT inputs.

13.4.1.3 Stability of the busbar differential protection

For stability test one current input shall always be used as a reference input. The reference current input then shall be tested for stability against all other current inputs in the IED. It is recommended to use current input CT1 as the reference current input. The typical connection between the three-phase current test set and the IED for this type of tests is shown in figure 50.

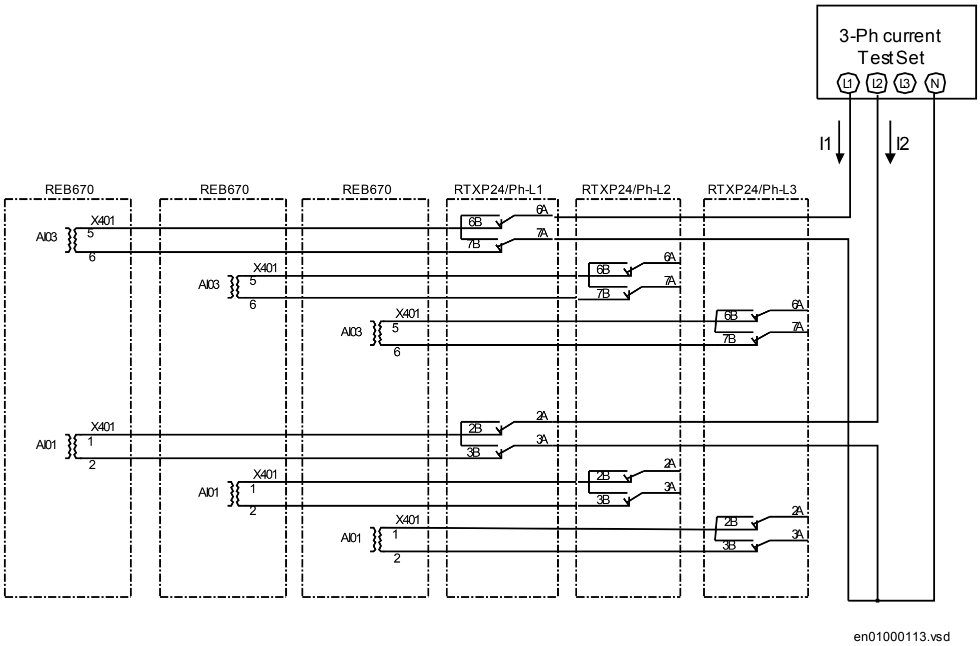


Figure 50: Typical test connection for CT3 and CT1 current input phase L1 when COMBITEST RTXP 24 test switch is delivered together with the one-phase IED

The connections are shown for phase L1 only. Similar connection shall be used for testing phase L2 and L3 also.

Testing will be explained for one general current input CTx (that is x=2, 3,...,Nmax; where Nmax is equal to the maximum number of used CT inputs).

Follow the following test instructions to perform this type of test.

Procedure

1. Connect the currents I1 and I2 from the three-phase test set to the current terminals of CT1 and CTx inputs of the IED as shown in figure 50.
2. Make sure that current measurement from CT1 and CTx inputs are included into the same differential zone (see previous test instruction for more details).
3. Set the current I2 (that is, current connected to reference current input CT1) to the nominal value of 1A (or to 5A if CT1 is connected to a main CT with 5A secondary rating) at 0°.
4. Set the current I1 (that is, connected to current input CTx) to the value calculated by the following formula:

Figure 51: *I1 = IXr · (CT Prim Input1/CT Prim Inputx)*

where:

IXr	is rated secondary current of the current input CTx (that is, normally 1A or 5A)
CT Prim Input1	is the rated primary CT current of the main CT connected to CT1 current input
CT Prim Inputx	is the rated primary CT current of the main CT connected to CTx current input

5. Set the phase angle of current I1 to 180° if both current inputs (that is, CT1 and CTx) has the same sign for entered configuration parameters *CT Prim Input1* and *CT Prim Input3* (that is, both positive or both negative). Otherwise set the phase angle of current I1 to 0°.
6. Inject these two currents into the IED. Differential function shall be stable. Write down the service values for incoming and differential currents for phase L1. Differential current should be very small.
7. Switch off the currents.
8. Repeat the same test procedure for phases L2 and L3.

13.4.1.4 Operation of fast open CT detection algorithm

For open CT test two current inputs shall always be used. The typical connection between the three-phase current test set and the IED for this type of tests is shown in figure 50.

The connections are shown for phase L1 only. Similar connection shall be used for testing phase L2 and L3 also.

Follow the following test instructions to perform this type of test.

Procedure

1. Connect the currents I1 and I2 from the three-phase test set test set to the current terminals of CT1 and CT3 inputs of the IED as shown in figure 50.
2. Make sure that current measurement from CT1 and CT3 inputs are included into the same differential zone (see previous test instructions for more details).
3. Set the current I2 (that is, current connected to input CT1) to the nominal value of 1A (or to 5A if CT1 is connected to a main CT with 5A secondary rating) at zero degree.
4. Set the current I1 (that is, connected to current input CT3) to the value calculated by the following formula:

Figure 52: *I1= I3r · (CT Prim Input1/CT Prim Input3)*

where:

I3r	is rated secondary current of the current input CT3 (that is, normally 1A or 5A)
CT Prim Input1	is the rated primary CT current of the main CT connected to CT1 current input
CT Prim Input3	is the rated primary CT current of the main CT connected to CT3 current input

5. Check that the value of the product *I1 · CT Prim Input3* is bigger than the value of the product *1.1 · Open CT Level* (this is just a check to see that

enough current will be disconnected later during testing in order for open CT algorithm to operate).

6. Set the phase angle of current I1 to 180 degrees if both current inputs (that is, CT1 and CT3) have the same sign for entered configuration parameters *CT Prim Input1* and *CT Prim Input3* (that is, both positive or both negative). Otherwise set the phase angle of current I1 to 0°.
7. Inject these two currents into the IED for approximately 5s. Differential function shall be stable. Write down the service values for incoming and differential currents for phase L1. Differential current should be very small.
8. Then switch off the current I2 only (that is, set its magnitude back to 0A).
9. Open CT condition shall be detected by the IED. The differential function will be blocked.
10. Check that open CT alarm contacts operate accordingly to the scheme wiring.
11. Check that open CT information is stored in the event list (if connected).
12. Switch off the currents.
13. Reset the open CT blocking in the reset menu of the local HMI.
14. Check that open CT reset information is stored in the event list (if connected).
15. Repeat the same test procedure for phases L2 and L3.

13.4.1.5 Operation of slow open CT detection algorithm

For open CT test two current inputs shall be always used. The typical connection between the three-phase current test set and the IED for this type of tests is shown in figure 50.

The connections are shown for phase L1 only. Similar connection shall be used for testing phase L2 and L3 also.

Follow the following test instructions to perform this type of test.

Procedure

1. Connect the currents I1 and I2 from the three-phase test set to the current terminals of CT1 and CT3 inputs of the IED as shown in figure 50.
2. Make sure that current measurement from CT1 and CT3 inputs are included into the same differential zone (see previous test instructions for more details).
3. Set the current I2 (that is, current connected to current input CT1) to the nominal value of 1A (or to 5A if CT1 is connected to a main CT with 5A secondary rating) at zero degree.
4. Set the current I1 (that is, connected to current input CT3) to the value calculated by the following formula:

Figure 53: $I1 = 0.85 \cdot I3r \cdot (CT\ Prim\ Input1/CT\ Prim\ Input3)$

where:

I3r	is rated secondary current of the current input CT3 (that is, normally 1A or 5A)
CT Prim Input1	is the rated primary CT current of the main CT connected to CT1 current input
CT Prim Input3	is the rated primary CT current of the main CT connected to CT3 current input

5. Check that the value of the product $0.15 \cdot I1 \cdot CT\ Prim\ Input1$ is bigger than the pre-set value of *OCTOperLev*. If it is not, increase current into CT1 input until this condition is satisfied and change current into input CT3 accordingly.
6. Set the phase angle of current I1 to 180° if both current inputs (that is, CT1 and CT3) have the same sign for entered configuration parameters *CT Prim Input1* and *CT Prim Input3* (that is, both positive or both negative). Otherwise set the phase angle of current I1 to 0°.
7. Inject these two currents into the IED. Differential function shall be stable. Write down the service values for incoming and differential currents for phase L1. Differential current should be approximately 15% of the incoming current.
8. After pre-set time determined by parameter *tSlow OCT*, open CT condition shall be detected by the IED. The differential function will be blocked.
9. Check that open CT alarm contacts operate accordingly to the scheme wiring.
10. Check that open CT information is stored in the event list (if connected).
11. Switch off the currents.
12. Reset the open CT blocking in the reset menu of the local HMI.
13. Check that open CT reset information is stored in the event list.
14. Repeat the same test procedure for phases L2 and L3.

13.4.1.6 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.4.1.7 Check of trip circuits and circuit breakers

The trip circuits are tested as part of the secondary/primary injection test.

Check that the circuit breakers associated with the IED protection scheme operate when the tripping IEDs are activated. The trip IEDs are conveniently activated by secondary injection to activate a suitable protection function.

13.5 Current protection

13.5.1 Four step phase overcurrent protection OC4PTOC

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

When inverse time overcurrent characteristic is selected, the operate time of the stage will be the sum of the inverse time delay and the set definite time delay. Thus, if only the inverse time delay is required, it is of utmost importance to set the definite time delay for that stage to zero.

13.5.1.1 Verifying the settings

1. Connect the test set for appropriate current injection to the appropriate IED phases.
   If there is any configuration logic that is used to enable or block any of the four available overcurrent steps, make sure that the step under test is enabled, for example end fault protection.
   If *1 out of 3* currents for operation is chosen: Connect the injection current to phases L1 and neutral.
   If *2 out of 3* currents for operation is chosen: Connect the injection current into phase L1 and out from phase L2.
   If *3 out of 3* currents for operation is chosen: Connect the symmetrical three-phase injection current into phases L1, L2 and L3.
2. Connect the test set for the appropriate three-phase voltage injection to the IED phases L1, L2 and L3. The protection shall be fed with a symmetrical three-phase voltage.
3. Set the injected polarizing voltage slightly larger than the set minimum polarizing voltage (default is 5% of *UBase*) and set the injection current to lag the appropriate voltage by an angle of about 80° if forward directional function is selected.
   If *1 out of 3* currents for operation is chosen: The voltage angle of phase L1 is the reference.
   If *2 out of 3* currents for operation is chosen: The voltage angle of phase L1 – the voltage angle of L2 is the reference.
   If *3 out of 3* currents for operation is chosen: The voltage angle of phase L1 is the reference.
   If reverse directional function is selected, set the injection current to lag the polarizing voltage by an angle equal to 260° (equal to 80° + 180°).
4. Increase the injected current and note the operated value of the tested step of the function.
5. Decrease the current slowly and note the reset value.
6. If the test has been performed by injection of current in phase L1, repeat the test when injecting current into phases L2 and L3 with polarizing voltage connected to phases L2 respectively L3 (*1 out of 3* currents for operation).
7. If the test has been performed by injection of current in phases L1 – L2, repeat the test when injecting current into phases L2 – L3 and L3 – L1 with appropriate phase angle of injected currents.
8. Block higher set stages when testing lower set stages according to below.
9. Connect a trip output contact to a timer.
10. Set the injected current to 200% of the operate level of the tested stage, switch on the current and check the time delay.

For inverse time curves, check the operate time at a current equal to 110% of the operate current for *txMin*.

11. Check that all trip and start contacts operate according to the configuration (signal matrixes)
12. Reverse the direction of the injected current and check that the protection does not operate.
13. If *2 out of 3* or *3 out of 3* currents for operation is chosen: Check that the function will not operate with current in one phase only.
14. Repeat the above described tests for the higher set stages.
15. Finally check that start and trip information is stored in the event menu.

Check of the non-directional phase overcurrent function. This is done in principle as instructed above, without applying any polarizing voltage.

13.5.1.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.2 Four step single phase overcurrent protection PH4SPTOC

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

Directional phase overcurrent current function

13.5.2.1 Verifying the settings

Procedure

1. Connect the test set for appropriate current injection to the appropriate IED terminals.
   If there is any configuration logic, which is used to enable or block any of 4 available overcurrent steps, make sure that step under test is enabled (that is, end fault protection).
2. Increase the injected current and note the operated value of the studied step of the function.
3. Decrease the current slowly and note the reset value.
4. Block higher set stages when testing lower set stages according to below.
5. Connect a trip output contact to a timer.
6. Set the injected current to 200% of the operate level of the tested stage, switch on the current and check the time delay.
   For inverse time curves, check the operate time at a current equal to 110% of the operate current for *tmin*.

7. Check that all trip and start contacts operate according to the configuration (signal matrixes)
8. Repeat the above described tests for the higher set stages.
9. Finally check that start and trip information is stored in the event menu.

13.5.2.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.3 Thermal overload protection, two time constants TRPTTR

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

13.5.3.1 Checking operate and reset values

1. Connect symmetrical three-phase currents to the appropriate current terminals of the IED.
2. Set the Time constant 1 (*Tau1*) and Time Constant 2 (*Tau2*) temporarily to 1 minute.
3. Set the three-phase injection currents slightly lower than the set operate value of stage *IBase1*, increase the current in phase L1 until stage *IBase1* operates and note the operate value.

   Observe the maximum permitted overloading of the current circuits in the IED.

4. Decrease the current slowly and note the reset value.
   Check in the same way as the operate and reset values of *IBase1* for phases L2 and L3.
5. Activate the digital input for cooling input signal to switch over to base current *IBase2*.
6. Check for all three phases the operate and reset values for *IBase2* in the same way as described above for stage *IBase1*
7. Deactivate the digital input signal for stage *IBase2*.
8. Set the time constant for *IBase1* in accordance with the setting plan.
9. Set the injection current for phase L1 to 1.50 · *IBase1*.
10. Connect a trip output contact to the timer and monitor the output of contacts ALARM1 and ALARM2 to digital inputs in test equipment.
    Read the heat content in the thermal protection from the local HMI and wait until the content is zero.

11. Switch on the injection current and check that ALARM1 and ALARM2 contacts operate at the set percentage level and that the operate time for tripping is in accordance with the set Time Constant 1 (*Tau1*).
    With setting Itr = 101%*IBase1* and injection current 1.50 · *IBase1*, the trip time from zero content in the memory shall be 0.60 · Time Constant 1 (*Tau1*).
12. Check that all trip and alarm contacts operate according to the configuration logic.
13. Switch off the injection current and check from the service menu readings of thermal status and LOCKOUT that the lockout resets at the set percentage of heat content.
14. Activate the digital input for cooling input signal to switch over to base current *IBase2*.
    Wait 5 minutes to empty the thermal memory and set Time Constant 2 (*Tau2*) in accordance with the setting plan.
15. Test with injection current 1.50 · *IBase2* the thermal alarm level, the operate time for tripping and the lockout reset in the same way as described for stage *IBase1*.
16. Finally check that start and trip information is stored in the event menu.

13.5.3.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.4 Breaker failure protection CCRBRF

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

The Breaker failure protection function CCRBRF should normally be tested in conjunction with some other function that provides a start signal. An external START signal can also be used.

To verify the settings in the most common back-up trip mode *1 out of 3*, it is sufficient to test phase-to-earth faults.

At mode *2 out of 4* the phase current setting, *IP>* can be checked by single-phase injection where the return current is connected to the summated current input. The value of residual (earth fault) current IN set lower than *IP>* is easiest checked in back-up trip mode *1 out of 4*.

13.5.4.1 Checking the phase current operate value, *IP>*

The check of the *IP>* current level is best made in *FunctionMode* = *Current* and *BuTripMode* = *1 out of 3* or *2 out of 4*.

1. Apply the fault condition, including START of CCRBRF, with a current below set *IP>*.
2. Repeat the fault condition and increase the current in steps until a trip occurs.
3. Compare the result with the set *IP>*.
4. Disconnect AC and START input signals.

Note! If *NoI>check* or *Retrip off* is set, only back-up trip can be used to check set *IP>*.

13.5.4.2 Checking the residual (earth fault) current operate value *IN>* set below *IP>*

Check the low set *IN>* current where setting *FunctionMode* = *Current* and setting *BuTripMode* = *1 out of 4*

1. Apply the fault condition, including START of CCRBRF, with a current just below set *IN>Pickup_N*.
2. Repeat the fault condition and increase the current in steps until trip appears.
3. Compare the result with the set *IN>*.
4. Disconnect AC and START input signals.

13.5.4.3 Checking the re-trip and back-up times

The check of the set times can be made in connection with the check of operate values above.

Choose the applicable function and trip mode, such as *FunctionMode* = *Current* and *RetripMode* = *I> check*.

1. Apply the fault condition, including start of CCRBRF, well above the set current value. Measure time from START of CCRBRF.
2. Check the re-trip *t1* and back-up trip times *t2* and *t3*.
   In applicable cases, the back-up trip for multi-phase start *t2MPh* and back-up trip 2, *t2* and *t3* can also be checked. To check *t2MPh*, a two-phase or three-phase start shall be applied.
3. Disconnect AC and START input signals.

13.5.4.4 Verifying the re-trip mode

Choose the mode below, which corresponds to the actual case.

In the cases below it is assumed that *FunctionMode* = *Current* is selected.

Checking the case without re-trip, *RetripMode* = *Retrip Off*

1. Set *RetripMode* = *Retrip Off*.
2. Apply the fault condition, including start of CCRBRF, well above the set current value.
3. Verify that no re-trip, but back-up trip is achieved after set time.
4. Disconnect AC and START input signals.

Checking the re-trip with current check, *RetripMode* = *CB Pos Check*

1. Set *RetripMode* = *CB Pos Check*.
2. Apply the fault condition, including start of CCRBRF, well above the set current value.
3. Verify that re-trip is achieved after set time *t1* and back-up trip after time *t2*
4. Apply the fault condition, including start of CCRBRF, with current below set current value.
5. Verify that no re-trip, and no back-up trip is obtained.
6. Disconnect AC and START input signals.

Checking re-trip without current check, *RetripMode* = *No CBPos Check*

1. Set *RetripMode* = *No CBPos Check*.
2. Apply the fault condition, including start of CCRBRF, well above the set current value.
3. Verify that re-trip is achieved after set time *t1*, and back-up trip after time *t2*.
4. Apply the fault condition, including start of CCRBRF, with current below set current value.
5. Verify that re-trip is achieved after set time *t1*, but no back-up trip is obtained.
6. Disconnect AC and START input signals.

13.5.4.5 Verifying the back-up trip mode

In the cases below it is assumed that *FunctionMode* = *Current* is selected.

Checking that back-up tripping is not achieved at normal CB tripping

Use the actual tripping modes. The case below applies to re-trip with current check.

1. Apply the fault condition, including start of CCRBRF, with phase current well above set value *IP*.
2. Arrange switching the current off, with a margin before back-up trip time, *t2*. It may be made at issue of re-trip command.
3. Check that re-trip is achieved, if selected, but no back-up trip.
4. Disconnect AC and START input signals.

The normal mode *BuTripMode* = *1 out of 3* should have been verified in the tests above. In applicable cases the modes *1 out of 4* and *2 out of 4* can be checked. Choose the mode below, which corresponds to the actual case.

Checking the case *BuTripMode* = *1 out of 4*

It is assumed that the earth-fault current setting *IN>* is below phase current setting *IP>*.

1. Set *BuTripMode = 1 out of 4*.
2. Apply the fault condition, including start of CCRBRF, with one-phase current below set *IP>* but above *IN>*. The residual earth-fault should then be above set *IN>*.
3. Verify that back-up trip is achieved after set time. If selected, re-trip should also appear.
4. Disconnect AC and START input signals.

Checking the case *BuTripMode* = *2 out of 4*

The earth-fault current setting *IN>* may be equal to or below phase-current setting *IP>*.

1. Set *BuTripMode = 2 out of 4*.
2. Apply the fault condition, including start of CCRBRF, with one-phase current above set *IP>* and residual (earth fault) above set *IN>*. It can be obtained by applying a single-phase current.
3. Verify that back-up trip is achieved after set time. If selected, re-trip should also appear.
4. Apply the fault condition, including start of CCRBRF, with at least one-phase current below set *IP>* and residual (earth fault) above set *IN>*. The current may be arranged by feeding three- (or two-) phase currents with equal phase angle (I0-component) below *IP>*, but of such value that the residual (earth fault) current ($3I_0$) will be above set value *IN>*.
5. Verify that back-up trip is not achieved.
6. Disconnect AC and START input signals.

13.5.4.6 Verifying instantaneous back-up trip at CB faulty condition

Applies in a case where a signal from CB supervision function regarding CB being faulty and unable to trip is connected to input CBFLT.

1. Repeat the check of back-up trip time. Disconnect current and START input signals.
2. Activate the input CBFLT. The output CBALARM (CB faulty alarm) should appear after set time *tCBAlarm*. Keep the input activated.
3. Apply the fault condition, including start of CCRBRF, with current above set current value.
4. Verify that back-up trip is obtained without intentional delay, for example within 20ms from application of start.
5. Disconnect injected AC and STARTinput signals.

13.5.4.7 Verifying the case *RetripMode* = *Contact*

It is assumed that re-trip without current check is selected, *RetripMode* = *Contact*.

1. Set *FunctionMode* = *Contact*
2. Apply input signal for CB closed to relevant input or inputs CBCLDL1 (2 or 3)
3. Apply input signal, or signals for start of CCRBRF. The value of current could be low.
4. Verify that phase-selection re-trip and back-up trip are achieved after set times.
5. Disconnect the start signal(s). Keep the CB closed signal(s).
6. Apply input signal(s), for start of CCRBRF. The value of current could be low.
7. Arrange disconnection of CB closed signal(s) well before set back-up trip time *t2*.
8. Verify that back-up trip is not achieved.
9. Disconnect injected AC and START input signals.

13.5.4.8 Verifying the function mode *Current&Contact*

To be made only when *FunctionMode* = *Current&Contact* is selected. It is suggested to make the tests in one phase only, or at three-phase trip applications for just three-phase tripping.

Checking the case with fault current above set value *IP>*

The operation shall be as in *FunctionMode* = *Current*.

1. Set *FunctionMode* = *Current&Contact*.
2. Leave the inputs for CB close inactivated. These signals should not influence.
3. Apply the fault condition, including start of CCRBRF, with current above the set *IP>* value.
4. Check that the re-trip, if selected, and back-up trip commands are achieved.
5. Disconnect injected AC and START input signals.

Checking the case with fault current below set value *I>BlkCont*

The case shall simulate a case where the fault current is very low and operation will depend on CB position signal from CB auxiliary contact. It is suggested that re-trip without current check is used, setting *RetripMode* = *No CBPos Check*.

1. Set *FunctionMode* = *Current&Contact*.
2. Apply input signal for CB closed to relevant input or inputs CBCLDL1 (2 or 3)
3. Apply the fault condition with input signal(s) for start of CCRBRF. The value of current should be below the set value *I>BlkCont*
4. Verify that phase selection re-trip (if selected) and back-up trip are achieved after set times. Failure to trip is simulated by keeping the signal(s) CB closed activated.
5. Disconnect the AC and the START signal(s). Keep the CB closed signal(s).
6. Apply the fault and the start again. The value of current should be below the set value *I>BlkCont*.

7. Arrange disconnection of BC closed signal(s) well before set back-up trip time *t2*. It simulates a correct CB tripping.
8. Verify that back-up trip is not achieved. Re-trip can appear for example, due to selection “Re-trip without current check”.
9. Disconnect injected AC and START input signals.

13.5.4.9 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.5 Breaker failure protection, single phase version CCSRBRF

Prepare the IED for verification of settings as outlined in section "Overview" and section "Preparing for test" in this chapter.

The breaker failure protection, single phase version function CCSRBRF should normally be tested in conjunction with some other function that provides a START signal. An external START signal can also be used.

CCSRBRF has to be set and configured before the testing can start. CCSRBRF is highly flexible in that it permits a choice of functional and tripping modes. The various modes are checked at the factory as part of the design verification. In certain cases only modes with a high probability of coming into operation need to be checked, in order to verify the configuration and settings.

Testing requirements

- Calculated settings
- Valid configuration diagram for the IED
- Valid terminal diagram for the IED
- Technical reference manual
- Single phase test equipment

The technical reference manual contains application and functionality summaries, function blocks, logic diagrams, input and output signals, a list of setting parameters and technical data for the function.

The test equipment should be able to provide a single phase supply of currents. The magnitude of currents should be possible to vary.

Make sure the IED is prepared for test before starting the test session. Consider the logic diagram of the function when performing the test. The response from a test can be viewed in different ways:

- Binary output signals
- Service values in the local HMI (logical signal or phasors)
- A PC with PCM600 (configuration software) in debug mode

13.5.5.1 Checking the phase current operate value *IP>*

Procedure

1. Apply the fault condition, including START of CCSRBRF, with a current below set *IP>*.
2. Repeat the fault condition and increase the current in steps until a trip occurs.
3. Compare the result with the set *IP>*.
4. Disconnect AC and start the input signals.

Note! If “No I> check” or “Retrip off” is set, only back-up trip can be used to check set *IP>*.

13.5.5.2 Checking the re-trip and back-up times

The check of the set times can be made in connection with the check of operate values above. Choose the applicable function and trip mode, such as *FunctMode* = *Current* and *RetripMode* = *I> check*.

Procedure

1. Apply the fault condition, including START of CCSRBRF, well above the set current value. Measure time from “Start of CCSRBRF”.
2. Check the re-trip *t1* and back-up trip times *t2* and *t3*
3. Disconnect AC and start input signals.

13.5.5.3 Verifying the re-trip mode

Choose the mode below, which corresponds to the actual case. In the cases below it is assumed that *FunctionMode* = *Current* is selected.

Checking the case without re-trip, *RetripMode* = *Off*

Procedure

1. Set *RetripMode* = *Off*.
2. Apply the fault condition, including START of CCSRBRF, well above the set current value.
3. Verify that no re-trip, but back-up trip is achieved after set time.
4. Disconnect AC and start input signals.

Checking the re-trip with current check, *RetripMode* = *I>*

Procedure

1. Set *RetripMode* = *I*>.
2. Apply the fault condition, including START of CCSRBRF, well above the set current value.
3. Verify that retrip is achieved after set time *t1* and back-up trip after time *t2*
4. Apply the fault condition, including START of CCSRBRF, with current below set current value.
5. Verify that no re-trip, and no back-up trip is obtained.
6. Disconnect AC and start input signals.

Checking re-trip without current check, *RetripMode* = *No CB Pos Check*

Procedure

1. Set *RetripMode* = *No CB Pos Check*.
2. Apply the fault condition, including START of CCSRBRF, well above the set current value.
3. Verify that re-trip is achieved after set time *t1*, and back-up trip after time *t2*.
4. Apply the fault condition, including START of CCSRBRF, with current below set current value.
5. Verify that re-trip is achieved after set time*t1*, but no back-up trip is obtained.
6. Disconnect AC and start input signals.

13.5.5.4 Verifying the back-up trip mode

In the cases below it is assumed that *FunctionMode* = *Current* is selected.

Checking that back-up tripping is not achieved at normal CB tripping

Use the actual tripping modes. The case below applies to re-trip with current check.

Procedure

1. Apply the fault condition, including START of CCSRBRF, with phase current well above set value *IP*.
2. Arrange switching the current off, with a margin before back-up trip time, *t2*. It may be made at issue of re-trip command.
3. Check that re-trip is achieved, if selected, but no back-up trip.
4. Disconnect AC and start input signals.

13.5.5.5 Verifying instantaneous back-up trip at “CB faulty” condition

Applies in a case where signal “CB faulty and unable to trip” is connected to input CBFLT.

Procedure

1. Repeat the check of back-up trip time. Disconnect current and START input signals.
2. Activate the input CBFLT. The output CBALARM (CB faulty alarm) should appear after set time *tCBAlarm*. Keep the input activated.
3. Apply the fault condition, including START of CCSRBRF, with current above set current value.
4. Verify that back-up trip is obtained without intentional delay, for example, within 20ms from application of START.
5. Disconnect injected AC and input signals.

13.5.5.6 Verifying the case *FunctionMode* = *Contact*

It is assumed that re-trip without current check is selected, *RetripMode* = *No I>*.

Procedure

1. Set *FunctionMode* = *Contact*.
2. Apply input signal for CB closed to relevant input or inputs CBCLD
3. Apply input signal, or signals for START of CCSRBRF. The value of current could be low.
4. Verify that re-trip and back-up trip are achieved after set times.
5. Disconnect the START signal(s). Keep the CB closed signal(s).
6. Apply input signal(s), for START of CCSRBRF. The value of current could be low.
7. Arrange disconnection of CB closed signal(s) well before set back-up trip time *t2*.
8. Verify that back-up trip is not achieved.
9. Disconnect injected AC and START input signals.

13.5.5.7 Verifying the function mode *Curr&Cont Check*

To be made only when *FunctionMode* = *Current&Contact* is selected. It is suggested to make the tests in one phase only, or at three-phase trip applications for just three-phase tripping.

Checking the case with fault current above set value

The operation shall be as in *FunctionMode* = *Current*.

Set

RetripMode = *CB Pos Check*.
Procedure

1. Set *FunctionMode* = *Curr&Cont Check*.
2. Leave the inputs for CB close inactivated. These This signals should not influence.
3. Apply the fault condition, including START of CCSRBRF, with current above the set *IP>* value.
4. Check that the re-trip, if selected, and back-up trip commands are achieved.
5. Disconnect injected AC and START input signals.

Checking the case with fault current below set value

The case shall simulate a case where the fault current is very low and operation will depend on CB position signal from CB auxiliary contact. It is suggested that re-trip without current check is used; setting *RetripMode* = *No CB Pos Check*.

Procedure

1. Set *FunctionMode* = *Current&Contact*.
2. Apply input signal for CB closed to relevant input or inputs CBCLD
3. Apply the fault condition with input signal(s) for START of CCSRBRF. The value of current should be below the set value *I>BlkCont*
4. Verify that re-trip (if selected) and back-up trip are achieved after set times. Failure to trip is simulated by keeping the signal(s) CB closed activated.
5. Disconnect the AC and the START signal(s). Keep the CB closed signal(s).
6. Apply the fault and the START again. The value of current should be below the set value *I>BlkCont*
7. Arrange disconnection of BC closed signal(s) well before set back-up trip time *t2*. It simulates a correct CB tripping.
8. Verify that back-up trip is not achieved. Re-trip can appear, for example, due to selection *RetripMode* = *No CB Pos Check*.
9. Disconnect injected AC and START input signals.

13.5.5.8 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.6 Directional underpower protection GUPPDUP

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

13.5.6.1 Verifying the settings

The underpower protection shall be set to values according to the real set values to be used.

The test is made by means of injection of voltage and current where the amplitude of both current and voltage and the phase angle between the voltage and current can be controlled. During the test, the analog outputs of active and reactive power shall be monitored.

1. Connect the test set for injection of voltage and current corresponding to the mode to be used in the application. If a three-phase test set is available this could be used for all the modes. If a single-phase current/voltage test set is available the test set should be connected to a selected input for one-phase current and voltage.

Table 18: Calculation modes

Set value: *Mode*	Formula used for complex power calculation
L1, L2, L3	$\overline{S} = \overline{U}_{L1} \cdot \overline{I}_{L1}^{*} + \overline{U}_{L2} \cdot \overline{I}_{L2}^{*} + \overline{U}_{L3} \cdot \overline{I}_{L3}^{*}$ (Equation 4)
Arone	$\overline{S} = \overline{U}_{L1L2} \cdot \overline{I}_{L1}^{*} - \overline{U}_{L2L3} \cdot \overline{I}_{L3}^{*}$ (Equation 5)
PosSeq	$\overline{S} = 3 \cdot \overline{U}_{PosSeq} \cdot \overline{I}_{PosSeq}^{*}$ (Equation 6)
L1L2	$\overline{S} = \overline{U}_{L1L2} \cdot (\overline{I}_{L1}^{*} - \overline{I}_{L2}^{*})$ (Equation 7)
L2L3	$\overline{S} = \overline{U}_{L2L3} \cdot (\overline{I}_{L2}^{*} - \overline{I}_{L3}^{*})$ (Equation 8)
L3L1	$\overline{S} = \overline{U}_{L3L1} \cdot (\overline{I}_{L3}^{*} - \overline{I}_{L1}^{*})$ (Equation 9)
L1	$\overline{S} = 3 \cdot \overline{U}_{L1} \cdot \overline{I}_{L1}^{*}$ (Equation 10)
L2	$\overline{S} = 3 \cdot \overline{U}_{L2} \cdot \overline{I}_{L2}^{*}$ (Equation 11)
L3	$\overline{S} = 3 \cdot \overline{U}_{L3} \cdot \overline{I}_{L3}^{*}$ (Equation 12)

2. Adjust the injected current and voltage to the set values in % of *IBase* and *UBase* (converted to secondary current and voltage). The angle between the injected current and voltage shall be set equal to the set direction *Angle1*,

angle for stage 1 (equal to 0° for low forward power protection and equal to 180° for reverse power protection). Check that the monitored active power is equal to 100% of rated power and that the reactive power is equal to 0% of rated power.

3. Change the angle between the injected current and voltage to *Angle1* + 90°. Check that the monitored active power is equal to 0% of rated power and that the reactive power is equal to 100% of rated power.
4. Change the angle between the injected current and voltage back to 0°. Decrease the current slowly until the START1 signal, start of stage 1, is activated.
5. Increase the current to 100% of *IBase*.
6. Switch the current off and measure the time for activation of TRIP1, trip of stage 1.
7. If a second stage is used, repeat steps 2 to 6 for the second stage.

13.5.6.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.7 Directional overpower protection GOPPDOP

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

13.5.7.1 Verifying the settings

The overpower protection shall be set to values according to the real set values to be used. The test is made by means of injection of voltage and current where the amplitude of both current and voltage and the phase angle between the voltage and current can be controlled. During the test the analog outputs of active and reactive power shall be monitored.

1. Connect the test set for injection of voltage and current corresponding to the mode to be used in the application. If a three phase test set is available this could be used for all the modes. If a single phase current/voltage test set is available the test set should be connected to a selected input for one phase current and voltage.
2. Adjust the injected current and voltage to the set rated values in % of *IBase* and *UBase* (converted to secondary current and voltage). The angle between the injected current and voltage shall be set equal to the set direction *Angle1*, angle for stage 1 (equal to 0° for low forward power protection and equal to 180° for reverse power protection). Check that the monitored active power is

equal to 100% of rated power and that the reactive power is equal to 0% of rated power.

3. Change the angle between the injected current and voltage to *Angle1* + 90°. Check that the monitored active power is equal to 0% of rated power and that the reactive power is equal to 100% of rated power.
4. Change the angle between the injected current and voltage back to *Angle1* value. Increase the current slowly from 0 until the START1 signal, start of stage 1, is activated. Check the injected power and compare it to the set value *Power1*, power setting for stage 1 in % of *Sbase*.
5. Increase the current to 100% of *IBase* and switch the current off.
6. Switch the current on and measure the time for activation of TRIP1, trip of stage 1.
7. If a second stage is used, repeat steps 2 to 6 for the second stage.

13.5.7.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.5.8 Capacitor bank protection CBPGAPC

Prepare the IED for verification of settings as outlined in section "Preparing for test" in this chapter.

In this section it is shown how to test the capacitor bank protection function CBPGAPC for application on a 50Hz, 200MVAr, 400kV SCB with 500/1A ratio CT.

Note that such SCB is shown in the application manual for this function. The same procedure can be used to test SCB with some other rating and different CT ratio.

As calculated in the application manual the base current for this particular SCB will be 289A on the primary side and 0.578A on the CT secondary side. Before any testing is commenced make sure that setting *IBase* for this function is set to *289A* (that is, setting for the base current corresponds to the rated current of the protected SCB). It will be also assumed that all other settings have values as shown in the setting example in the application manual for this SCB.

Test equipment

Connect the secondary test set to the CT inputs on the IED dedicated for the SCB currents. Single- or three-phase test equipment can be used but it may be required to have facility to vary the frequency of the injected current signal(s).

13.5.8.1 Verifying the settings and operation of the function

Reconnection inhibit feature

1. Inject SCB rated current (that is, 0.587A at 50Hz for this SCB) in at least one phase (preferably perform this test with three phase injection).
2. After couple of seconds stop injection of all currents (that is, set all currents back to 0A).
3. Check that function binary output signal RECNINH is set to one and that only resets after the set time under parameter *tReconnInhibit* for example 300s for this SCB) has expired.
4. If this binary signal is used to prevent CB closing make sure that it is properly connected/wired into the CB closing circuit.

Overcurrent feature

Note that during testing the overcurrent feature the harmonic voltage overload feature or reactive power overload feature may also give start and trip signals depending on their actual settings. Therefore it is best to switch them off during this test.

1. Inject current 20% bigger than the set overcurrent pickup level under setting parameter *IOC>* (for example, $1.2 \cdot 1.35 \cdot 0.587A = 0951A$ at 50Hz for this SCB) in phase L1 only.
2. Check that function binary output signals STOCL1 and STOC are set to one.
3. Check that function binary output signals TROC and TRIP are set to one after the set time under parameter *tOC* (that is, 30s for this SCB) has expired.
4. If any of these signals are used for tripping, signaling and/or local/remote indication check that all relevant contacts and LEDs have operated and that all relevant GOOSE messages have been sent.
5. Check that service value from the function for current in phase L1, on the local HMI under **Main menu/Test** is approximately 476A (that is, $0.951A \cdot (500/1) = 476A$).
6. Stop injection of all currents (that is, set all currents back to 0A).
7. Check that all above mentioned function binary output signals now have logical value zero.
8. Repeat above steps 1-7 for phase L2and phase L3.

Note that the operation of this feature is based on current peak value. That means that this overcurrent function is also able to operate for the same current magnitude but for different injected frequencies. If required repeat this injection procedure for example for the 3rd harmonic by just simply injecting $3 \cdot 50 = 150Hz$ currents with the same magnitude. Obtain results shall be the same.

Undercurrent feature

1. Inject SCB rated current (that is, 0.587A at 50Hz for this SCB) in all three phases.
2. Lower phase L1 current 10% under the set value for setting parameter *IUC<* (that is, 0.9 · 0.7 · 0.587A = 0.370A at 50Hz for this SCB).
3. Check that function binary output signals STUCL1 and STUC are set to one.
4. Check that function binary output signals TRUC and TRIP are set to one after the set time under parameter *tUC* (for example, 5s for this SCB) has expired.
5. If any of these signals are used for tripping, signaling and/or local/remote indication check that all relevant contacts and LEDs have operated and that all relevant GOOSE messages have been sent.
6. Check that service value from the function for current in phase L1, on the local HMI under **Main menu/Test** is approximately 185A (that is, 0.370A · (500/1) = 185A).
7. Stop injection of all currents (that is, set all currents back to 0A).
8. Check that all above mentioned function binary output signals now have logical value zero because they will be automatically blocked by operation of built-in reconnection inhibit feature.
9. Repeat above steps 1-8 for phase L2 and phase L3.

Reactive power overload feature

Note that during testing the reactive power overload feature the harmonic voltage overload feature or overcurrent feature may also give start and trip signals depending on their actual settings. Therefore it is best to switch them off during this test.

1. Inject current equal to the set reactive power overload pickup level under setting parameter *QOL>* (that is, 1.3 · 0.587A = 0.763A at 50Hz for this SCB) in phase L1 only.
2. Check that function binary output signals STQOLL1 and STQOL are set to one.
3. Check that function binary output signals TRQOL and TRIP are set to one after the set time under parameter *tQOL* (for example, 60s for this SCB) has expired.
4. If any of these signals are used for tripping, signaling and/or local/remote indication check that all relevant contacts and LEDs have operated and that all relevant GOOSE messages have been sent.
5. Check that service value from the function for current in phase L1, on the local HMI under **Main menu/Test** is approximately *382A* (that is, 0.763A · (500/1) = 382A).
6. Check that service value from the function for reactive power in phase L1, on the local HMI under **Main menu/Test** is approximately 169% (that is, 1.3 · 1.3 = 1,69pu = 169%).

7. Stop injection of all currents (that is, set all currents back to 0A).
8. Check that all above mentioned function binary output signals now have logical value zero.
9. Repeat above steps 1 - 8 for phase L2 and phase L3.

Note that operation of this feature is based on injected current and internally calculated true RMS values. That means that this feature is also able to operate for current signals with varying frequency. However due to relatively complex calculation procedure it is recommended to do secondary tests only with fundamental frequency current signals.

The following formula can be used to calculate SCB reactive power in per-unit system when current with different frequency from the rated frequency is injected.

$$Q[pu] = \frac{f_{rated}}{f_{injected}} \cdot I^2 [pu]$$

(Equation 13)

Harmonic voltage overload feature

Note that during testing the harmonic voltage overload feature the reactive power overload feature or overcurrent feature may also give start and trip signals depending on their actual settings. Therefore it is best to switch them off during this test.

Procedure to test inverse time delayed step:

The following points on the inverse curve are defined per relevant IEC/ANSI standards for time multiplier value set to *kHOLIDMT*=1.0

UpeakRMS [pu]	1.15	1.2	1.3	1.4	1.7	2.0	2.2
Time [s]	1800	300	60	15	1	0.3	0.12

Note that operation of this feature is based on internally calculated voltage peak RMS value. That means that this feature is also able to operate for current signals with varying frequency.

Here will be shown how to test the fourth point from the above table. Other points can be tested in the similar way:

1. Inject 140% of the base current (that is, 1.4 · 0.587A = 0.822A at 50Hz for this SCB) in phase L1only.
2. Check that function binary output signals STHIDML1 and STHOL are set to one.
3. Check that function binary output signals TRHOL and TRIP are set to one after the expected time (for example, 15s for this voltage level in accordance with the above table) has expired.
4. If any of these signals are used for tripping, signaling and/or local/remote indication, check that all relevant contacts and LEDs have operated and that all relevant GOOSE messages have been sent.
5. Check that service value for current in phase L1, on the local HMI under **Main menu/Test** is approximately *411A* (that is, 0.822A · (500/1) = 411A).
6. Check that service value for voltage across SCB in phase L1, on the local HMI under **Main menu/Test** is approximately 140%.
7. Stop injection of all currents (that is, set all currents back to 0A).
8. Check that all above mentioned function binary output signals now have logical value zero.
9. Repeat above steps 1 - 8 for phase L2 and phase L3.
10. Repeat above steps 1 - 8 to test different points from the above table.

Operation of this feature is based on internally calculated peak RMS voltage value. That means that this feature is also able to operate for current signals with varying frequency. Note that for the fundamental frequency injection, internally calculated voltage in percent corresponds directly to the injected current value given in percent. However if it is required to test IDMT characteristic with a varying frequency, the magnitude of the injected current must be adjusted accordingly. The following formula can be used to calculate required current RMS value in percent at the desired injection frequency in order to archive voltage percentage value given in the above table:

$$I_{inj}\left[\%\right] = \frac{f_{injected}}{f_{rated}} \cdot U\left[\%\right]$$

(Equation 14)

Note that it is recommended to test IDMT operating times by injected current with the rated frequency.

Above procedure can also be used to test definite time step. Pay attention that IDMT step can also operate during such injection. Therefore make sure that appropriate settings are entered in order to insure correct test results for definite time step.

13.5.8.2 Completing the test

Continue to test another functions or end the test by changing the Test mode setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes. Make sure that all built-in features for this function, which shall be in operation, are enabled and with correct settings.

13.6 Voltage protection

13.6.1 Two step undervoltage protection UV2PTUV

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

13.6.1.1 Verifying the settings

Verification of START value and time delay to operate for Step1

1. Check that the IED settings are appropriate, especially the START value, the definite time delay and the *1 out of 3* operation mode.
2. Supply the IED with three-phase voltages at their rated values.
3. Slowly decrease the voltage in one of the phases, until the START signal appears.
4. Note the operate value and compare it with the set value.
5. Increase the measured voltage to rated load conditions.
6. Check that the START signal resets.
7. Instantaneously decrease the voltage in one phase to a value about 20% lower than the measured operate value.
8. Measure the time delay for the TRIP signal, and compare it with the set value.

Extended testing

1. The test above can now be repeated for step 2.
2. The tests above can be repeated for *2 out of 3* and for *3 out of 3* operation mode.
3. The tests above can be repeated to check security, that is, the START and operate signals, that are not supposed to appear, - do not.
4. The tests above can be repeated to check the time to reset.
5. The tests above can be repeated to test the inverse time characteristic.

13.6.1.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.2 Two step overvoltage protection OV2PTOV

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

13.6.2.1 Verifying the settings

1. Apply single-phase voltage below the set value *U1>*.
2. Slowly increase the voltage until the ST1 signal appears.
3. Note the operate value and compare it with the set value.
4. Switch the applied voltage off.
5. Set and apply about 20% higher voltage than the measured operate value for one phase.
6. Measure the time delay for the TR1 signal and compare it with the set value.
7. Repeat the test for step 2.

13.6.2.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.3 Two step residual overvoltage protection ROV2PTOV

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

13.6.3.1 Verifying the settings

1. Apply the single-phase voltage either to a single phase voltage input or to a residual voltage input with the start value below the set value *U1>*.
2. Slowly increase the value until ST1 appears.
3. Note the operate value and compare it with the set value.
4. Switch the applied voltage off.
5. Set and apply about 20% higher voltage than the measured operate value for one phase.
6. Measure the time delay for the TR1 signal and compare it with the set value.
7. Repeat the test for step 2.

13.6.3.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.4 Voltage differential protection VDCPTOV

Prepare the IED for verification of settings as outlined in section "Overview" and section "Preparing for test" in this chapter.

13.6.4.1 Check of undervoltage levels

This test is relevant if the setting *BlkDiffAtULow* = *Yes*.

Check of *U1Low*

Procedure

1. Connect voltages to the IED according to valid connection diagram and figure 51.
2. Apply voltage higher than the highest set value of *UDTrip*, *U1Low* and *U2Low* to the U1 three-phase inputs and to one phase of the U2 inputs according to figure 51.
   The voltage differential START signal is set.

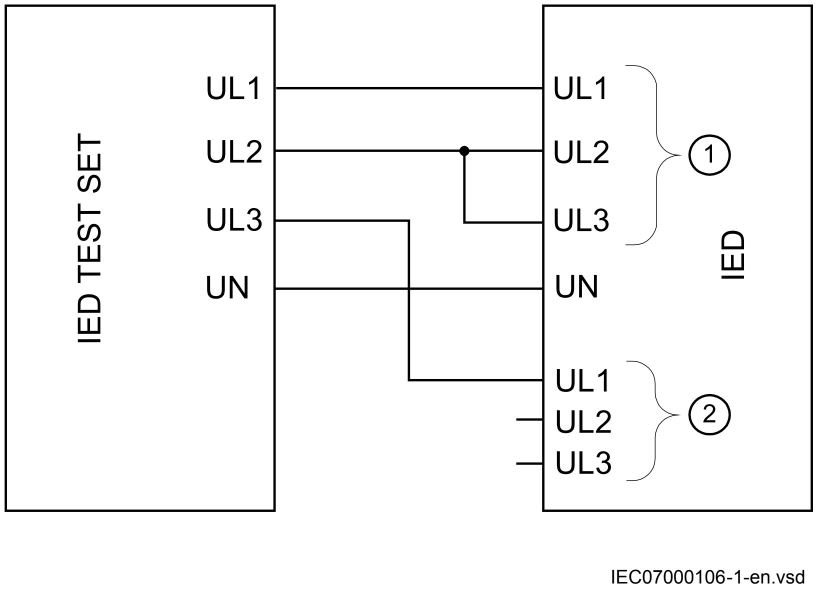


Figure 54: Connection of the test set to the IED for test of U1 block level

where:

1	is three-phase voltage group1 (U1)
2	is three-phase voltage group2 (U2)

3. Decrease slowly the voltage in phase UL1 of the test set until the START signal resets.
4. Check U1 blocking level by comparing the voltage level at reset with the set undervoltage blocking *U1Low*.
5. Repeat steps 2 to 4 to check *U1Low* for the other phases.

The connections to U1 must be shifted to test another phase. (UL1 to UL2, UL2 to UL3, UL3 to UL1)

Check of *U2Low*

Procedure

1. Connect voltages to the IED according to valid connection diagram and figure 52.

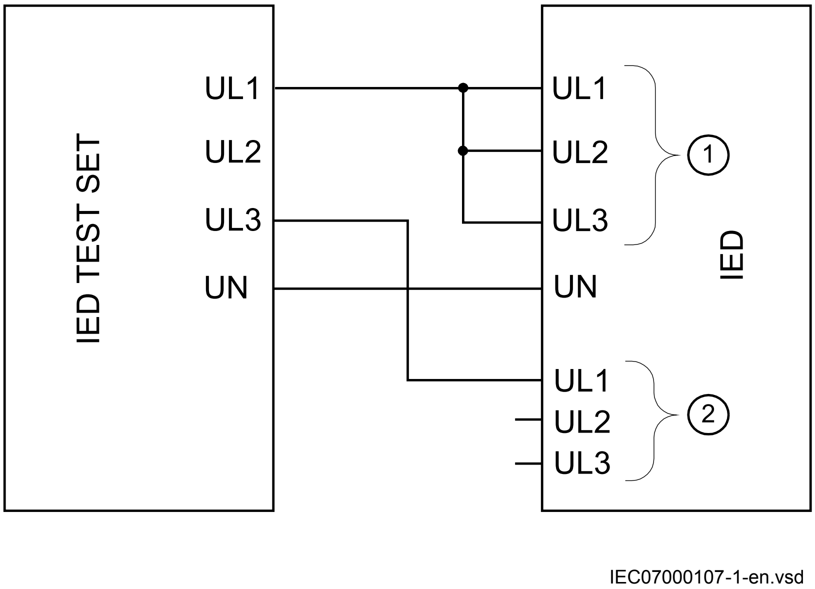


Figure 55: Connection of the test set to the IED for test of U2 block level

where:

1	is three-phase voltage group1 (U1)
2	is three-phase voltage group2 (U2)

2. Apply voltage higher than the highest set value of *UDTrip*, *U1Low* and *U2Low* to the U1 three-phase inputs and to one phase of the U2 inputs according to figure 52.
   The voltage differential START signal is set.
3. Decrease slowly the voltage in phase UL3 of the test set until the START signal resets.
4. Check U2 blocking level by comparing the voltage level at reset with the set undervoltage blocking *U2Low*.

13.6.4.2 Check of voltage differential trip and alarm levels

Procedure

1. Connect voltages to the IED according to valid connection diagram and figure 53.

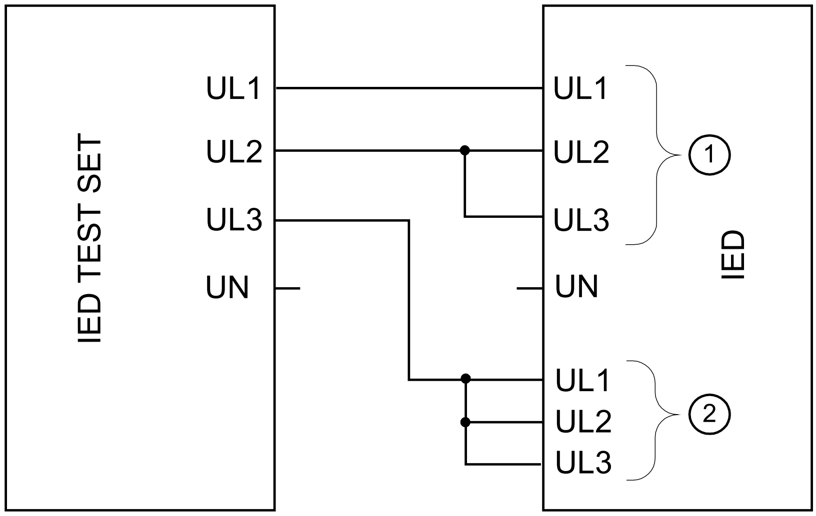


Figure 56: Connection of the test set to the IED for test of alarm levels, trip levels and trip timer

where:

1	is three-phase voltage group1 (U1)
2	is three-phase voltage group2 (U2)

2. Apply 1.2 · Ur (rated voltage) to the U1 and U2 inputs.
3. Decrease slowly the voltage of in phase UL1 of the test set until the ALARM signal is activated.

The ALARM signal is delayed with timer *tAlarm*

4. Check the alarm operation level by comparing the differential voltage level at ALARM with the set alarm level *UDAlarm*.
5. Continue to slowly decrease the voltage until START signal is activated.
6. Check the differential voltage operation level by comparing the differential voltage level at START with the set trip level *UDTrip*.
7. Repeat steps 1 to 2 to check the other phases.
   Observe that the connections to U1 must be shifted to test another phase. (UL1 to UL2, UL2 to UL3, UL3 to UL1)

13.6.4.3 Check of trip and trip reset timers

Procdure

1. Connect voltages to the IED according to valid connection diagram and figure 53.
2. Set Ur (rated voltage) to the U1 inputs and increase U2 voltage until differential voltage is 1.5 · operating level (*UDTrip*).
3. Switch on the test set. Measure the time from activation of the START signal until TRIP signal is activated.
4. Check the measured time by comparing it to the set trip time *tTrip*.
5. Increase the voltage until START signal resets. Measure the time from reset of START signal to reset of TRIP signal.
6. Check the measured time by comparing it to the set trip reset time *tReset*.

13.6.4.4 Final adjustment of compensation for VT ratio differences

Procedure

1. With the protection in test mode, view the differential voltage service values in each phase on the local HMI under **Main menu/Test/Function status/ Voltage protection/VoltageDiff(PTOV,60)/VDCPTOV:x**.

   The IED voltage inputs should be connected to the VTs according to valid connection diagram.

2. Record the differential voltages.
3. Calculate the compensation factor *RFLx* for each phase.
   For information about calculation of the compensation factor, see the application manual.
4. Set the compensation factors on the local HMI under **Main menu/Settings/ Settings group N/Voltage protection/VoltageDiff(PTOV,60)/VDCPTOV:x**
5. Check that the differential voltages are close to zero.

13.6.4.5 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.6.5 Loss of voltage check LOVPTUV

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

13.6.5.1 Measuring the operate limit of set values

1. Check that the input logical signals BLOCK, CBOPEN and VTSU are logical zero.
2. Supply a three-phase rated voltage in all three phases and note on the local HMI that the TRIP logical signal is equal to the logical 0.
3. Switch off the voltage in all three phases.
   After set *tTrip* time a TRIP signal appears on the corresponding binary output or on the local HMI.

   Note that TRIP at this time is a pulse signal, duration should be according to set *tPulse*.

4. Inject the measured voltages to their rated values for at least set *tRestore* time.
5. Activate the CBOPEN binary input.
6. Simultaneously disconnect all the three-phase voltages from the IED.
   No TRIP signal should appear.
7. Inject the measured voltages to their rated values for at least set *tRestore* time.
8. Activate the VTSU binary input.
9. Simultaneously disconnect all the three-phase voltages from the *tRestore*.
   No TRIP signal should appear.
10. Reset the VTSU binary input.
11. Inject the measured voltages to their rated values for at least set *tRestore* time.
12. Activate the BLOCK binary input.
13. Simultaneously disconnect all the three-phase voltages from the terminal.
    No TRIP signal should appear.
14. Reset the BLOCK binary input.

13.6.5.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.7 Frequency protection

13.7.1 Underfrequency protection SAPTUF

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

13.7.1.1 Verifying the settings

Verification of START value and time delay to operate

1. Check that the IED settings are appropriate, especially the START value and the definite time delay.
2. Supply the IED with three-phase voltages at their rated values.
3. Slowly decrease the frequency of the applied voltage, until the START signal appears.
4. Note the operate value and compare it with the set value.
5. Increase the frequency until rated operating levels are reached.
6. Check that the START signal resets.
7. Instantaneously decrease the frequency of the applied voltage to a value about 20% lower than the operate value.
8. Measure the time delay of the TRIP signal, and compare it with the set value.

Extended testing

1. The test above can be repeated to check the time to reset.
2. The tests above can be repeated to test the frequency dependent inverse time characteristic.

Verification of the low voltage magnitude blocking

1. Check that the IED settings are appropriate, especially the *StartFrequency*, *IntBlockLevel*, and the *TimeDlyOperate*.
2. Supply the IED with three-phase voltages at rated values.
3. Slowly decrease the magnitude of the applied voltage, until the BLKDMAGN signal appears.
4. Note the voltage magnitude value and compare it with the set value *IntBlockLevel*.
5. Slowly decrease the frequency of the applied voltage, to a value below *StartFrequency*.
6. Check that the START signal does not appear.
7. Wait for a time corresponding to *TimeDlyOperate*, and make sure that the TRIP signal not appears.

13.7.1.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.7.2 Overfrequency protection SAPTOF

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

13.7.2.1 Verifying the settings

Verification of START value and time delay to operate

1. Check that the settings in the IED are appropriate, especially the START value and the definite time delay.
2. Supply the IED with three-phase voltages at their rated values.
3. Slowly increase the frequency of the applied voltage, until the START signal appears.
4. Note the operate value and compare it with the set value.
5. Decrease the frequency to rated operating conditions.
6. Check that the START signal resets.
7. Instantaneously increase the frequency of the applied voltage to a value about 20% higher than the operate value.
8. Measure the time delay for the TRIP signal, and compare it with the set value.

Extended testing

1. The test above can be repeated to check the time to reset.

Verification of the low voltage magnitude blocking

1. Check that the settings in the IED are appropriate, especially the *StartFrequency*, *IntBlocklevel*, and the *TimeDlyOperate*.
2. Supply the IED with three-phase voltages at their rated values.
3. Slowly decrease the magnitude of the applied voltage, until the BLKDMAGN signal appears.
4. Note the voltage magnitude value and compare it with the set value, *IntBlocklevel*.
5. Slowly increase the frequency of the applied voltage, to a value above *StartFrequency*.
6. Check that the START signal does not appear.
7. Wait for a time corresponding to *TimeDlyOperate*, and make sure that the TRIP signal does not appear.

13.7.2.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.7.3 Rate-of-change frequency protection SAPFRC

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

13.7.3.1 Verifying the settings

Verification of START value and time delay to operate

1. Check that the settings in the IED are appropriate, especially the START value and the definite time delay. Set *StartFreqGrad*, to a rather small negative value.
2. Supply the IED with three-phase voltages at their rated values.
3. Slowly decrease the frequency of the applied voltage, with an increasing rate-of-change that finally exceeds the setting of *StartFreqGrad*, and check that the START signal appears.
4. Note the operate value and compare it with the set value.
5. Increase the frequency to rated operating conditions, and zero rate-of-change.
6. Check that the START signal resets.
7. Instantaneously decrease the frequency of the applied voltage to a value about 20% lower than the nominal value.
8. Measure the time delay for the TRIP signal, and compare it with the set value.

Extended testing

1. The test above can be repeated to check a positive setting of *StartFreqGrad*.
2. The tests above can be repeated to check the time to reset.
3. The tests above can be repeated to test the RESTORE signal, when the frequency recovers from a low value.

13.7.3.2 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.8 Multipurpose protection

13.8.1 General current and voltage protection CVGAPC

Prepare the IED for verification of settings as outlined in section "Overview" and section "Preparing for test" in this chapter.

One of the new facilities within the general current and voltage protection function CVGAPC is that the value, which is processed and used for evaluation in the function, can be chosen in many different ways by the setting parameters *CurrentInput* and *VoltageInput*.

These setting parameters decide what kind of preprocessing the connected three-phase CT and VT inputs shall be subjected to. That is, for example, single-phase quantities, phase-to-phase quantities, positive sequence quantities, negative sequence quantities, maximum quantity from the three-phase group, minimum quantity from the three-phase group, difference between maximum and minimum quantities (unbalance) can be derived and then used in the function.

Due to the versatile possibilities of CVGAPC itself, but also the possibilities of logic combinations in the application configuration of outputs from more than one CVGAPC function block, it is hardly possible to define a fully covering general commissioning test.

When inverse time overcurrent characteristic is selected, the operate time of the stage will be the sum of the inverse time delay and the set definite time delay. Thus, if only the inverse time delay is required, it is of utmost importance to set the definite time delay for that stage to zero.

13.8.1.1 Built-in overcurrent feature (non-directional)

Procedure

1. Go to **Main menu/Test/Function test modes/Multipurpose protection/ GeneralCurrentVoltage(GAPC)/CVGAPC:x** and make sure that CVGAPC to be tested is unblocked and other functions that might disturb the evaluation of the test are blocked.
2. Connect the test set for injection of three-phase currents to the appropriate current terminals of the IED in the 670 series.
3. Inject current(s) in a way that relevant measured current (according to setting parameter *CurrentInput*) is created from the test set. Increase the current(s) until the low set stage operates and check against the set operate value.
4. Decrease the current slowly and check the reset value.
5. Block high set stage if the injection current will activate the high set stage when testing the low set stage according to below.
6. Connect a TRIP output contact to the timer.
7. Set the current to 200% of the operate value of low set stage, switch on the current and check the time delay.
   For inverse time curves, check the operate time at a current equal to 110% of the operate current at *tMin*.
8. Check that TRIP and START contacts operate according to the configuration logic.
9. Release the blocking of the high set stage and check the operate and reset value and the time delay for the high set stage in the same way as for the low set stage.
10. Finally check that START and TRIP information is stored in the event menu.

Information on how to use the event menu is found in the operator's manual.

13.8.1.2 Overcurrent feature with current restraint

The current restraining value has also to be measured or calculated and the influence on the operation has to be calculated when the testing of the operate value is done.

Procedure

1. Operate value measurement
   The current restraining value has also to be measured or calculated and the influence on the operation has to be calculated when the testing of the operate value is done.

13.8.1.3 Overcurrent feature with voltage restraint

Procedure

1. Connect the test set for injection of three-phase currents and three-phase voltages to the appropriate current and voltage terminals of the IED.
2. Inject current(s) and voltage(s) in a way that relevant measured (according to setting parameter *CurrentInput* and *VoltageInput*) currents and voltages are created from the test set.
   Overall check in principal as above (non-directional overcurrent feature)
3. Operate value measurement
   The relevant voltage restraining value (according to setting parameter *VoltageInput*) has also to be injected from the test set and the influence on the operate value has to be calculated when the testing the operate value is done.
4. Operate time measurement
   Definite times may be tested as above (non-directional overcurrent feature). For inverse time characteristics the START value (to which the overcurrent ratio has to be calculated) is the actual pickup value as got with actual restraining from the voltage restraining quantity.

13.8.1.4 Overcurrent feature with directionality

Please note that the directional characteristic can be set in two different ways either just dependent on the angle between current and polarizing voltage (setting parameter *DirPrinc_OC1* or *DirPrinc_OC2* set to or in a way that the operate value also is dependent on the angle between current and polarizing voltage according to the I · cos(Φ) law (setting parameter *DirPrincOC1* or *DirPrincOC2* set to I · cos(Φ). This has to be known if a more detailed measurement of the directional characteristic is made, than the one described below.

Procedure

1. Connect the test set for injection of three-phase currents and three-phase voltages to the appropriate current and voltage terminals of the IED.
2. Inject current(s) and voltage(s) in a way that relevant measured (according to setting parameter *CurrentInput* and *VoltageInput*) currents and voltages are created from the test set.
3. Set the relevant measuring quantity current to lag or lead (lag for negative RCA angle and lead for positive RCA angle) the relevant polarizing quantity voltage by an angle equal to the set IED characteristic angle (rca-dir) when forward directional feature is selected and the *CTstarpoint* configuration parameter is set to *ToObject*.
   If reverse directional feature is selected or *CTstarpoint* configuration parameter is set to *FromObject*, the angle between current and polarizing voltage shall be set equal to rca-dir+180°.
4. Overall check in principal as above (non-directional overcurrent feature)
5. Reverse the direction of the injection current and check that the protection does not operate.
6. Check with low polarization voltage that the feature becomes non-directional, blocked or with memory according to the setting.

13.8.1.5 Over/Undervoltage feature

Procedure

1. Connect the test set for injection three-phase voltages to the appropriate voltage terminals of the IED.
2. Inject voltage(s) in a way that relevant measured (according to setting parameter *VoltageInput*) voltages are created from the test set.
3. Overall check in principal as above (non-directional overcurrent feature) and correspondingly for the undervoltage feature.

13.8.1.6 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.9 Secondary system supervision

13.9.1 Fuse failure supervision SDDRFUF

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

The verification is divided in two main parts. The first part is common to all fuse failure supervision options, and checks that binary inputs and outputs operate as expected according to actual configuration. In the second part the relevant set operate values are measured.

13.9.1.1 Checking that the binary inputs and outputs operate as expected

1. Simulate normal operating conditions with the three-phase currents in phase with their corresponding phase voltages and with all of them equal to their rated values.
2. Connect the nominal dc voltage to the DISCPOS binary input.
    - The signal BLKU should appear with almost no time delay.
    - No signals BLKZ and 3PH should appear on the IED.
    - Only the distance protection function can operate.
    - Undervoltage-dependent functions must not operate.
3. Disconnect the dc voltage from the DISCPOS binary input terminal.
4. Connect the nominal dc voltage to the MCBOP binary input.
    - The BLKU and BLKZ signals should appear without any time delay.
    - All undervoltage-dependent functions must be blocked.
5. Disconnect the dc voltage from the MCBOP binary input terminal.
6. Disconnect one of the phase voltages and observe the logical output signals on the binary outputs of the IED. BLKU and BLKZ signals should simultaneously appear.
   BLKU and BLKZ signals should simultaneously appear.
7. After more than 5 seconds disconnect the remaining two-phase voltages and all three currents.
    - There should be no change in the high status of the output signals BLKU and BLKZ.
    - The signal 3PH will appear.
8. Establish normal voltage and current operating conditions simultaneously and observe the corresponding output signals.
   They should change to logical 0 as follows:
    - Signal 3PH after about 25ms
    - Signal BLKU after about 50ms
    - Signal BLKZ after about 200ms

13.9.1.2 Measuring the operate value for the negative sequence function

Measure the operate value for the negative sequence function, if included in the IED.

1. Simulate normal operating conditions with the three-phase currents in phase with their corresponding phase voltages and with all of them equal to their rated values.
2. Slowly decrease the measured voltage in one phase until the BLKU signal appears.
3. Record the measured voltage and calculate the corresponding negative-sequence voltage according to the equation.
   Observe that the voltages in the equation are phasors.

$$3 \cdot \overline{U_2} = \overline{U_{L1}} + a^2 \cdot \overline{U_{L2}} + a \cdot \overline{U_{L3}}$$

(Equation 15)

Where:

$\overline{U_{L1}}$ $\overline{U_{L2}}$ and $\overline{U_{L3}}$ = the measured phase voltages

$$a = 1 \cdot e^{j\frac{2 \cdot \pi}{3}} = -0,5 + j\frac{\sqrt{3}}{2}$$

4. Compare the result with the set value (consider that the set value *3U2>* is in percentage of the base voltage *UBase*) of the negative-sequence operating voltage.

13.9.1.3 Measuring the operate value for the zero-sequence function

Measure the operate value for the zero-sequence function, if included in the IED.

1. Simulate normal operating conditions with the three-phase currents in phase with their corresponding phase voltages and with all of them equal to their rated values.
2. Slowly decrease the measured voltage in one phase until the BLKU signal appears.
3. Record the measured voltage and calculate the corresponding zero-sequence voltage according to the equation.
   Observe that the voltages in the equation are phasors.

$$3 \cdot \overline{U_0} = \overline{U_{L1}} + \overline{U_{L2}} + \overline{U_{L3}}$$

(Equation 18)

Where:

$\overline{U_{L1}}$, $\overline{U_{L2}}$ and $\overline{U_{L3}}$ = the measured phase voltages.

4. Compare the result with the set value (consider that the set value *3U0>* is in percentage of the base voltage of the zero-sequence operating voltage.

13.9.1.4 Checking the operation of the du/dt and di/dt based function

Check the operation of the du/dt and di/dt based function, if included in the IED.

1. Simulate normal operating conditions with the three-phase currents in phase with their corresponding phase voltages and with all of them equal to their rated values.
2. Connect the nominal dc voltage to the CBCLOSED binary input.
3. Change the voltages and currents in all three phases simultaneously.
   The voltage change should be greater then set *DU>* and the current change should be less than the set *DI<*.
   - The BLKU and BLKZ signals appear without any time delay. The BLKZ signal will be activated, only if the internal deadline detection is not activated at the same time.
   - 3PH should appear after 5 seconds, if the remaining voltage levels are lower than the set *UDLD<* of the DLD function.
4. Apply normal conditions as in step 3.
   The BLKU, BLKZ and 3PH signals should reset, if activated, see step 1 and 3.
5. Change the voltages and currents in all three phases simultaneously.
   The voltage change should be greater than set *DU>* and the current change should be greater than the set *DI<*.
   The BLKU, BLKZ and 3PH signals should not appear.
6. Disconnect the dc voltage to the CBCLOSED binary input.
7. Apply normal conditions as in step 1.
8. Repeat step 3.
9. Connect the nominal voltages in all three phases and feed a current below the operate level in all three phases.
10. Keep the current constant. Disconnect the voltage in all three phases simultaneously.
    The BLKU, BLKZ and 3PH signals should not appear.

13.9.1.5 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.10 Control

13.10.1 Autorecloser SMBRREC

Verification of the Autorecloser function SMBRREC can be considered to consist of two parts.

- One part to verify the internal logic and timing of the function
- One part to verify its interaction with the protection system

This section deals with verification of SMBRREC itself. However, it is practical to start SMBRREC by activating a protection function, for example, by secondary injection tests.

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

The purpose of verification before commissioning is to check that entered selections, setting parameters and configuration render the intended result. The function is flexible with many options and facilities. At commissioning only the selections and settings intended for use are verified. If one chooses to reduce some time settings in order to speed up verification, be careful to set the parameters at intended operational values at the end of the verification procedure. One such parameter is the *tReclaim* time and could result in a long delay of reclosing shots, for example, shot 2 and later ones.

The verification test is performed together with protection and trip functions. Figure 54 illustrates a suggested testing arrangement, where the circuit-breaker (CB) is simulated by an external bi-stable relay (BR), for example a relay type RXMVB2 or RXMD or Breaker Simulator of ABB. The following manual switches are used:

- Switch or push-button to close (SC)
- Switch or push-button to trip (ST)
- Switch for CB ready condition (SRY)

If no bi-stable relay or breaker simulator is available, replace it with two self-reset auxiliary relays and use a self-holding connection.

Use a secondary injection IED test set to operate the protection function. The test set shall be switched off when a trip signal is given or when the BR comes to open position to simulate real conditions.

The CB simulation can be made more elaborate, including simulation of the operating gear condition, CBREADY of either the type ready for a Close-Open (CO) cycle, or the type ready for an Open-Close -Open (OCO) cycle.

The CB condition CBREADY of a type, CO, shall be high (true) until a closing operation is performed. It then goes low (false) for a recharging time of about 5 - 10s. After that it is high again.

A CB condition CBREADY of a type, OCO shall be high (true) before and during tripping (Start reclosing). During tripping it goes low for a recharging time, for example, 10s. It may thus be low at the instant of reclosing. After each Open or Close operation it may need a recharging period before it goes high again.

In the example of CB simulation arrangement, the CBREADY condition is simulated by a manual switch, SRY.

Information and material for the verification:

- Protection or control unit, IED, configured and with settings entered.
- Configuration diagram for the IED
- Terminal diagram for the IED, or plant circuit diagram including the IED
- Technical reference manual for the IED
- IED test set for secondary injection
- Means to indicate, measure and record operation and times, for example an event recording facility
- A bi-stable relay (BR) or two auxiliary relays to simulate a CB
- Two push-buttons (SC, ST) to operate the BR and a change-over switch (SRY) to simulate CBREADY
- Possibly a switch simulation the synchronizing check SESRSYN condition

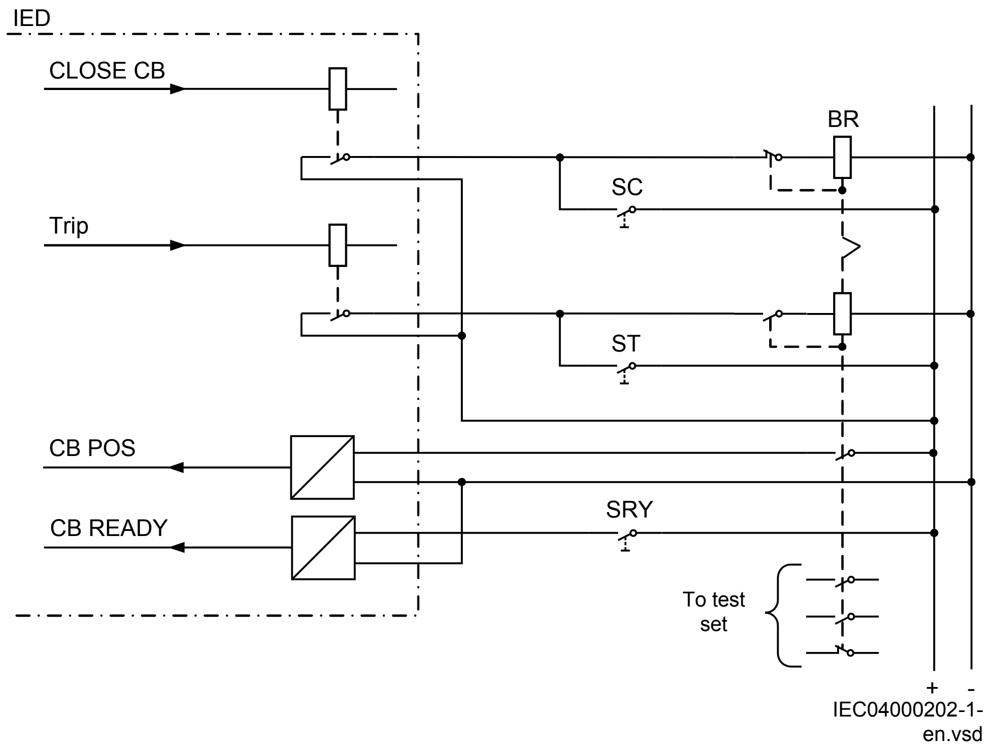


Figure 57: Simulating the CB operation by a bi-stable relay/breaker simulator and manual switches

13.10.1.1 Preparation of the verification

1. Check the function settings on the local HMI under **Main menu/Settings/Setting group N/Control/Autorecloser(RREC,79)/SMBRREC:x**

If any timer settings are reduced to speed up or facilitate the testing, they shall be set to normal after testing. A temporary label on the IED can be a reminder to restore normal settings after which a verification test should be performed.
2. Decide if a synchronizing check function SESRSYN shall be included in the test.
   If SESRSYN as an internal function or external device is not operated by the injection, it may be connected as a permanent high signal or controlled by a switch.
3. Read and make notes of the reclosing operation counters on the local HMI under **Main menu/Test/Function status/Control/AutoRecloser(RREC,79)/SMBRREC:x**
   Possibly reset the counters to *Zero*. Counters are reset in the reset menu.
4. Make arrangements for the simulation of the CB, for example as in figure 54.
5. Make arrangements for indication, recording and time measurements.
   The signals for CBPOS, START, CLOSECB, READY and other relevant signals should preferably be arranged for event recording with time tagging. If that is not possible, other means of time measurement and recording should be arranged.

13.10.1.2 Switching the autorecloser function to *On* and *Off*

1. Set the *Operation* setting to *Off* and check the state.
2. Set the *Operation* setting to *On* and check the state, including SETON and READY.
   The CB should be closed and ready.
3. If external control Off/On is connected, check that it works.
   Set *Operation* to *ExternalCtrl* and use that control to switch On and Off, and check the state of the function.

13.10.1.3 Verifying the autorecloser function SMBRREC

Select the test cases to be run according to what is applicable to the particular application. It can be, for example,

- three-phase single-shot reclosing
- two-shot reclosing
- single-phase and three-phase single-shot reclosing

Below, a case with single-phase and three-phase single-shot reclosing is described.

1. Set *Operation* = *On*.
2. If the autorecloser function SMBRREC is not to be operated, ensure that the SMBRREC input is activated. If SMBRREC is to be included, ensure that it is supplied with the appropriate AC quantities.
3. Simulate CB closed position by closing switch SC to make the BR relay start.
4. Simulate CBREADY by closing the switch SRY, and leave it closed.

5. Inject AC quantities to give a trip, for example, one-phase trip, to the BR and to the START input.
   Observe and preferably record the operation. The BR relay shall trip and reclose (start). After reclosing, the SRY switch can be opened for about 5s and then closed again.
   The autoreclosing open time and the sequence should be checked, for example in the event recording. Check also the operation indications (disturbance report) and the operation counters on the local HMI under **Main menu/Test/Function status/Control/AutoRecloser(RREC,79)/ SMBRREC:x**
   Should the operation not be as expected, this should be investigated. It could be caused by an inappropriate setting or missing condition such as CBREADY (or SMBRREC at three-phase reclosing).
6. Repeat the sequence by simulating a permanent fault.
   Shortly after the reclosing shot, a new fault is applied. If a single-shot reclosing program is selected, there shall be one reclosing operation and then blocking of SMBRREC for the set Reclaim time.
   Before a new reclosing sequence can be run, the CBREADY and CBPOS (CB closed) must be set manually.
7. Repeat the sequence by simulating a three-phase transient and permanent faults, and other applicable cases, such as signal to STARTHS and high-speed reclosing.
   If just single-phase reclosing is selected, *FirstShot* = *1ph*, a check can be run to make sure that a three-phase trip does not result in any reclosing. Other similar cases can be checked as required.

13.10.1.4 Checking the reclosing conditions

When checking the influence of a releasing condition it is suggested to first run a sequence with the condition fulfilled. When the condition signal is removed, and a new sequence is run, it indicates that the result was due to the changed condition. In case of a blocking signal the procedure should be similar. Start without the blocking or inhibit signal, and then run a sequence with the blocking or inhibit signal added.

Checking the influence of the INHIBIT signal

1. Check that the autorecloser function SMBRREC is operative, for example, by making a reclosing shot without the INHIBIT signal.
2. Apply a fault and thereby a START signal. At the same time, or during the open time, apply a signal to the input INHIBIT.
3. Check that the reclosing sequence is interrupted and no reclosing takes place.

Check closing onto a fault

1. Check that the autorecloser function SMBRREC is operative, for example by making a reclosing shot.

Keep the CBREADY signal high.
2. Set the breaker simulating relay BR in Open position.
3. Close the BR relay and apply immediately a fault and thereby a START signal.
4. Check that no reclosing takes place.

Checking the influence of CB not ready for reclosing

1. Check that the autorecloser function SMBRREC is operative, for example by making a reclosing shot.
   Keep the CB simulator BR closed. Remove the CBREADY signal by opening SRY.
2. Apply a fault and thereby a START signal.
3. Check that no reclosing takes place.

Checking the influence of synchronizing check (at three-phase reclosing)

1. Check that the autorecloser function SMBRREC is operative, for example, by making a three-phase reclosing shot with the SESRSYN synchronizing check condition.
   Remove the SESRSYN signal connected to input signal SYNC.
2. Apply a fault causing three-phase trip and thereby a START and a TR3P signal.
3. Wait for the *tSync* time out limit.
   Check that no reclosing is made.

Checking the response when autoreclosing is *Off*

Procedure

1. Check that the autorecloser function SMBRREC is operative, for examle by making a reclosing shot.
   Set the autoreclosing operation to *Off*, for examle by external control.
   The output READY shall be low, and PREP3P shall be high.
2. Apply a fault and thereby a START signal.
3. Check that no reclosing takes place.

Testing autoreclosing in a multi-breaker arrangement

The usual arrangement is to have an autorecloser function SMBRREC per circuit-breaker. They can be in different CB related IEDs or in a common IED.

- A master SMBRREC function is set with *Priority* = *High*.
- A slave SMBRREC function is set with *Priority* = *Low*.

See the application manual for an illustration of typical interconnections.

The two functions can be checked individually by carefully applying START, WAIT, and INHIBIT signals.

It is also possible to verify the two functions together by using CB simulating equipment and two CB circuits. There should be interconnections from the master to the slave function, WFMASTER - WAIT, and UNSUCCL - INHIBIT, as shown in the illustration referred to above.

Restoring equipment

After the tests, restore the equipment to normal or desired state. Check the following items in particular:

1. Check the operation counters.
   Reset the counters to zero, if that is the user's preference. The counter reset function is found on the local HMI under **Main menu/Reset/Reset counters/ AutoRecloser(RREC,79)/SMBRREC:x**
2. Restore settings that may have been modified for the tests back to normal.
3. Disconnect the test switch, CB simulating arrangement and test circuits.
   Reconnect any links or connection terminals, which may have been opened for the tests.
4. Reset indications, alarms and disturbance recordings.
   Clearing of the disturbance report must be done via the Disturbance Handling in PCM600.

13.10.1.5 Completing the test

Continue to test another function or end the test by changing the *TestMode* setting to *Off*. Restore connections and settings to their original values, if they were changed for testing purposes.

13.10.2 Apparatus control APC

The apparatus control function consists of four types of function blocks, which are connected in a delivery-specific way between bays and to the station level. For that reason, test the total function in a system, that is, either in a complete delivery system as an acceptance test (FAT/SAT) or as parts of that system.

If a block/unblock command is sent from remote to function, while the IED is shut down, this command will not be recognized after the start up, thus the command that was sent prior to the shut down is used. In such cases, where there is a mismatch, the user is advised to make a complete cycle of block/unblock operations to align the statuses.

13.10.3 Interlocking

Prepare the IED for verification of settings outlined in section "Overview" and section "Preparing for test" in this chapter.

Values of the logical signals are available on the local HMI under **Main menu/ Tests/Function status/Control/<Function>/<1:Function>**. The Signal Monitoring in PCM600 shows the same signals that are available on the local HMI.

The interlocking function consists of a bay-level part and a station-level part. The interlocking is delivery specific and is realized by bay-to-bay communication over the station bus. For that reason, test the function in a system, that is, either in a complete delivery system as an acceptance test (FAT/SAT) or as parts of that system.

13.10.4 Single command SingleCommand16Signals

For the single command function block, it is necessary to configure the output signal to corresponding binary output of the IED. The operation of the single command function (SingleCommand16Signals) is then checked from the local HMI by applying the commands with *Mode* = *Off*, *Steady* or *Pulse*, and by observing the logic statuses of the corresponding binary output. Command control functions included in the operation of different built-in functions must be tested at the same time as their corresponding functions.

13.11 Monitoring

13.11.1 Event counter CNTGGIO

The event counter function CNTGGIO can be tested by connecting a binary input to the counter under test and applying pulses to the counter. The speed of pulses must not exceed 10 per second. Normally the counter will be tested in connection with tests on the function that the counter is connected to, such as trip logic. When configured, test it together with the function that operates it. Trig the function and check that the counter result corresponds with the number of operations.

13.11.2 Event function EVENT

Prepare the IED for verification of settings as outlined in section "Overview" and section "Preparing for test" in this chapter.

During testing, the IED can be set when in test mode from PST. The functionality of the event reporting during test mode is set in the Parameter Setting tool in PCM600.

- Use event masks
- Report no events
- Report all events

In test mode, individual event blocks can be blocked from PCM600.

Individually, event blocks can also be blocked from the local HMI under

Main menu/Test/Function test modes/Monitoring/EventCounter(GGIO)/ CNTGGIO:x

13.12 Metering

13.12.1 Pulse counter PCGGIO

The test of the Pulse counter function PCGGIO requires the Parameter Setting tool in PCM600 or an appropriate connection to the local HMI with the necessary functionality. A known number of pulses with different frequencies are connected to the pulse counter input. The test should be performed with settings *Operation* = *On* or *Operation* = *Off* and the function blocked or unblocked. The pulse counter value is then checked in PCM600 or on the local HMI.

13.13 Station communication

13.13.1 Multiple command and transmit MultiCmd/MultiTransm

The multiple command and transmit function (MultiCmd/MultiTransm) is only applicable for horizontal communication.

Test of the multiple command function block and multiple transmit is recommended to be performed in a system, that is, either in a complete delivery system as an acceptance test (FAT/SAT) or as parts of that system, because the command function blocks are connected in a delivery-specific way between bays and the station level and transmit.

Command and transmit function blocks included in the operation of different built-in functions must be tested at the same time as their corresponding functions.

13.14 Remote communication

13.14.1 Binary signal transfer BinSignReceive, BinSignTransm

Prepare the IED for verification of settings as outlined in section "Overview" and section "Preparing for test" in this chapter.

To perform a test of Binary signal transfer function (BinSignReceive/ BinSignTransm), the hardware (LDCM) and binary input and output signals to transfer must be configured as required by the application.

There are two types of internal self supervision of BinSignReceive/BinSignTransm

- The I/O-circuit board is supervised as an I/O module. For example it generates FAIL if the board is not inserted. I/O-modules not configured are not supervised.
- The communication is supervised and the signal COMFAIL is generated if a communication error is detected.

Status for inputs and outputs as well as self-supervision status are available from the local HMI under

- Self-supervision status: **Main menu/Diagnostics/Internal events**
- Status for inputs and outputs: **Main menu/Test/Function status**, browse to the function group of interest.
- Remote communication related signals: **Main menu/Test/Function status/ Communication/Remote communication**

Test the correct functionality by simulating different kind of faults. Also check that sent and received data is correctly transmitted and read.

A test connection is shown in figure 55. A binary input signal (BI) at End1 is configured to be transferred through the communication link to End2. At End2 the received signal is configured to control a binary output (BO). Check at End2 that the BI signal is received and the BO operates.

Repeat the test for all the signals configured to be transmitted over the communication link.

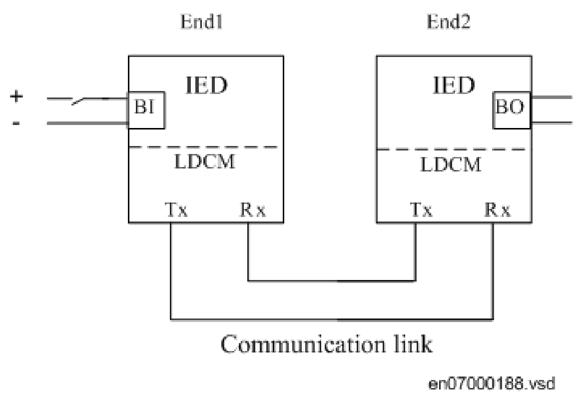


Figure 58: Test of RTC with I/O

Section 14 Primary injection testing

About this chapter

This chapter describes tests with primary current through the protected zone to determine that connections and settings are correct.

14.1 Primary injection testing

Whenever it becomes necessary to work on primary equipment, it is essential that all the necessary switching, locking, earthing and safety procedures are observed and obeyed in a rigid and formalized manner. Operating and testing procedures should be strictly followed in order to avoid exposure to the substation equipment that has not been properly de-energized.

A test with primary current through the protected zone is usually a final check that the current circuits are correctly connected to the IED protection scheme. It is important to have an appropriate source, which is able to inject sufficient current in the primary circuit in order to distinguish between noise and real injected current. Therefore it is recommended that the injection current should be at least 10% of rated CT primary current.

14.1.1 Operation of the busbar differential protection

The primary injection tests of a differential IED consist of applying a suitable current source across the primary winding of the CT connected to the current input of the IED. The testing is normally carried out on one phase at a time. If the primary current is bigger than the set value of the *DiffOperLevel* parameter, the IED shall issue the trip command as well. The primary current injection test should be repeated for every CT until all current circuits in all phases are checked. The typical connection for the primary injection test is shown in figure 56.

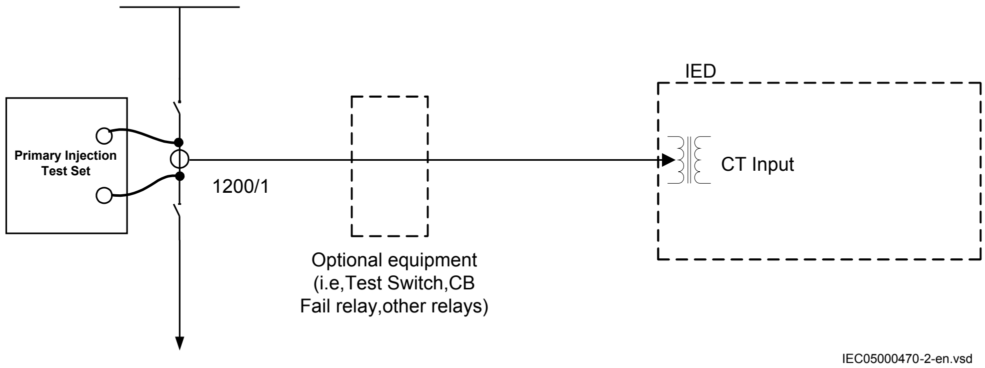


Figure 59: Typical test connection for primary injection testing

Testing will be explained from one general current input CTx (that is, x = 1, 2,..., Nmax; where Nmax is equal to the maximum number of used CT inputs).

Follow the following test instructions for all used current inputs in an IED.

Procedure

1. Connect the test set for injection primary current to the main CT connected to the current terminals of CTx input of the IED as shown in figure 56.
2. Make sure that current measurement from the CTx input are included in one of the differential zones.
3. Inject the primary current in phase L1 and note the incoming and differential currents on the local HMI of the IED. The values of the incoming and the differential currents shall correspond to the injected primary current.
4. Check that the current is present only in the phase being tested.
5. If the injected current is high enough, check that trip contacts operate accordingly to the scheme wiring.
6. Check that trip information is stored in the disturbance recorder and event list (if connected).
7. Switch off the current.
8. Check the function in the same way by injecting current in phases L2 and L3.

It is recommended that each primary CB is tripped directly from the protection scheme at least once during these tests. This will confirm the trip-circuit connection between the protection scheme and the CB.

14.1.2 Stability of the busbar differential protection

For stability testing, one current circuit shall always be used as a reference input. The reference current circuit shall then be tested for stability against all other current circuits connected to a REB670 IED protection scheme on a one-by-one basis. Use the current circuit connected to the CT1 current input as the reference current circuit. A typical connection for the primary current test set for this type of tests is shown in figure 57.

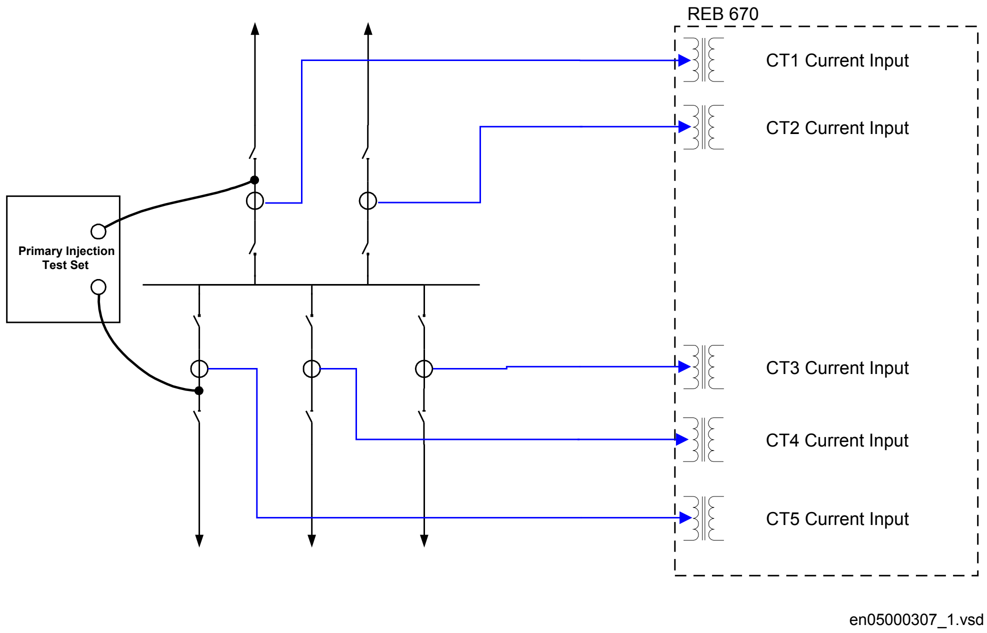


Figure 60: Typical test connection for primary injection, which should confirm the stability of the main CT connected to current inputs of the IED

For this type of primary injection tests a suitable current source should be applied across the primary windings of two CTs connected in series as shown in figure 57. The testing is normally done on one phase at the time. The currents in the secondary winding of these CTs are then opposite in phase. The differential current displayed by the IED should be negligible while the incoming current displayed should be equal to the value of the injected primary current. The IED must not issue the trip command during these tests. If it trips or the differential current has a high value it usually means that there is a wiring problem in the CT circuits connected to the current input CTx (that is, a differential current equal to twice the injection current probably indicates wrong polarity of the main CT connected to the CTx current input). This problem must be solved before the protection scheme is put in service.

Procedure

1. Connect the test set for primary current injection to the main CTs as shown in figure 57.
2. Make sure that current measurement from two used CT inputs are included in the same differential zone.
3. Inject the primary current in phase L1 and note the incoming and differential currents on the local HMI of the IED.
   The value of the incoming current for phase L1 shall correspond to the injected primary current. The value of the differential current for phase L1 shall be negligible.

4. Check that the current is present only in the phase being tested.
5. Switch the current off.
6. Check the function in phases L2 and L3 by injecting current in the same way.

The busbar disconnector replica is used in order to provide the information to the REB670 differential IEDs, which of the measured CT currents shall be included within different differential zones. To form the busbar disconnector replica, it is necessary to use the auxiliary contacts from each busbar disconnector.

For more information please refer to the REB670 application manual.

Proper operation of this scheme have to be checked during commissioning, by manual operation of the primary busbar disconnectors and/or circuit breakers and verification that the associated switch status function block properly operates and energies the corresponding binary inputs of relevant REB670 IED bay function block. If necessary proper timing of the disconnector auxiliary contacts have to be checked as well.

The REB670 IED protection scheme can be put in service, after all these tests have been conducted.

Section 16 Commissioning and maintenance of the fault clearing system

About this chapter

This chapter discusses maintenance tests and other periodic maintenance measures.

15.1 Commissioning tests

During commissioning all protection functions shall be verified with the setting values used at each plant. The commissioning tests must include verification of all circuits by green-lining the circuit diagrams and the configuration diagrams for the used functions.

Further, the settings for protection functions are tested and recorded carefully as outlined for the future periodic maintenance tests.

The final testing includes primary verification of all directional functions where load currents is checked on the local HMI and in PCM600. The amplitudes and angles of all currents and voltages should be checked and the symmetry verified.

Directional functions have information about the measured direction and, for example, measured impedance. These values must be checked and verified as correct with the export or import of power available.

Finally, final trip tests must be performed. This involves activation of protection functions or tripping outputs with the circuit breaker closed and the tripping of the breaker verified. When several breakers are involved, each breaker must be checked individually and it must be verified that the other involved breakers are not tripped at the same time.

15.2 Periodic maintenance tests

The periodicity of all tests depends on several factors, for example the importance of the installation, environmental conditions, simple or complex equipment, static or electromechanical IEDs, and so on.

The normal maintenance praxis of the user should be followed. However, ABB's recommendation is as follows:

Every second to third year

- Visual inspection of all equipment.
- Removal of dust on ventilation louvres and IEDs if necessary.
- Periodic maintenance test for protection IEDs of object where no redundant protections are provided.

Every four to six years

- Periodic maintenance test for protection IEDs of objects with redundant protection system.

First maintenance test should always be carried out after the first half year of service.

When protection IEDs are combined with built-in control, the test interval can be increased drastically, up to for instance 15 years, because the IED continuously reads service values, operates the breakers, and so on.

15.2.1 Visual inspection

Prior to testing, the protection IEDs should be inspected to detect any visible damage that may have occurred (for example, dirt or moisture deposits, overheating). Should burned contacts be observed when inspecting the IEDs, a diamond file or an extremely fine file can be used to polish the contacts. Emery cloth or similar products must not be used as insulating grains of abrasive may be deposited on the contact surfaces and cause failure.

Make sure that all IEDs are equipped with covers.

15.2.2 Maintenance tests

To be made after the first half year of service, then with the cycle as proposed above and after any suspected maloperation or change of the IED setting.

Testing of protection IEDs shall preferably be made with the primary circuit de-energized. The IED cannot protect the circuit during testing. Trained personnel may test one IED at a time on live circuits where redundant protection is installed and de-energization of the primary circuit is not allowed.

ABB protection IEDs are preferably tested by aid of components from the COMBITEST testing system described in information B03-9510 E. Main components are RTXP 8/18/24 test switch located to the left in each protection IED and RTXH 8/18/24 test handle, which is inserted in test switch at secondary testing. All necessary operations such as opening of trip circuits, short-circuiting of current circuits and opening of voltage circuits are automatically performed in the right order to allow for simple and safe secondary testing even with the object in service.

15.2.2.1 Preparation

Before starting maintenance testing, the test engineers should scrutinize applicable circuit diagrams and have the following documentation available:

- Test instructions for protection IEDs to be tested
- Test records from previous commissioning and maintenance tests
- List of valid settings
- Blank test records to fill in measured values

15.2.2.2 Recording

It is of utmost importance to carefully record the test results. Special test sheets covering the frequency of test, date of test and achieved test values should be used. IED setting list and protocols from previous tests should be available and all results should be compared for differences. At component failures, spare equipment is used and set to the requested value. A note of the exchange is made and the new measured values are recorded. Test records for several years of testing should be stored in a common file for a station, or a part of a station, to give a simple overview of the period of testing and achieved test values. These test records are valuable when analysis of service disturbances shall be done.

15.2.2.3 Secondary injection

The periodic maintenance test is done by secondary injection from a portable test set. Each protection shall be tested according to the secondary injection test information for the specific protection IED. Only the setting values adopted shall be checked for each protection function. If the discrepancy between obtained value and requested set value is too big the setting should be adjusted, the new value recorded and a note should be made in the test record.

15.2.2.4 Alarm test

When inserting the test handle the alarm and event signalling is normally blocked. This is done in the IED by setting the event reporting to *Off* during the test. This can be done when the test handle is inserted or the IED is set to test mode from the local HMI. At the end of the secondary injection test it should be checked that the event and alarm signalling is correct by activating the events and performing some selected tests.

15.2.2.5 Self supervision check

Once secondary testing has been completed, it should be checked that no self-supervision signals are activated continuously or sporadically. Especially check the time synchronization system, GPS or other, and communication signals, both station communication and remote communication.

15.2.2.6 Trip circuit check

When the protection IED undergoes an operational check, a tripping pulse is normally obtained on one or more of the output contacts and preferably on the test switch. The healthy circuit is of utmost importance for the protection operation. If the circuit is not provided with a continuous trip-circuit supervision, it is possible to check that circuit is really closed when the test-plug handle has been removed by using a high-ohmic voltmeter and measuring between the plus and the trip output on the panel. The measurement is then done through the tripping magnet of the circuit breaker and therefore the complete tripping circuit is checked.

Note that the breaker must be closed.

Please observe that the test system does not provide built-in security during this test. If the instrument should be set on Amp instead of Volts, the circuit breaker naturally is tripped, therefore, great care is necessary.

Trip circuit from trip IEDs to circuit breaker is often supervised by trip-circuit supervision. It can then be checked that a circuit is healthy by opening tripping output terminals in the cubicle. When the terminal is opened, an alarm shall be achieved on the signal system after a delay of some seconds.

Remember to close the circuit directly after the test and tighten the terminal carefully.

15.2.2.7 Measurement of service currents

After a maintenance test it is recommended to measure the service currents and service voltages recorded by the protection IED. The service values are checked on the local HMI or in PCM600. Ensure that the correct values and angles between voltages and currents are recorded. Also check the direction of directional functions such as Distance and directional overcurrent functions.

For transformer differential protection, the achieved differential current value is dependent on the tap changer position and can vary between less than 1% up to perhaps 10% of rated current. For line differential functions, the capacitive charging currents can normally be recorded as a differential current.

The zero-sequence current to earth-fault protection IEDs should be measured. The current amounts normally very small but normally it is possible to see if the current circuit is "alive".

The neutral-point voltage to an earth-fault protection IED is checked. The voltage is normally 0.1 to 1V secondary. However, voltage can be considerably higher due to harmonics. Normally a CVT secondary can have around 2.5 - 3% third-harmonic voltage.

15.2.2.8 Restoring

Maintenance is very important to improve the availability of the protection system by detecting failures before the protection is required to operate. There is however little point in testing healthy equipment and then putting it back into service with an open terminal, with a removed fuse or open miniature circuit breaker with an open connection, wrong setting, and so on.

Thus a list should be prepared of all items disturbed during test so that all can be put back into service quickly and without overlooking something. It should be put back into service item by item and signed by the responsible engineer.

Section 17 Fault tracing and repair

About this chapter

This chapter describes how to carry out fault tracing and if necessary, a change of circuit board.

16.1 Fault tracing

16.1.1 Information on the local HMI

If an internal fault has occurred, the local HMI displays information under **Main menu/Diagnostics/IED status/General**

Under the Diagnostics menus, indications of a possible internal failure (serious fault) or internal warning (minor problem) are listed.

Indications regarding the faulty unit are outlined in table 19.

Table 19: Self-supervision signals on the local HMI

HMI Signal Name:	Status	Description
INT Fail	OFF / ON	This signal will be active if one or more of the following internal signals are active; INT--NUMFAIL, INT--LMDERROR, INT--WATCHDOG, INT--APPERROR, INT--RTEERROR, INT--FTFERROR, or any of the HW dependent signals
INT Warning	OFF / ON	This signal will be active if one or more of the following internal signals are active; INT--RTCERROR, INT--IEC61850ERROR, INT--TIMESYNCHERROR
NUM Fail	OFF / ON	This signal will be active if one or more of the following internal signals are active; INT--WATCHDOG, INT--APPERROR, INT--RTEERROR, INT--FTFERROR
NUM Warning	OFF / ON	This signal will be active if one or more of the following internal signals are active; INT--RTCERROR, INT--IEC61850ERROR
ADMnn	READY / FAIL	Analog input module n failed. Signal activation will reset the IED
BIMnn	READY / FAIL	BIM error. Binary input module Error status. Signal activation will reset the IED

Table continues on next page

HMI Signal Name:	Status	Description
BOMn	READY / FAIL	BOM error. Binary output module Error status.
IOMn	READY / FAIL	IOM-error. Input/Output Module Error status.
MIMn	READY / FAIL	mA input module MIM1 failed. Signal activation will reset the IED
RTC	READY / FAIL	This signal will be active when there is a hardware error with the real time clock.
Time Sync	READY / FAIL	This signal will be active when the source of the time synchronization is lost, or when the time system has to make a time reset.
Application	READY / FAIL	This signal will be active if one or more of the application threads are not in the state that Runtime Engine expects. The states can be CREATED, INITIALIZED, RUNNING, etc.
RTE	READY / FAIL	This signal will be active if the Runtime Engine failed to do some actions with the application threads. The actions can be loading of settings or parameters for components, changing of setting groups, loading or unloading of application threads.
IEC61850	READY / FAIL	This signal will be active if the IEC61850 stack did not succeed in some actions like reading IEC61850 configuration, startup etc.
LMD	READY / FAIL	LON network interface, MIP/DPS, is in an unrecoverable error state.
LDCMxxx	READY / FAIL	Line Differential Communication Error status
OEM	READY / FAIL	Optical Ethernet Module error status.

Also the internal signals, such as INT--FAIL and INT--WARNING can be connected to binary output contacts for signalling to a control room.

In the IED Status - Information, the present information from the self-supervision function can be viewed. Indications of failure or warnings for each hardware module are provided, as well as information about the external time synchronization and the internal clock. All according to table 19. Loss of time synchronization can be considered as a warning only. The IED has full functionality without time synchronization.

16.1.2 Using front-connected PC

Here, two summary signals appear, self-supervision summary and numerical module status summary. These signals can be compared to the internal signals as:

- Self-supervision summary = INT--FAIL and INT--WARNING
- CPU-module status summary = INT--NUMFAIL and INT--NUMWARN

When an internal fault has occurred, extensive information about the fault can be retrieved from the list of internal events available in the SMS part:

TRM-STAT TermStatus - Internal Events

The list of internal events provides valuable information, which can be used during commissioning and fault tracing.

The internal events are time tagged with a resolution of 1ms and stored in a list. The list can store up to 40 events. The list is based on the FIFO principle, when it is full, the oldest event is overwritten. The list cannot be cleared and its content cannot be erased.

The internal events in this list not only refer to faults in the IED, but also to other activities, such as change of settings, clearing of disturbance reports, and loss of external time synchronization.

The information can only be retrieved from the Parameter Setting software package. The PC can be connected either to the port at the front or at the rear of the IED.

These events are logged as internal events.

Table 20: Events available for the internal event list in the IED

Event message:		Description	Generating signal:
INT--FAIL	Off	Internal fail status	INT--FAIL (reset event)
INT--FAIL			INT--FAIL (set event)
INT--WARNING	Off	Internal warning status	INT--WARNING (reset event)
INT--WARNING			INT--WARNING (set event)
INT--NUMFAIL	Off	Numerical module fatal error status	INT--NUMFAIL (reset event)
INT--NUMFAIL			INT--NUMFAIL (set event)
INT--NUMWARN	Off	Numerical module non-fatal error status	INT--NUMWARN (reset event)
INT--NUMWARN			INT--NUMWARN (set event)
IOn--Error	Off	In/Out module No. n status	IOn--Error (reset event)
IOn--Error			IOn--Error (set event)
ADMn-Error	Off	Analog/Digital module No. n status	ADMn-Error (reset event)
ADMn-Error			ADMn-Error (set event)
MIM1-Error	Off	mA-input module status	MIM1-Error (reset event)
MIM1-Error			MIM1-Error (set event)
INT--RTC	Off	Real Time Clock (RTC) status	INT--RTC (reset event)
INT--RTC			INT--RTC (set event)
Table continues on next page			

Event message:	Description	Generating signal:
INT--TSYNC Off	External time synchronization status	INT--TSYNC (reset event)
INT--TSYNC		INT--TSYNC (set event)
INT--SETCHGD	Any settings in IED changed	
DRPC-CLEARED	All disturbances in Disturbance report cleared	

The events in the internal event list are time tagged with a resolution of 1ms.

This means that, when using the PC for fault tracing, it provides information on the:

- Module that should be changed.
- Sequence of faults, if more than one unit is faulty.
- Exact time when the fault occurred.

16.2 Repair instruction

Never disconnect the secondary connection of a current transformer circuit without short-circuiting the transformer’s secondary winding. Operating a current transformer with the secondary winding open will cause a massive potential build up that may damage the transformer and may cause injuries to humans.

Never connect or disconnect a wire and/or a connector to or from a IED during normal service. Hazardous voltages and currents are present that may be lethal. Operation may be disrupted and IED and measuring circuitry may be damaged.

An alternative is to open the IED and send only the faulty circuit board to ABB for repair. When a printed circuit board is sent to ABB, it must always be placed in a metallic, ESD-proof, protection bag. The user can also purchase separate replacement modules.

Strictly follow the company and country safety regulations.

Most electronic components are sensitive to electrostatic discharge and latent damage may occur. Please observe usual procedures for handling electronics and also use an ESD wrist strap. A semi-conducting layer must be placed on the workbench and connected to earth.

Disassemble and reassemble the IED accordingly:

1. Switch off the dc supply.
2. Short-circuit the current transformers and disconnect all current and voltage connections from the IED.
3. Disconnect all signal wires by removing the female connectors.
4. Disconnect the optical fibers.
5. Unscrew the main back plate of the IED.
6. If the transformer module is to be changed:
   - Remove the IED from the panel if necessary.
   - Remove the rear plate of the IED.
   - Remove the front plate.
   - Remove the screws of the transformer input module, both front and rear.
7. Pull out the faulty module.
8. Check that the new module has a correct identity number.
9. Check that the springs on the card rail are connected to the corresponding metallic area on the circuit board when the new module is inserted.
10. Reassemble the IED.

If the IED has been calibrated with the system inputs, the calibration procedure must be performed again to maintain the total system accuracy.

16.3 Repair support

If an IED needs to be repaired, the whole IED must be removed and sent to an ABB Logistic Center. Before returning the material, an inquiry must be sent to the ABB Logistic Center.

e-mail: offer.selog@se.abb.com

16.4 Maintenance

The IED is self-supervised. No special maintenance is required.

Instructions from the power network company and other maintenance directives valid for maintenance of the power system must be followed.

Section 18 Glossary

About this chapter

This chapter contains a glossary with terms, acronyms and abbreviations used in ABB technical documentation.

AC	Alternating current
ACT	Application configuration tool within PCM600
A/D converter	Analog-to-digital converter
ADBS	Amplitude deadband supervision
ADM	Analog digital conversion module, with time synchronization
AI	Analog input
ANSI	American National Standards Institute
AR	Autoreclosing
ArgNegRes	Setting parameter/ZD/
ArgDir	Setting parameter/ZD/
ASCT	Auxiliary summation current transformer
ASD	Adaptive signal detection
AWG	American Wire Gauge standard
BBP	Busbar protection
BFP	Breaker failure protection
BI	Binary input
BIM	Binary input module
BOM	Binary output module
BOS	Binary outputs status
BR	External bistable relay
BS	British Standards
BSR	Binary signal transfer function, receiver blocks
BST	Binary signal transfer function, transmit blocks
C37.94	IEEE/ANSI protocol used when sending binary signals between IEDs
CAN	Controller Area Network. ISO standard (ISO 11898) for serial communication
CB	Circuit breaker

CBM	Combined backplane module
CCITT	Consultative Committee for International Telegraph and Telephony. A United Nations-sponsored standards body within the International Telecommunications Union.
CCM	CAN carrier module
CCVT	Capacitive Coupled Voltage Transformer
Class C	Protection Current Transformer class as per IEEE/ ANSI
CMPPS	Combined megapulses per second
CMT	Communication Management tool in PCM600
CO cycle	Close-open cycle
Codirectional	Way of transmitting G.703 over a balanced line. Involves two twisted pairs making it possible to transmit information in both directions
COMTRADE	Standard format according to IEC 60255-24
Contra-directional	Way of transmitting G.703 over a balanced line. Involves four twisted pairs, two of which are used for transmitting data in both directions and two for transmitting clock signals
CPU	Central processor unit
CR	Carrier receive
CRC	Cyclic redundancy check
CROB	Control relay output block
CS	Carrier send
CT	Current transformer
CVT	Capacitive voltage transformer
DAR	Delayed autoreclosing
DARPA	Defense Advanced Research Projects Agency (The US developer of the TCP/IP protocol etc.)
DBDL	Dead bus dead line
DBLL	Dead bus live line
DC	Direct current
DFC	Data flow control
DFT	Discrete Fourier transform
DHCP	Dynamic Host Configuration Protocol
DIP-switch	Small switch mounted on a printed circuit board
DI	Digital input
DLLB	Dead line live bus

DNP	Distributed Network Protocol as per IEEE Std 1815-2012
DR	Disturbance recorder
DRAM	Dynamic random access memory
DRH	Disturbance report handler
DSP	Digital signal processor
DTT	Direct transfer trip scheme
EHV network	Extra high voltage network
EIA	Electronic Industries Association
EMC	Electromagnetic compatibility
EMF	(Electromotive force)
EMI	Electromagnetic interference
EnFP	End fault protection
EPA	Enhanced performance architecture
ESD	Electrostatic discharge
FCB	Flow control bit; Frame count bit
FOX 20	Modular 20 channel telecommunication system for speech, data and protection signals
FOX 512/515	Access multiplexer
FOX 6Plus	Compact time-division multiplexer for the transmission of up to seven duplex channels of digital data over optical fibers
G.703	Electrical and functional description for digital lines used by local telephone companies. Can be transported over balanced and unbalanced lines
GCM	Communication interface module with carrier of GPS receiver module
GDE	Graphical display editor within PCM600
GI	General interrogation command
GIS	Gas-insulated switchgear
GOOSE	Generic object-oriented substation event
GPS	Global positioning system
GSAL	Generic security application
GTM	GPS Time Module
HDLC protocol	High-level data link control, protocol based on the HDLC standard
HFBR connector type	Plastic fiber connector

HMI	Human-machine interface
HSAR	High speed autoreclosing
HV	High-voltage
HVDC	High-voltage direct current
IDBS	Integrating deadband supervision
IEC	International Electrical Committee
IEC 60044-6	IEC Standard, Instrument transformers – Part 6: Requirements for protective current transformers for transient performance
IEC 60870-5-103	Communication standard for protective equipment. A serial master/slave protocol for point-to-point communication
IEC 61850	Substation automation communication standard
IEC 61850–8–1	Communication protocol standard
IEEE	Institute of Electrical and Electronics Engineers
IEEE 802.12	A network technology standard that provides 100 Mbits/s on twisted-pair or optical fiber cable
IEEE P1386.1	PCI Mezzanine Card (PMC) standard for local bus modules. References the CMC (IEEE P1386, also known as Common Mezzanine Card) standard for the mechanics and the PCI specifications from the PCI SIG (Special Interest Group) for the electrical EMF (Electromotive force).
IEEE 1686	Standard for Substation Intelligent Electronic Devices (IEDs) Cyber Security Capabilities
IED	Intelligent electronic device
I-GIS	Intelligent gas-insulated switchgear
IOM	Binary input/output module
Instance	When several occurrences of the same function are available in the IED, they are referred to as instances of that function. One instance of a function is identical to another of the same kind but has a different number in the IED user interfaces. The word "instance" is sometimes defined as an item of information that is representative of a type. In the same way an instance of a function in the IED is representative of a type of function.
IP	1. Internet protocol. The network layer for the TCP/IP protocol suite widely used on Ethernet networks. IP is a connectionless, best-effort packet-switching protocol. It provides packet routing, fragmentation and reassembly through the data link layer. 2. Ingression protection, according to IEC standard

IP 20	Ingression protection, according to IEC standard, level 20
IP 40	Ingression protection, according to IEC standard, level 40
IP 54	Ingression protection, according to IEC standard, level 54
IRF	Internal failure signal
IRIG-B:	InterRange Instrumentation Group Time code format B, standard 200
ITU	International Telecommunications Union
LAN	Local area network
LIB 520	High-voltage software module
LCD	Liquid crystal display
LDCM	Line differential communication module
LDD	Local detection device
LED	Light-emitting diode
LNT	LON network tool
LON	Local operating network
MCB	Miniature circuit breaker
MCM	Mezzanine carrier module
MIM	Milli-ampere module
MPM	Main processing module
MVB	Multifunction vehicle bus. Standardized serial bus originally developed for use in trains.
NCC	National Control Centre
NUM	Numerical module
OCO cycle	Open-close-open cycle
OCP	Overcurrent protection
OEM	Optical ethernet module
OLTC	On-load tap changer
OV	Over-voltage
Overreach	A term used to describe how the relay behaves during a fault condition. For example, a distance relay is overreaching when the impedance presented to it is smaller than the apparent impedance to the fault applied to the balance point, that is, the set reach. The relay “sees” the fault but perhaps it should not have seen it.
PCI	Peripheral component interconnect, a local data bus
PCM	Pulse code modulation

PCM600	Protection and control IED manager
PC-MIP	Mezzanine card standard
PMC	PCI Mezzanine card
POR	Permissive overreach
POTT	Permissive overreach transfer trip
Process bus	Bus or LAN used at the process level, that is, in near proximity to the measured and/or controlled components
PSM	Power supply module
PST	Parameter setting tool within PCM600
PT ratio	Potential transformer or voltage transformer ratio
PUTT	Permissive underreach transfer trip
RASC	Synchrocheck relay, COMBIFLEX
RCA	Relay characteristic angle
RFPP	Resistance for phase-to-phase faults
RFPE	Resistance for phase-to-earth faults
RISC	Reduced instruction set computer
RMS value	Root mean square value
RS422	A balanced serial interface for the transmission of digital data in point-to-point connections
RS485	Serial link according to EIA standard RS485
RTC	Real-time clock
RTU	Remote terminal unit
SA	Substation Automation
SBO	Select-before-operate
SC	Switch or push button to close
SCS	Station control system
SCADA	Supervision, control and data acquisition
SCT	System configuration tool according to standard IEC 61850
SDU	Service data unit
SLM	Serial communication module. Used for SPA/LON/IEC/DNP3 communication.
SMA connector	Subminiature version A, A threaded connector with constant impedance.
SMT	Signal matrix tool within PCM600
SMS	Station monitoring system

SNTP	Simple network time protocol – is used to synchronize computer clocks on local area networks. This reduces the requirement to have accurate hardware clocks in every embedded system in a network. Each embedded node can instead synchronize with a remote clock, providing the required accuracy.
SPA	Strömberg protection acquisition, a serial master/slave protocol for point-to-point communication
SRY	Switch for CB ready condition
ST	Switch or push button to trip
Starpoint	Neutral point of transformer or generator
SVC	Static VAr compensation
TC	Trip coil
TCS	Trip circuit supervision
TCP	Transmission control protocol. The most common transport layer protocol used on Ethernet and the Internet.
TCP/IP	Transmission control protocol over Internet Protocol. The de facto standard Ethernet protocols incorporated into 4.2BSD Unix. TCP/IP was developed by DARPA for Internet working and encompasses both network layer and transport layer protocols. While TCP and IP specify two protocols at specific protocol layers, TCP/IP is often used to refer to the entire US Department of Defense protocol suite based upon these, including Telnet, FTP, UDP and RDP.
TEF	Time delayed earth-fault protection function
TNC connector	Threaded Neill-Concelman, a threaded constant impedance version of a BNC connector
TPZ, TPY, TPX, TPS	Current transformer class according to IEC
UMT	User management tool
Underreach	A term used to describe how the relay behaves during a fault condition. For example, a distance relay is underreaching when the impedance presented to it is greater than the apparent impedance to the fault applied to the balance point, that is, the set reach. The relay does not “see” the fault but perhaps it should have seen it. See also Overreach.
UTC	Coordinated Universal Time. A coordinated time scale, maintained by the Bureau International des Poids et Mesures (BIPM), which forms the basis of a coordinated dissemination of standard frequencies and time signals.

	UTC is derived from International Atomic Time (TAI) by the addition of a whole number of "leap seconds" to synchronize it with Universal Time 1 (UT1), thus allowing for the eccentricity of the Earth's orbit, the rotational axis tilt (23.5 degrees), but still showing the Earth's irregular rotation, on which UT1 is based. The Coordinated Universal Time is expressed using a 24-hour clock, and uses the Gregorian calendar. It is used for aeroplane and ship navigation, where it is also sometimes known by the military name, "Zulu time." "Zulu" in the phonetic alphabet stands for "Z", which stands for longitude zero.
UV	Undervoltage
WEI	Weak end infeed logic
VT	Voltage transformer
X.21	A digital signalling interface primarily used for telecom equipment
$3I_O$	Three times zero-sequence current. Often referred to as the residual or the earth-fault current
$3U_O$	Three times the zero sequence voltage. Often referred to as the residual voltage or the neutral point voltage

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